

ST7LITE49M

8-bit MCU with single voltage Flash memory data EEPROM, ADC, 8/12-bit timers, and I²C interface

Features

Memories

4 Kbytes single voltage extended Flash (XFlash) Program memory with Read-Out Protection In-Circuit Programming and In-Application programming (ICP and IAP) Endurance: 10K write/erase cycles guaranteed Data retention: 20 years at 55 °C

- 384 bytes RAM
- 128 bytes data EEPROM with Read-Out Protection.
 300K write/erase cycles guaranteed, data retention: 20 years at 55 °C.
- Clock, Reset and Supply Management
 - 3-level low voltage supervisor (LVD) for main supply and an auxiliary voltage detector (AVD) for safe power-on/off
 - Clock sources: Internal trimmable 8 MHz RC oscillator, auto wake-up internal low power - low frequency oscillator, crystal/ceramic resonator or external clock
 - Five power saving modes: Halt, Active-Halt, Auto Wake-up from Halt, Wait and Slow

■ I/O Ports

- Up to 24 multifunctional bidirectional I/Os
- 8 high sink outputs





■ 5 timers

- Configurable watchdog timer
- Dual 8-bit Lite timers with prescaler,
 1 real time base and 1 input capture
- Dual 12-bit Auto-reload timers with 4 PWM outputs, input capture, output compare, dead-time generation and enhanced one pulse mode functions
- Communication interface:
 - I²C multimaster interface
- A/D converter: 10 input channels
- Interrupt management
 - 13 interrupt vectors plus TRAP and RESET
- Instruction set
 - 8-bit data manipulation
 - 63 basic instructions with illegal opcode detection
 - 17 main addressing modes
 - 8 x 8 unsigned multiply instructions
- Development tools
 - Full HW/SW development package
 - DM (Debug Module)

Table 1. Device summary

| Features | ST7LITE49M |
|------------------------|----------------|
| Program memory - bytes | 4K |
| RAM (stack) - bytes | 384 (128) |
| Data EEPROM - bytes | 128 |
| Operating supply | 2.4 to 5.5 V |
| CPU frequency | Up to 8 MHz |
| Operating temperature | -40 to +125 °C |
| Packages | LQFP32, SDIP32 |

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Description ST7LITE49M

Description 1

The ST7LITE49M is a member of the ST7 microcontroller family. All ST7 devices are based on a common industry-standard 8-bit core, featuring an enhanced instruction set.

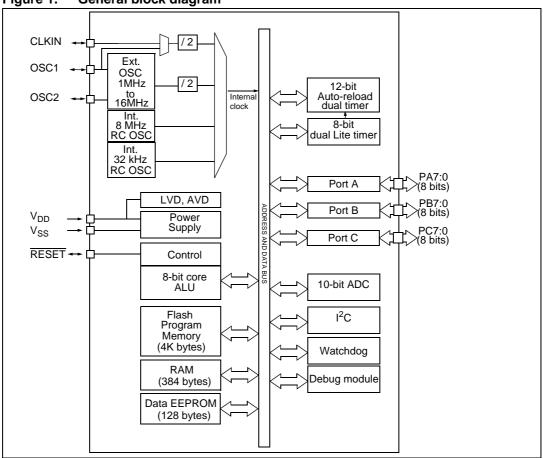
The ST7LITE49M features Flash memory with byte-by-byte In-Circuit Programming (ICP) and In-Application Programming (IAP) capability.

Under software control, the ST7LITE49M device can be placed in Wait, Slow, or Halt mode, reducing power consumption when the application is in idle or standby state.

The enhanced instruction set and addressing modes of the ST7 offer both power and flexibility to software developers, enabling the design of highly efficient and compact application code. In addition to standard 8-bit data management, all ST7 microcontrollers feature true bit manipulation, 8x8 unsigned multiplication and indirect addressing modes.

The ST7LITE49M features an on-chip Debug Module (DM) to support In-Circuit Debugging (ICD). For a description of the DM registers, refer to the ST7 ICC Protocol Reference Manual.

Figure 1. General block diagram



ST7LITE49M Pin description

2 Pin description

Figure 2. 32-pin SDIP package pinout

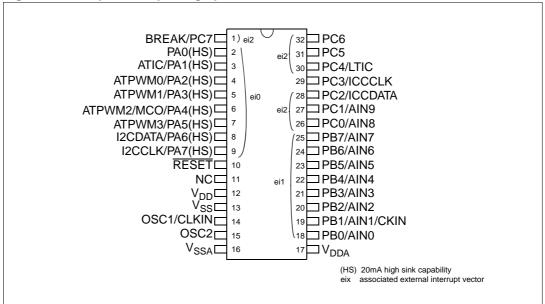
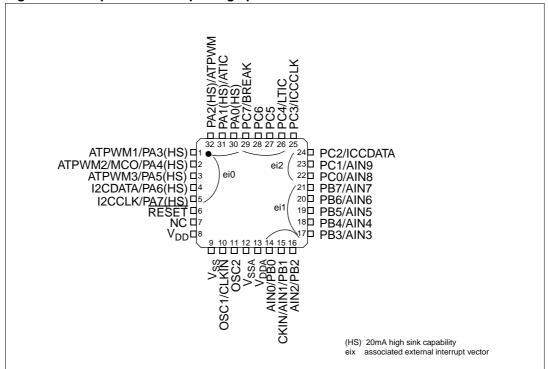


Figure 3. 32-pin LQFP 7x7 package pinout



Pin description ST7LITE49M

Legend / Abbreviations for Table 2:

Type: I = input, O = output, S = supply

In/Output level: C_T = CMOS $0.3V_{DD}/0.7V_{DD}$ with input trigger

Output level: HS = 20mA high sink (on N-buffer only)

Port and control configuration:

• Input: float = floating, wpu = weak pull-up, int = interrupt, ana = analog

• Output: OD = open drain, PP = push-pull

The RESET configuration of each pin is shown in bold which is valid as long as the device is in reset state.

Table 2. Device pin description

| Pi num | | | | Level | | Port/control | | | | | | Main | |
|-----------|--------|---------------------------------|------|----------------|------------|------------------|-------|--------------|-----|-------------------|--------------|---------------------------|--|
| 32 | 32 | Pin name | Туре | ¥ | <u>.</u> # | | Input | | | Output | | function (after reset) | Alternate function |
| LQFP32 | SDIP32 | | | Input | Output | float | ndw | int | ana | OD ⁽¹⁾ | В | (arter reset) | |
| 1 | 5 | PA3(HS)/ATPWM1 | I/O | C_{T} | HS | Х | | | | Х | Х | Port A3 (HS) | ATPWM1 |
| 2 | 6 | PA4(HS)/ ATPWM2/MCO | I/O | C _T | HS | x ei0 | | | х | х | Port A4 (HS) | ATPWM2/MCO | |
| 3 | 7 | PA5 (HS)ATPWM3 | I/O | C _T | HS | Х | х | | | Х | Х | Port A5 (HS) | ATPWM3 |
| 4 | 8 | PA6(HS)/ I2CDATA | I/O | C _T | HS | х | | ei0 | | Т | | Port A6 (HS) | I2CDATA |
| 5 | 9 | PA7(HS)/I2CCLK | I/O | C _T | HS | Х | | | | Т | | Port A7 (HS) | I2CCLK |
| 6 | 10 | RESET | | | | | Х | | | Х | | R | eset |
| 8 | 12 | V _{DD} ⁽²⁾ | S | | | | | | | | | Digital Supply Voltage | |
| 9 | 13 | V _{SS} ⁽²⁾ | S | | | | | | | | | Digital Gro | ound Voltage |
| 10 | 14 | OSC1 | I | | | | | | | | | | scillator inverter rnal clock input |
| 11 | 15 | OSC2 | 0 | | | | | | | | | Resonator o | scillator output |
| 12 | 16 | V _{SSA} ⁽²⁾ | S | | | Analog Ground Vo | | ound Voltage | | | | | |
| 13 | 17 | V _{DDA} ⁽²⁾ | S | | | | | | | | | Analog Supply Voltage | |

ST7LITE49M Pin description

Table 2. Device pin description

| Pin number | | | | Level | | Port/control | | | | | Main | | |
|---------------|--------|-----------------|------|----------------|----|--------------|-----------|----|-----|--------|--------------|---------------------------|----------------------------|
| 32 | 32 | Pin name | Туре | # | Ħ | Input | | | | Output | | function (after reset) | Alternate function |
| LQFP32 | SDIP32 | | | Input | | float | wpu | | ana | OD(1) | 8 | (aitei reset) | |
| 14 | 18 | PB0/AIN0 | I/O | C_{T} | | Х | | | Х | Х | Х | Port B0 | AIN0 |
| 15 | 19 | PB1/AIN1/CLKIN | I/O | C _T | | х | х | | х | х | х | Port B1 | AIN1/External clock source |
| 16 | 20 | PB2/AIN2 | I/O | C_{T} | | Х | x ei1 x x | | Х | Х | х | Port B2 | AIN2 |
| 17 | 21 | PB3/AIN3 | I/O | C_{T} | | Х | | | Х | Х | Х | Port B3 | AIN3 |
| 18 | 22 | PB4/AIN4 | I/O | C_{T} | | Х | | | Х | Х | х | Port B4 | AIN4 |
| 19 | 23 | PB5/AIN5 | I/O | C_{T} | | Х | | | Х | Х | х | Port B5 | AIN5 |
| 20 | 24 | PB6/AIN6 | I/O | C _T | | Х | | Х | Х | х | Port B6 | AIN6 | |
| 21 | 25 | PB7/AIN7 | I/O | C_{T} | | Х | х | | Х | Х | х | Port B7 | AIN7 |
| 22 | 26 | PC0/AIN8 | I/O | C_{T} | | Х | | | Х | Х | х | Port C0 | AIN8 |
| 23 | 27 | PC1/AIN9 | I/O | C_{T} | | Х | x ei2 | | Х | Х | х | Port C1 | AIN9 |
| 24 | 28 | PC2/ICCDATA | I/O | C_{T} | | Х | | | | Х | х | Port C2 | ICCDATA |
| 25 | 29 | PC3/ICCCLK | I/O | C_{T} | | Х | х | | | Х | х | Port C3 | ICCCLK |
| 26 | 30 | PC4/LTIC | I/O | C_{T} | | Х | 0 | io | | Х | х | Port C4 | LTIC |
| 27 | 31 | PC5 | I/O | C_{T} | | Х | x ei2 | | | Х | х | Po | rt C5 |
| 28 | 32 | PC6 | I/O | C_{T} | | Х | | | Х | х | Po | rt C6 | |
| 29 | 1 | PC7/BREAK | I/O | C_{T} | | х | x ei2 | | | х | х | Port C7 | BREAK |
| 30 | 2 | PA0 (HS) | I/O | C _T | HS | х | | х | | х | х | Port A | A0 (HS) |
| 31 | 3 | PA1 (HS)/ATIC | I/O | C_{T} | HS | х | x ei0 | | | х | х | Port A1 (HS) | ATIC |
| 32 | 4 | PA2 (HS)/ATPWM0 | I/O | C_{T} | HS | х | | | х | Х | Port A2 (HS) | ATPWM0 | |

In the open-drain output column, T defines a true open-drain I/O (P-Buffer and protection diode to V_{DD} are not implemented).

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^{2.} It is mandatory to connect all available V_{DD} and V_{DDA} pins to the supply voltage and all V_{SSA} pins to ground.

3 Register and memory mapping

As shown in *Figure 4*, the MCU is capable of addressing 64 Kbytes of memories and I/O registers.

The available memory locations consist of 128 bytes of register locations, 384 bytes of RAM, 128 bytes of data EEPROM and 4 Kbytes of Flash program memory. The RAM space includes up to 128 bytes for the stack from 180h to 1FFh.

The highest address bytes contain the user reset and interrupt vectors.

The Flash memory contains two sectors (see *Figure 4*) mapped in the upper part of the ST7 addressing space so the reset and interrupt vectors are located in Sector 0 (FFE0h-FFFFh).

The size of Flash Sector 0 and other device options are configurable by option bytes (refer to Section 14.1 on page 175).

Caution:

Memory locations marked as "Reserved" must never be accessed. Accessing a reserved area can have unpredictable effects on the device.

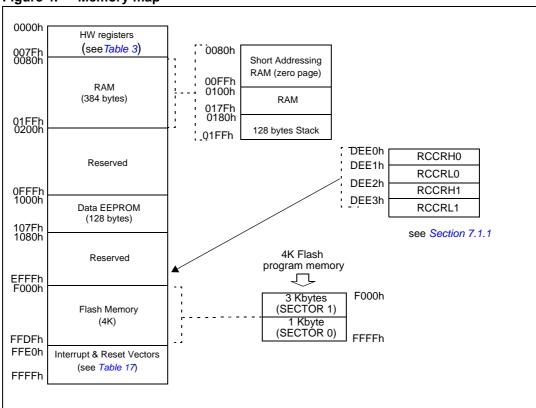


Figure 4. Memory map

Table 3. Hardware register map⁽¹⁾

| Address | Block | Register label | Register name | Reset status | Remarks |
|---|--------------------------|---|---|---|---|
| 0000h 0001h 0002h | Port A | PADR PADDR PAOR | Port A Data register Port A Data Direction register Port A Option register | 00h 00h 00h | R/W R/W R/W |
| 0003h 0004h 0005h | Port B | PBDR PBDDR PBOR | Port B Data register Port B Data Direction register Port B Option register | 00h 00h 00h | R/W R/W R/W |
| 0006h 0007h 0008h | Port C | PCDR PCDDR PCOR | Port C Data register Port C Data Direction register Port C Option register | 00h 00h 08h | R/W R/W R/W |
| 0009h to 000Bh | | | Reserved area (3 bytes) | | |
| 000Ch 000Dh 000Eh 000Fh 0010h | LITE TIMER | LTCSR2 LTARR LTCNTR LTCSR1 LTICR | Lite Timer Control/Status register 2 Lite Timer Auto-reload register Lite Timer Counter register Lite Timer Control/Status register 1 Lite Timer Input Capture register | 0Fh 00h 00h 0x00 0000b xxh | R/W R/W Read Only R/W Read Only |
| 0011h 0012h 0013h 0014h 0015h 0016h 0017h 0018h 0019h 001Ah 001Bh 001Ch 001Dh 001Eh 0020h 0021h 0022h 0023h 0024h 0025h 0026h 0027h 0028h 0029h 002Ah | AUTO- RELOAD TIMER | ATCSR CNTR1H CNTR1L ATR1H ATR1L PWMCR PWM0CSR PWM1CSR PWM2CSR PWM3CSR DCR0H DCR0L DCR1H DCR1L DCR2H DCR2L DCR3H ATICRH ATICRL ATCSR2 BREAKCR ATR2H ATR2L DTGR BREAKEN | Timer Control/Status register Counter register 1 High Counter register 1 Low Auto-Reload register 1 Low PWM Output Control register PWM 0 Control/Status register PWM 1 Control/Status register PWM 2 Control/Status register PWM 3 Control/Status register PWM 0 Duty Cycle register High PWM 0 Duty Cycle register Low PWM 1 Duty Cycle register High PWM 1 Duty Cycle register High PWM 2 Duty Cycle register Low PWM 2 Duty Cycle register High PWM 3 Duty Cycle register High PWM 3 Duty Cycle register High PWM 3 Duty Cycle register Low PWM 3 Duty Cycle register High PWM 3 Duty Cycle register Low Input Capture register High Input Capture register Low Timer Control/Status register 2 Break Control register Auto-Reload register 2 High Auto-Reload register 2 Low Dead Time Generation register Break Enable register | 0x00 0000b 00h 00h 00h 00h 00h 00h 00h 00h 00 | R/W Read Only Read Only R/W |
| 002Bh to 002Ch | | 1 | Reserved area (2 bytes) | ı | |
| 002Dh 002Eh 002Fh 0030h 0031h | ITC | ISPR0 ISPR1 ISPR2 ISPR3 EICR | Interrupt Software Priority register 0 Interrupt Software Priority register 1 Interrupt Software Priority register 2 Interrupt Software Priority register 3 External Interrupt Control register | FFh FFh FFh FFh 00h | R/W R/W R/W R/W |

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Table 3. Hardware register map⁽¹⁾ (continued)

| Address | Block | Register label | Register name | Reset status | Remarks | |
|---|--------------------------|--|--|---|---|--|
| 0032h | | | | | | |
| 0033h | WDG | WDGCR | Watchdog Control register | 7Fh | R/W | |
| 0034h | FLASH | FCSR | Flash Control/Status register | 00h | R/W | |
| 0035h | EEPROM | EECSR | Data EEPROM Control/Status register | 00h | R/W | |
| 0036h 0037h 0038h | ADC | ADCCSR ADCDRH ADCDRL | A/D Control Status register A/D Data register High A/D Data Low / test register | 00h xxh 0xh | R/W Read Only R/W | |
| 0039h | | | Reserved area (1 byte) | | | |
| 003Ah | MCC | MCCSR | Main Clock Control/Status register | 00h | R/W | |
| 003Bh 003Ch | Clock and Reset | RCCR SICSR | RC oscillator Control register System Integrity Control/Status register | FFh 011x 0x00b | R/W R/W | |
| 003Dh | AVD | AVDTHCR | AVD Threshold Selection register / RC prescaler | 00h | R/W | |
| 003Eh to 0047h | Reserved area (10 bytes) | | | | | |
| 0048h 0049h | AWU | AWUCSR AWUPR | AWU Control/Status register AWU Preload register | FFh 00h | R/W R/W | |
| 004Ah 004Bh 004Ch 004Dh 004Eh 004Fh 0050h | DM ⁽²⁾ | DMCR DMSR DMBK1H DMBK1L DMBK2H DMBK2L DMCR2 | DM Control register DM Status register DM Breakpoint register 1 High DM Breakpoint register 1 Low DM Breakpoint register 2 High DM Breakpoint register 2 Low DM Control register 2 | 00h 00h 00h 00h 00h 00h 00h | R/W R/W R/W R/W R/W R/W | |
| 0051h | Clock Controller | CKCNTCSR | Clock Controller Status register | 09h | R/W | |
| 0052h to 0063h | Reserved area (18 bytes) | | | | | |
| 0064h 0065h 0066h 0067h 0068h 0069h 006Ah | I2C | I2CCR I2CSR1 I2CSR2 I2CCCR I2COAR1 I2COAR2 I2CDR | I ² C Control register I ² C Status register 1 I ² C Status register 2 I ² C Clock Control register I ² C Own Address register 1 I ² C Own Address register 2 I ² C Data register | 00h 00h 00h 00h 00h 40h 00h | R/W Read only Read only R/W R/W R/W R/W | |

^{1.} Legend: x=undefined, R/W=read/write.

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^{2.} For a description of the Debug Module registers, see ICC protocol reference manual.

4 Flash programmable memory

4.1 Introduction

The ST7 single voltage extended Flash (XFlash) is a non-volatile memory that can be electrically erased and programmed either on a byte-by-byte basis or up to 32 bytes in parallel.

The XFlash devices can be programmed off-board (plugged in a programming tool) or on-board using In-Circuit Programming or In-Application Programming.

The array matrix organization allows each sector to be erased and reprogrammed without affecting other sectors.

4.2 Main features

- ICP (In-Circuit Programming)
- IAP (In-Application Programming)
- ICT (In-Circuit Testing) for downloading and executing user application test patterns in RAM
- Sector 0 size configurable by option byte
- Read-out and write protection

4.3 Programming modes

The ST7 can be programmed in three different ways:

- Insertion in a programming tool. In this mode, Flash sectors 0 and 1, option byte row and data EEPROM (if present) can be programmed or erased.
- In-Circuit Programming. In this mode, Flash sectors 0 and 1, option byte row and data EEPROM (if present) can be programmed or erased without removing the device from the application board.
- In-Application Programming. In this mode, sector 1 and data EEPROM (if present) can be programmed or erased without removing the device from the application board and while the application is running.

4.3.1 In-Circuit Programming (ICP)

ICP uses a protocol called ICC (In-Circuit Communication) which allows an ST7 plugged on a printed circuit board (PCB) to communicate with an external programming device connected via cable. ICP is performed in three steps:

Switch the ST7 to ICC mode (In-Circuit Communications). This is done by driving a specific signal sequence on the ICCCLK/DATA pins while the RESET pin is pulled low. When the ST7 enters ICC mode, it fetches a specific Reset vector which points to the ST7 System Memory containing the ICC protocol routine. This routine enables the ST7 to receive bytes from the ICC interface.

- Download ICP Driver code in RAM from the ICCDATA pin
- Execute ICP Driver code in RAM to program the Flash memory

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Depending on the ICP Driver code downloaded in RAM, Flash memory programming can be fully customized (number of bytes to program, program locations, or selection of the serial communication interface for downloading).

4.3.2 In Application Programming (IAP)

This mode uses an IAP Driver program previously programmed in Sector 0 by the user (in ICP mode).

This mode is fully controlled by user software. This allows it to be adapted to the user application, (user-defined strategy for entering programming mode, choice of communications protocol used to fetch the data to be stored etc.)

IAP mode can be used to program any memory areas except Sector 0, which is Write/Erase protected to allow recovery in case errors occur during the programming operation.

4.4 ICC interface

ICP needs a minimum of 4 and up to 6 pins to be connected to the programming tool. These pins are:

RESET: device reset

V_{SS}: device power supply ground

ICCCLK: ICC output serial clock pin

ICCDATA: ICC input serial data pin

OSC1: main clock input for external source

V_{DD}: application board power supply (optional, see Note 3)

If the ICCCLK or ICCDATA pins are only used as outputs in the application, no signal isolation is necessary. As soon as the Programming Tool is plugged to the board, even if an ICC session is not in progress, the ICCCLK and ICCDATA pins are not available for the application. If they are used as inputs by the application, isolation such as a serial resistor has to be implemented in case another device forces the signal. Refer to the Programming Tool documentation for recommended resistor values.

During the ICP session, the programming tool must control the $\overline{\text{RESET}}$ pin. This can lead to conflicts between the programming tool and the application reset circuit if it drives more than 5mA at high level (push pull output or pull-up resistor<1 k\Omega). A schottky diode can be used to isolate the application RESET circuit in this case. When using a classical RC network with R>1 k\Omega or a reset management IC with open drain output and pull-up resistor>1 k\Omega, no additional components are needed. In all cases the user must ensure that no external reset is generated by the application during the ICC session.

The use of pin 7 of the ICC connector depends on the Programming Tool architecture. This pin must be connected when using most ST Programming Tools (it is used to monitor the application power supply). Please refer to the Programming Tool manual.

Pin 9 has to be connected to the PB1/CLKIN pin of the ST7 when the clock is not available in the application or if the selected clock option is not programmed in the option byte. ST7 devices with multi-oscillator capability need to have OSC2 grounded in this case.

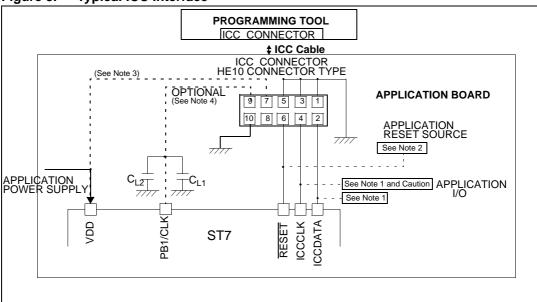
In 38-pulse ICC mode, the internal RC oscillator is forced as a clock source, regardless of the selection in the option byte.

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Caution:

During normal operation the ICCCLK pin must be internally or externally pulled- up (external pull-up of 10 k Ω mandatory in noisy environment) to avoid entering ICC mode unexpectedly during a reset. In the application, even if the pin is configured as output, any reset will put it back in input pull-up.

Figure 5. Typical ICC Interface



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4.5 Memory protection

There are two different types of memory protection: Read-Out Protection and Write/Erase Protection which can be applied individually.

4.5.1 Read-Out Protection

Read-Out Protection, when selected provides a protection against program memory content extraction and against write access to Flash memory. Even if no protection can be considered as totally unbreakable, the feature provides a very high level of protection for a general purpose microcontroller. Both program and data EEPROM memory are protected.

In Flash devices, this protection is removed by reprogramming the option. In this case, both program and data EEPROM memory are automatically erased and the device can be reprogrammed.

Read-Out Protection selection depends on the device type:

- In Flash devices it is enabled and removed through the FMP_R bit in the option byte.
- In ROM devices it is enabled by mask option specified in the option list.

4.5.2 Flash Write/Erase Protection

Write/Erase Protection, when set, makes it impossible to both overwrite and erase program memory. It does not apply to EEPROM data. Its purpose is to provide advanced security to applications and prevent any change being made to the memory content. Write/Erase Protection is enabled through the FMP_W bit in the option byte.

Caution: Once set, Write/Erase Protection can never be removed. A write-protected Flash device is no longer reprogrammable.

4.6 Related documentation

For details on Flash programming and ICC protocol, refer to the ST7 Flash Programming Reference Manual and to the ST7 ICC Protocol Reference Manual.

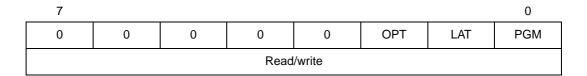
4.7 Description of the Flash Control/Status register (FCSR)

This register controls the XFlash erasing and programming using ICP, IAP or other programming methods.

1st RASS Key: 0101 0110 (56h) 2nd RASS Key: 1010 1110 (AEh)

When an EPB or another programming tool is used (in socket or ICP mode), the RASS keys are sent automatically.

Reset value: 000 0000 (00h)



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ST7LITE49M Data EEPROM

5 Data EEPROM

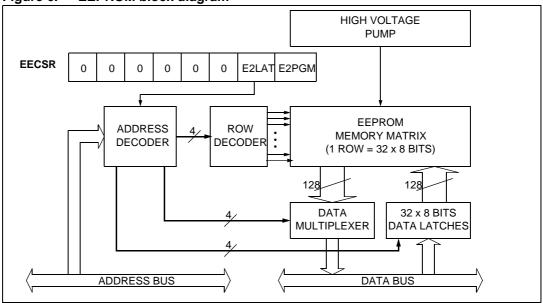
5.1 Introduction

The Electrically Erasable Programmable Read Only Memory can be used as a non volatile back-up for storing data. Using the EEPROM requires a basic access protocol described in this chapter.

5.2 Main features

- Up to 32 bytes programmed in the same cycle
- EEPROM mono-voltage (charge pump)
- Chained erase and programming cycles
- Internal control of the global programming cycle duration
- Wait mode management
- Read-Out Protection

Figure 6. EEPROM block diagram



Data EEPROM ST7LITE49M

5.3 Memory access

The Data EEPROM memory read/write access modes are controlled by the E2LAT bit of the EEPROM Control/Status register (EECSR). The flowchart in Figure 7 describes these different memory access modes.

5.3.1 Read operation (E2LAT=0)

The EEPROM can be read as a normal ROM location when the E2LAT bit of the EECSR register is cleared.

On this device, Data EEPROM can also be used to execute machine code. Take care not to write to the Data EEPROM while executing from it. This would result in an unexpected code being executed.

5.3.2 Write operation (E2LAT=1)

To access the write mode, the E2LAT bit has to be set by software (the E2PGM bit remains cleared). When a write access to the EEPROM area occurs, the value is latched inside the 32 data latches according to its address.

When PGM bit is set by the software, all the previous bytes written in the data latches (up to 32) are programmed in the EEPROM cells. The effective high address (row) is determined by the last EEPROM write sequence. To avoid wrong programming, the user must take care that all the bytes written between two programming sequences have the same high address: only the five Least Significant Bits of the address can change.

At the end of the programming cycle, the PGM and LAT bits are cleared simultaneously.

Note:

Care should be taken during the programming cycle. Writing to the same memory location will over-program the memory (logical AND between the two write access data result) because the data latches are only cleared at the end of the programming cycle and by the falling edge of the E2LAT bit. It is not possible to read the latched data (see Figure 9).

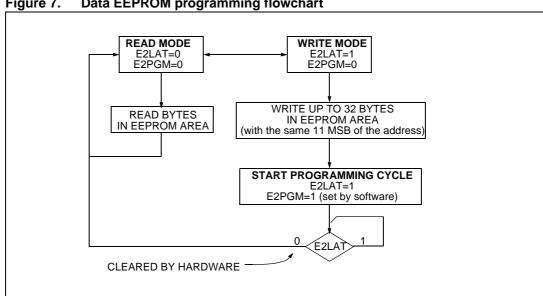


Figure 7. **Data EEPROM programming flowchart**

ST7LITE49M Data EEPROM

 \Downarrow Row / byte \Rightarrow 0 1 2 3 30 31 **Physical Address** ROW **DEFINITION** 0 00h...1Fh 1 20h...3Fh Ν Nx20h...Nx20h+1Fh Read operation impossible Read operation possible Byte 2 Byte 32 Programming cycle Byte 1 PHASE 1 PHASE 2 Writing data latches Waiting E2PGM and E2LAT to fall E2LAT bit Set by USER application

-Cleared by hardware

Figure 8. Data EEPROM write operation

5.4 Power saving modes

E2PGM bit

5.4.1 Wait mode

The DATA EEPROM can enter Wait mode on execution of the WFI instruction of the microcontroller or when the microcontroller enters Active-Halt mode. The DATA EEPROM will immediately enter this mode if there is no programming in progress, otherwise the DATA EEPROM will finish the cycle and then enter Wait mode.

5.4.2 Active-Halt mode

Refer to Wait mode.

5.4.3 Halt mode

The DATA EEPROM immediately enters Halt mode if the microcontroller executes the HALT instruction. Therefore the EEPROM will stop the function in progress, and data may be corrupted.

5.5 Access error handling

If a read access occurs while E2LAT=1, then the data bus will not be driven.

If a write access occurs while E2LAT=0, then the data on the bus will not be latched.

If a programming cycle is interrupted (by a RESET action), the integrity of the data in memory will not be guaranteed.

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If a programming cycle is interrupted (by a reset action), the integrity of the data in memory is not guaranteed.

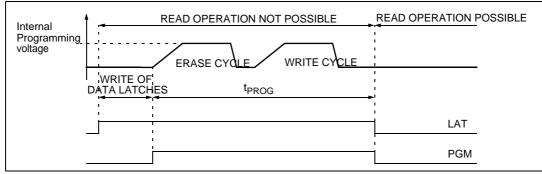
Data EEPROM ST7LITE49M

5.6 Data EEPROM Read-Out Protection

The Read-Out Protection is enabled through an option bit (see *Section 14.1: Option bytes*). When this option is selected, the programs and data stored in the EEPROM memory are protected against Read-out (including a re-write protection). In Flash devices, when this protection is removed by reprogramming the option byte, the entire Program memory and EEPROM is first automatically erased.

Note: Both Program Memory and data EEPROM are protected using the same option bit.

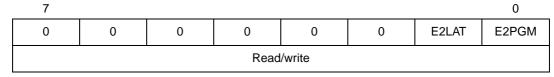




5.7 EEPROM Control/Status register (EECSR)

Address: 0035h

Reset value: 0000 0000 (00h)



Bits 7:2 = Reserved, forced by hardware to 0

- 0: Read mode
- 1: Write mode

Bit 1 = **E2LAT** *Latch Access Transfer bit:* this bit is set by software.

It is cleared by hardware at the end of the programming cycle. It can only be cleared by software if the E2PGM bit is cleared

Bit 0 = **E2PGM** Programming Control and Status bit

This bit is set by software to begin the programming cycle. At the end of the programming cycle, this bit is cleared by hardware.

- 0: Programming finished or not yet started
- 1: Programming cycle is in progress

If the E2PGM bit is cleared during the programming cycle, the memory data is not guaranteed.

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Note:

6 Central processing unit

6.1 Introduction

This CPU has a full 8-bit architecture and contains six internal registers allowing efficient 8-bit data manipulation.

6.2 Main features

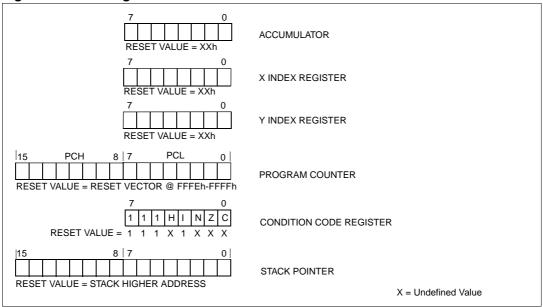
.

- 63 basic instructions
- Fast 8-bit by 8-bit multiply
- 17 main addressing modes
- Two 8-bit index registers
- 16-bit stack pointer
- Low power modes
- Maskable hardware interrupts
- Non-maskable software interrupt

6.3 CPU registers

The six CPU registers shown in *Figure 10*. They are not present in the memory mapping and are accessed by specific instructions.

Figure 10. CPU registers



6.3.1 Accumulator (A)

The Accumulator is an 8-bit general purpose register used to hold operands and the results of the arithmetic and logic calculations and to manipulate data.

6.3.2 Index registers (X and Y)

In indexed addressing modes, these 8-bit registers are used to create either effective addresses or temporary storage areas for data manipulation. (The Cross-Assembler generates a precede instruction (PRE) to indicate that the following instruction refers to the Y register.)

The Y register is not affected by the interrupt automatic procedures (not pushed to and popped from the stack).

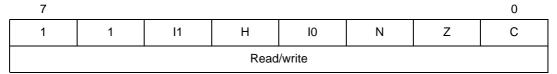
6.3.3 Program Counter (PC)

The Program Counter is a 16-bit register containing the address of the next instruction to be executed by the CPU. It is made of two 8-bit registers PCL (Program Counter low which is the LSB) and PCH (Program Counter high which is the MSB).

6.3.4 Condition Code register (CC)

The 8-bit Condition Code register contains the interrupt mask and four flags representative of the result of the instruction just executed. This register can also be handled by the PUSH and POP instructions.

Reset value: 111x 1xxx



These bits can be individually tested and/or controlled by specific instructions.

Arithmetic management bits

Bit 4 = **H** Half carry bit

This bit is set by hardware when a carry occurs between bits 3 and 4 of the ALU during an ADD or ADC instruction. It is reset by hardware during the same instructions.

0: No half carry has occurred.

1: A half carry has occurred.

This bit is tested using the JRH or JRNH instruction. The H bit is useful in BCD arithmetic subroutines.

Bit 3 = I Interrupt mask bit

This bit is set by hardware when entering in interrupt or by software to disable all interrupts except the TRAP software interrupt. This bit is cleared by software.

- 0: Interrupts are enabled.
- 1: Interrupts are disabled.

This bit is controlled by the RIM, SIM and IRET instructions and is tested by the JRM and JRNM instructions.

Note:

Interrupts requested while I is set are latched and can be processed when I is cleared. By default an interrupt routine is not interruptible because the I bit is set by hardware at the start of the routine and reset by the IRET instruction at the end of the routine. If the I bit is cleared by software in the interrupt routine, pending interrupts are serviced regardless of the priority level of the current interrupt routine.

Bit 2 = N Negative bit

This bit is set and cleared by hardware. It is representative of the result sign of the last arithmetic, logical or data manipulation. It is a copy of the 7th bit of the result.

- 0: The result of the last operation is positive or null.
- 1: The result of the last operation is negative (that is, the most significant bit is a logic 1).

This bit is accessed by the JRMI and JRPL instructions.

Bit 1 = Z Zero bit

This bit is set and cleared by hardware. This bit indicates that the result of the last arithmetic, logical or data manipulation is zero.

- 0: The result of the last operation is different from zero.
- 1: The result of the last operation is zero.

This bit is accessed by the JREQ and JRNE test instructions.

Bit 0 = **C** Carry/borrow bit

This bit is set and cleared by hardware and software. It indicates an overflow or an underflow has occurred during the last arithmetic operation.

- 0: No overflow or underflow has occurred.
- 1: An overflow or underflow has occurred.

This bit is driven by the SCF and RCF instructions and tested by the JRC and JRNC instructions. It is also affected by the "bit test and branch", shift and rotate instructions.

Interrupt management bits

Bit 5,3 = 11, 10 Interrupt bits

The combination of the I1 and I0 bits gives the current interrupt software priority.

These two bits are set/cleared by hardware when entering in interrupt. The loaded value is given by the corresponding bits in the interrupt software priority registers (IxSPR). They can be also set/cleared by software with the RIM, SIM, IRET, HALT, WFI and PUSH/POP instructions. See *Section 10.6: Interrupts* for more details.

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 Table 4.
 Interrupt software priority truth table

| Interrupt software priority | I 1 | 10 |
|-------------------------------|------------|----|
| Level 0 (main) | 1 | 0 |
| Level 1 | 0 | 1 |
| Level 2 | 0 | 0 |
| Level 3 (= interrupt disable) | 1 | 1 |

6.3.5 Stack Pointer (SP)

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Reset value: 01FFh



The Stack Pointer is a 16-bit register which is always pointing to the next free location in the stack. It is then decremented after data has been pushed onto the stack and incremented before data is popped from the stack (see *Figure 11*).

Since the stack is 128 bytes deep, the 9 most significant bits are forced by hardware. Following an MCU Reset, or after a Reset Stack Pointer instruction (RSP), the Stack Pointer contains its reset value (the SP6 to SP0 bits are set) which is the stack higher address.

The least significant byte of the Stack Pointer (called S) can be directly accessed by a LD instruction.

Note:

When the lower limit is exceeded, the Stack Pointer wraps around to the stack upper limit, without indicating the stack overflow. The previously stored information is then overwritten and therefore lost. The stack also wraps in case of an underflow.

The stack is used to save the return address during a subroutine call and the CPU context during an interrupt. The user may also directly manipulate the stack by means of the PUSH and POP instructions. In the case of an interrupt, the PCL is stored at the first location pointed to by the SP. Then the other registers are stored in the next locations as shown in *Figure 11*.

- When an interrupt is received, the SP is decremented and the context is pushed on the stack.
- On return from interrupt, the SP is incremented and the context is popped from the stack.

A subroutine call occupies two locations and an interrupt five locations in the stack area.

CALL Subroutine RET or RSP PUSH Y POP Y Interrupt Event **IRET** @ 0180h SP SP SP Υ CC CC CC Α Α Α Χ Χ Χ PCH PCH PCH SP SP PCL PCL PCL PCH PCH PCH PCH PCH SP @ 01FFh PCL PCL PCL PCL PCL Stack Higher Address = 01FFh Stack Lower Address = 0180h

Figure 11. Stack manipulation example

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7 Supply, reset and clock management

The device includes a range of utility features for securing the application in critical situations (for example in case of a power brown-out), and reducing the number of external components. The main features are the following:

- Clock Management
 - 8 MHz internal RC oscillator (enabled by option byte)
 - Auto Wake Up RC oscillator (enabled by option byte)
 - 1 to 16 MHz or 32kHz External crystal/ceramic resonator (selected by option byte)
 - External Clock Input (enabled by option byte)
- Reset Sequence Manager (RSM)
- System Integrity Management (SI)
 - Main supply Low voltage detection (LVD) with reset generation (enabled by option byte)
 - Auxiliary Voltage detector (AVD) with interrupt capability for monitoring the main supply (enabled by option byte)

7.1 RC oscillator adjustment

7.1.1 Internal RC oscillator

The device contains an internal RC oscillator with a specific accuracy for a given device, temperature and voltage range (4.5V-5.5V). It must be calibrated to obtain the frequency required in the application. This is done by software writing a 10-bit calibration value in the RCCR (RC Control register) and in the bits 6:5 in the SICSR (SI Control Status register).

Whenever the microcontroller is reset, the RCCR returns to its default value (FFh), i.e. each time the device is reset, the calibration value must be loaded in the RCCR. Predefined calibration values are stored in EEPROM for 3 and 5 V V_{DD} supply voltages at 25 °C (see *Table 5*).

Table 5. Predefined RC oscillator calibration values

| RCCR | Conditions | ST7LITE49M Address |
|--------|--|--------------------------------|
| RCCRH0 | V _{DD} = 5V | DEE0h ⁽¹⁾ (CR[9:2]) |
| RCCRL0 | T _A = 25°C f _{RC} = 8 MHz | DEE1h ⁽¹⁾ (CR[1:0]) |
| RCCRH1 | V _{DD} = 3.3 V | DEE2h ⁽¹⁾ (CR[9:2]) |
| RCCRL1 | T _A = 25°C f _{RC} = 8 MHz | DEE3h ⁽¹⁾ (CR[1:0]) |

The DEE0h, DEE1h, DEE2h and DEE3h addresses are located in a reserved area in non-volatile memory.
 They are read-only bytes for the application code. This area cannot be erased or programmed by any ICC operations.

For compatibility reasons with the SICSR register, CR[1:0] bits are stored in the 5th and 6th position of DEE1 and DEE3 addresses.

In 38-pulse ICC mode, the internal RC oscillator is forced as a clock source, regardless of the selection in the option byte.

Section 13: Electrical characteristics on page 142 for more information on the frequency and accuracy of the RC oscillator.

To improve clock stability and frequency accuracy, it is recommended to place a decoupling capacitor, typically 100nF, between the V_{DD} and V_{SSA} pins and also between the V_{DDA} and V_{SSA} pins as close as possible to the ST7 device.

These bytes are systematically programmed by ST, including on FASTROM devices.

Caution:

If the voltage or temperature conditions change in the application, the frequency may need to be recalibrated. Refer to application note AN1324 for information on how to calibrate the RC frequency using an external reference signal.

7.1.2 Auto Wake Up RC oscillator

The ST7LITE49M also contains an Auto Wake Up RC oscillator. This RC oscillator should be enabled to enter Auto Wake-up from Halt mode.

The Auto Wake Up (AWU) RC oscillator can also be configured as the startup clock through the CKSEL[1:0] option bits (see Section 14.1: Option bytes on page 175).

This is recommended for applications where very low power consumption is required.

Switching from one startup clock to another can be done in run mode as follows (see *Figure 12*):

Case 1 Switching from internal RC to AWU

- 1. Set the RC/AWU bit in the CKCNTCSR register to enable the AWU RC oscillator
- 2. The RC_FLAG is cleared and the clock output is at 1.
- Wait 3 AWU RC cycles till the AWU FLAG is set
- 4. The switch to the AWU clock is made at the positive edge of the AWU clock signal
- 5. Once the switch is made, the internal RC is stopped

Case 2 Switching from AWU RC to internal RC

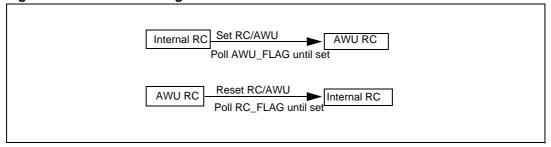
- 1. Reset the RC/AWU bit to enable the internal RC oscillator
- 2. Using a 4-bit counter, wait until 8 internal RC cycles have elapsed. The counter is running on internal RC clock.
- Wait till the AWU_FLAG is cleared (1AWU RC cycle) and the RC_FLAG is set (2 RC cycles)
- 4. The switch to the internal RC clock is made at the positive edge of the internal RC clock signal
- 5. Once the switch is made, the AWU RC is stopped

Note: 1 When the internal RC is not selected, it is stopped so as to save power consumption.

- When the internal RC is selected, the AWU RC is turned on by hardware when entering Auto Wake-Up from Halt mode.
- 3 When the external clock is selected, the AWU RC oscillator is always on.

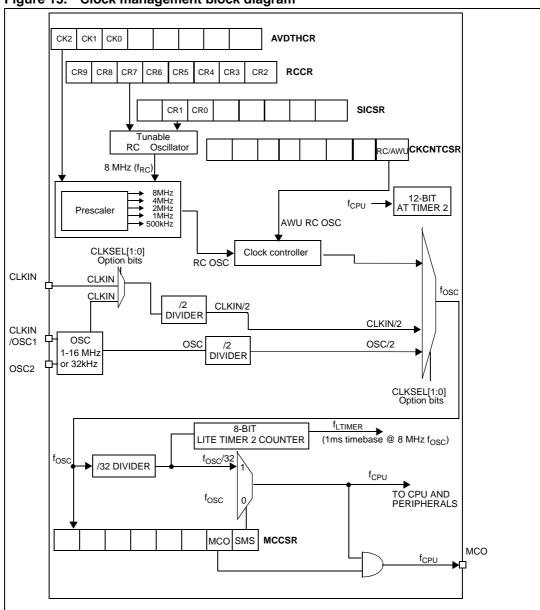
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Figure 12. Clock switching



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Figure 13. Clock management block diagram



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7.2 Multi-oscillator (MO)

The main clock of the ST7 can be generated by four different source types coming from the multi-oscillator block (1 to 16MHz):

- An external source
- 5 different configurations for crystal or ceramic resonator oscillators
- An internal high frequency RC oscillator

Each oscillator is optimized for a given frequency range in terms of consumption and is selectable through the option byte. The associated hardware configurations are shown in *Table 6*. Refer to the electrical characteristics section for more details.

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7.2.1 External clock source

In this external clock mode, a clock signal (square, sinus or triangle) with ~50% duty cycle has to drive the OSC1 pin while the OSC2 pin is tied to ground.

Note:

When the Multi-Oscillator is not used OSCI1 and OSCI2 must be tied to ground, and PB1 is selected by default as the external clock.

7.2.2 Crystal/ceramic oscillators

In this mode, with a self-controlled gain feature, oscillator of any frequency from 1 to 16MHz can be placed on OSC1 and OSC2 pins. This family of oscillators has the advantage of producing a very accurate rate on the main clock of the ST7. In this mode of the multi-oscillator, the resonator and the load capacitors have to be placed as close as possible to the oscillator pins in order to minimize output distortion and start-up stabilization time. The loading capacitance values must be adjusted according to the selected oscillator.

These oscillators are not stopped during the RESET phase to avoid losing time in the oscillator start-up phase.

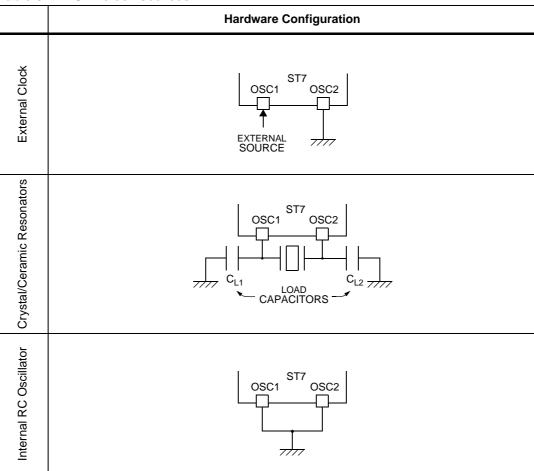
7.2.3 Internal RC oscillator

In this mode, the tunable 1% RC oscillator is used as main clock source. The two oscillator pins have to be tied to ground.

The calibration is done through the RCCR[7:0] and SICSR[6:5] registers.

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Table 6. ST7 clock sources



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7.3 Reset sequence manager (RSM)

7.3.1 Introduction

The reset sequence manager includes three RESET sources as shown in *Figure 15*:

- External RESET source pulse
- Internal LVD RESET (Low Voltage Detection)
- Internal WATCHDOG RESET

Note:

A reset can also be triggered following the detection of an illegal opcode or prebyte code. Refer to Section 12.2.1 on page 139 for further details.

These sources act on the RESET pin and it is always kept low during the delay phase.

The RESET service routine vector is fixed at addresses FFFEh-FFFFh in the ST7 memory mapping.

The basic RESET sequence consists of 3 phases as shown in Figure 14:

- Active Phase depending on the RESET source
- 256 or 4096 CPU clock cycle delay (see Table 7)

Caution:

When the ST7 is unprogrammed or fully erased, the Flash is blank and the Reset vector is not programmed. For this reason, it is recommended to keep the RESET pin in low state until programming mode is entered, in order to avoid unwanted behavior.

The 256 or 4096 CPU clock cycle delay allows the oscillator to stabilize and ensures that recovery has taken place from the Reset state. The shorter or longer clock cycle delay is automatically selected depending on the clock source chosen by option byte.

The Reset vector fetch phase duration is 2 clock cycles.

Table 7. CPU clock delay during Reset sequence

| Clock source | CPU clock cycle delay |
|---|-----------------------|
| Internal RC 8MHz Oscillator | 4096 |
| Internal RC 32kHz Oscillator | 256 |
| External clock (connected to CLKIN/PB1 pin) | 4096 |
| External Crystal/Ceramic Oscillator (connected to OSC1/OSC2 pins) | 4096 |
| External Crystal/Ceramic 1-16MHz Oscillator | 4096 |
| External Crystal/Ceramic 32kHz Oscillator | 256 |

Figure 14. RESET sequence phases

| | RESET | |
|--------------|--|-----------------|
| Active Phase | INTERNAL RESET 256 or 4096 CLOCK CYCLES | FETCH VECTOR |

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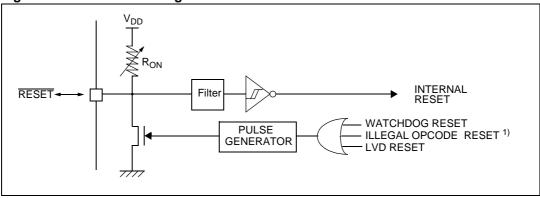
7.3.2 Asynchronous External RESET pin

The RESET pin is both an input and an open-drain output with integrated R_{ON} weak pull-up resistor. This pull-up has no fixed value but varies in accordance with the input voltage. It can be pulled low by external circuitry to reset the device. See Electrical Characteristic section for more details.

A RESET signal originating from an external source must have a duration of at least $t_{h(RSTL)in}$ in order to be recognized (see *Figure 16*). This detection is asynchronous and therefore the MCU can enter reset state even in Halt mode.

The RESET pin is an asynchronous signal which plays a major role in EMS performance. In a noisy environment, it is recommended to follow the guidelines mentioned in the electrical characteristics section.

Figure 15. Reset block diagram



1. See Section 12.2.1: Illegal Opcode Reset on page 139 for more details on illegal opcode reset conditions.

7.3.3 External Power-On Reset

If the LVD is disabled by option byte, to start up the microcontroller correctly, the user must ensure by means of an external reset circuit that the reset signal is held low until V_{DD} is over the minimum level specified for the selected f_{OSC} frequency.

A proper reset signal for a slow rising V_{DD} supply can generally be provided by an external RC network connected to the \overline{RESET} pin.

7.3.4 Internal Low Voltage Detector (LVD) Reset

Two different Reset sequences caused by the internal LVD circuitry can be distinguished:

- Power-On Reset
- Voltage Drop Reset

The device \overline{RESET} pin acts as an output that is pulled low when V_{DD} is lower than V_{IT+} (rising edge) or V_{DD} lower than V_{IT-} (falling edge) as shown in *Figure 16*.

The LVD filters spikes on V_{DD} larger than t_{q(VDD)} to avoid parasitic resets.

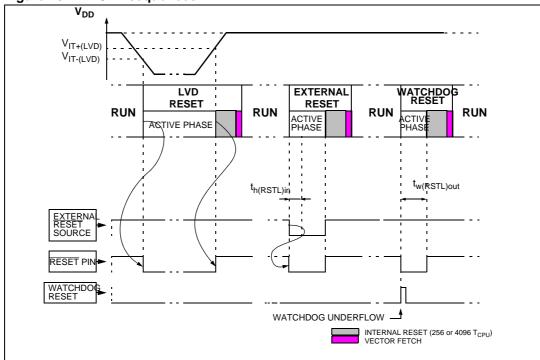
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7.3.5 Internal Watchdog Reset

The Reset sequence generated by a internal Watchdog counter overflow is shown in *Figure 16*.

Starting from the Watchdog counter underflow, the device $\overline{\text{RESET}}$ pin acts as an output that is pulled low during at least $t_{w(RSTL)out}$.

Figure 16. RESET sequences



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7.4 System integrity management (SI)

The System Integrity Management block contains the Low voltage Detector (LVD) and Auxiliary Voltage Detector (AVD) functions. It is managed by the SICSR register.

Note:

A reset can also be triggered following the detection of an illegal opcode or prebyte code. Refer to Section 12.2.1 on page 139 for further details.

7.4.1 Low Voltage Detector (LVD)

The Low Voltage Detector function (LVD) generates a static reset when the V_{DD} supply voltage is below a $V_{\text{IT-(LVD)}}$ reference value. This means that it secures the power-up as well as the power-down keeping the ST7 in reset.

The $V_{\text{IT-(LVD)}}$ reference value for a voltage drop is lower than the $V_{\text{IT+(LVD)}}$ reference value for power-on in order to avoid a parasitic reset when the MCU starts running and sinks current on the supply (hysteresis).

The LVD Reset circuitry generates a reset when V_{DD} is below:

- V_{IT+(LVD)}when V_{DD} is rising
- V_{IT-(LVD)} when V_{DD} is falling

The LVD function is illustrated in Figure 17.

The voltage threshold can be configured by option byte to be low, medium or high. See Section 14.1 on page 175.

Provided the minimum V_{DD} value (guaranteed for the oscillator frequency) is above $V_{IT-(LVD)}$, the MCU can only be in two modes:

- Under full software control
- In static safe reset

In these conditions, secure operation is always ensured for the application without the need for external reset hardware.

During a Low Voltage Detector Reset, the RESET pin is held low, thus permitting the MCU to reset other devices.

Note:

Use of LVD with capacitive power supply: with this type of power supply, if power cuts occur in the application, it is recommended to pull V_{DD} down to 0V to ensure optimum restart conditions. Refer to circuit example in Figure 96 on page 171 and note 4.

The LVD is an optional function which can be selected by option byte. See Section 14.1 on page 175.

It allows the device to be used without any external RESET circuitry.

If the LVD is disabled, an external circuitry must be used to ensure a proper power-on reset.

It is recommended to make sure that the V_{DD} supply voltage rises monotonously when the device is exiting from Reset, to ensure the application functions properly.

Make sure that the right combination of LVD and AVD thresholds is used as LVD and AVD levels are not correlated. Refer to section Section 13.3.2 on page 145 and Section 13.3.3 on page 146 for more details.

Caution:

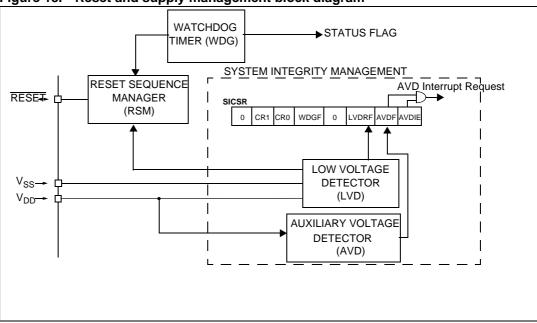
If an LVD reset occurs after a watchdog reset has occurred, the LVD will take priority and will clear the watchdog flag.

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V_{IT+(LVD)} V_{DD} V_{hys} V_{IT-(LVD)} RESET

Figure 17. Low Voltage Detector vs Reset

Figure 18. Reset and supply management block diagram



7.4.2 Auxiliary Voltage Detector (AVD)

The Voltage Detector function (AVD) is based on an analog comparison between a $V_{IT-(AVD)}$ and $V_{IT+(AVD)}$ reference value and the V_{DD} main supply voltage (V_{AVD}). The $V_{IT-(AVD)}$ reference value for falling voltage is lower than the $V_{IT+(AVD)}$ reference value for rising voltage in order to avoid parasitic detection (hysteresis).

The output of the AVD comparator is directly readable by the application software through a real time status bit (AVDF) in the SICSR register. This bit is read only.

Monitoring the V_{DD} main supply

The AVD threshold is selected by the AVD[1:0] bits in the AVDTHCR register.

If the AVD interrupt is enabled, an interrupt is generated when the voltage crosses the $V_{IT+(AVD)}$ or $V_{IT-(AVD)}$ threshold (AVDF bit is set).

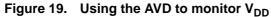
In the case of a drop in voltage, the AVD interrupt acts as an early warning, allowing software to shut down safely before the LVD resets the microcontroller. See *Figure 19*.

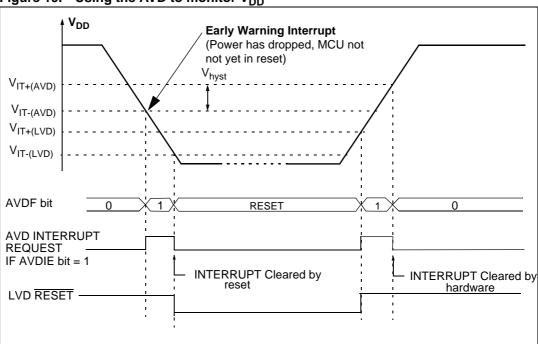
The interrupt on the rising edge is used to inform the application that the V_{DD} warning state is over.

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Note:

Make sure that the right combination of LVD and AVD thresholds is used as LVD and AVD levels are not correlated. Refer to Section 13.3.2 on page 145 and Section 13.3.3 on page 146 for more details.





7.4.3 Low power modes

Table 8. Low power modes

| Mode | Description |
|------|---|
| Wait | No effect on SI. AVD interrupts cause the device to exit from Wait mode. |
| Halt | The SICSR register is frozen. The AVD remains active but the AVD interrupt cannot be used to exit from Halt mode. |

Interrupts

The AVD interrupt event generates an interrupt if the corresponding Enable Control Bit (AVDIE) is set and the interrupt mask in the CC register is reset (RIM instruction).

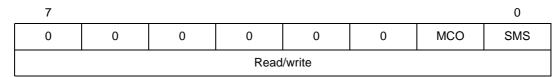
Table 9. Description of interrupt events

| Interrupt event | Event flag | Enable Control bit | Exit from Wait | Exit from Halt |
|-----------------|------------|--------------------------|-------------------|-------------------|
| AVD event | AVDF | AVDIE | Yes | No |

7.5 Register description

7.5.1 Main Clock Control/Status register (MCCSR)

Reset value: 0000 0000 (00h)



Bits 7:2 = Reserved, must be kept cleared.

Bit 1 = MCO Main Clock Out enable bit

This bit is read/write by software and cleared by hardware after a reset. This bit allows to enable the MCO output clock.

0: MCO clock disabled, I/O port free for general purpose I/O.

1: MCO clock enabled.

Bit 0 = **SMS** Slow mode selection bit

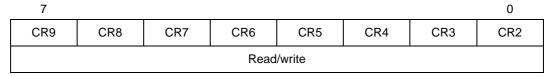
This bit is read/write by software and cleared by hardware after a reset. This bit selects the input clock f_{OSC} or $f_{OSC}/32$.

0: Normal mode (f_{CPU} = f_{OSC}

1: Slow mode $(f_{CPU} = f_{OSC}/32)$

7.5.2 RC Control register (RCCR)

Reset value: 1111 1111 (FFh)



Bits 7:0 = CR[9:2] RC Oscillator Frequency Adjustment bits

These bits must be written immediately after reset to adjust the RC oscillator frequency and to obtain an accuracy of 1%. The application can store the correct value for each voltage range in EEPROM and write it to this register at start-up.

00h = maximum available frequency

FFh = lowest available frequency

These bits are used with the CR[1:0] bits in the SICSR register. Refer to Section 7.5 on page 45.

Note: To tune the oscillator, write a series of different values in the register until the correct frequency is reached. The fastest method is to use a dichotomy starting with 80h.

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7.5.3 AVD Threshold Selection register (AVDTHCR)

Reset value: 0000 0000 (00h)

7 0
CK2 CK1 CK0 0 0 0 AVD1 AVD0
Read/write

Bits 7:5 = CK[2:0] internal RC Prescaler Selection

These bits are set by software and cleared by hardware after a reset. These bits select the prescaler of the internal RC oscillator. See *Figure 13 on page 36* and *Table 10*.

If the internal RC is used with a supply operating range below 3.3V, a division ratio of at least 2 must be enabled in the RC prescaler.

Table 10. Internal RC Prescaler Selection bits

| CK2 | CK1 | CK0 | fosc |
|-----|--------|-----|--------------------|
| 0 | 0 | 1 | f _{RC/2} |
| 0 | 1 | 0 | f _{RC/4} |
| 0 | 1 | 1 | f _{RC/8} |
| 1 | 0 | 0 | f _{RC/16} |
| | others | | f _{RC} |

Bits 4:2 = Reserved, must be kept cleared.

Bits 1:0 = AVD[1:0] AVD Threshold selection. These bits are used to select the AVD threshold. They are set and cleared by software. They are set by hardware after a reset.

Bit 1 = **AVDF** Voltage Detector flag

This read-only bit is set and cleared by hardware. If the AVDIE bit is set, an interrupt request is generated when the AVDF bit is set. Refer to *Figure 19* for additional details

- 0: V_{DD} over AVD threshold
- 1: V_{DD} under AVD threshold

Bit 0 = **AVDIE** Voltage Detector interrupt enable bit

This bit is set and cleared by software. It enables an interrupt to be generated when the AVDF flag is set. The pending interrupt information is automatically cleared when software enters the AVD interrupt routine.

- 0: AVD interrupt disabled
- 1: AVD interrupt enabled

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7.5.4 CLOCK Controller Control/Status register (CKCNTCSR)

Reset value: 0000 1001 (09h)



Bits 7:4 = Reserved, must be kept cleared.

Bit 3 = AWU_FLAG AWU Selection bit

This bit is set and cleared by hardware.

0: No switch from AWU to RC requested

1: AWU clock activated and temporization completed

Bit 2 = RC_FLAG RC Selection bit

This bit is set and cleared by hardware.

0: No switch from RC to AWU requested

1: RC clock activated and temporization completed

Bit 1 = Reserved, must be kept cleared.

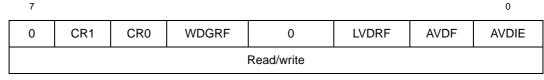
Bit 0 = RC/AWU RC/AWU Selection bit

0: RC enabled

1: AWU enabled (default value)

7.5.5 System Integrity (SI) Control/Status register (SICSR)

Reset value: 011x 0x00 (xxh)



Bit 7 = Reserved, must be kept cleared

Bits 6:5 = CR[1:0] RC Oscillator Frequency Adjustment bits

These bits, as well as CR[9:2] bits in the RCCR register must be written immediately after reset to adjust the RC oscillator frequency and to obtain an accuracy of 1%. Refer to Section 7.1.1: Internal RC oscillator on page 34.

Bit 4 = **WDGRF** Watchdog Reset flag

This bit indicates that the last Reset was generated by the Watchdog peripheral. It is set by hardware (watchdog reset) and cleared by software (writing zero) or an LVD Reset (to ensure a stable cleared state of the WDGRF flag when CPU starts).

The WDGRF and the LVDRF flags are used to select the reset source (see Table 11).

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Table 11. Reset source selection

| RESET source | LVDRF | WDGRF |
|--------------------|-------|-------|
| External RESET pin | 0 | 0 |
| Watchdog | 0 | 1 |
| LVD | 1 | Х |

Bit 3 = Reserved, must be kept cleared

Bit 2 = **LVDRF** LVD reset flag

This bit indicates that the last Reset was generated by the LVD block. It is set by hardware (LVD reset) and cleared by software (by reading). When the LVD is disabled by option byte, the LVDRF bit value is undefined.

The LVDRF flag is not cleared when another RESET type occurs (external or watchdog), the LVDRF flag remains set to keep trace of the original failure. In this case, a watchdog reset can be detected by software while an external reset can not.

Bit 1 = AVDF Voltage Detector flag

This read-only bit is set and cleared by hardware. If the AVDIE bit is set, an interrupt request is generated when the AVDF bit is set. Refer to *Figure 19* and to *Section* for additional details.

0: V_{DD} over AVD threshold

1: V_{DD} under AVD threshold

Bit 0 = **AVDIE** Voltage Detector Interrupt Enable bit

This bit is set and cleared by software. It enables an interrupt to be generated when the AVDF flag is set. The pending interrupt information is automatically cleared when software enters the AVD interrupt routine.

0: AVD interrupt disabled

1: AVD interrupt enabled

Table 12. Clock register mapping and reset values

| Address (Hex.) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------|-------------------------|----------|----------|----------|------------|----------|------------|-----------|------------|
| 003Ah | MCCSR Reset Value | - 0 | - 0 | - 0 | - 0 | 0 | - 0 | MCO 0 | SMS 0 |
| 003Bh | RCCR Reset Value | CR9 1 | CR8 1 | CR7 1 | CR6 1 | CR5 1 | CR4 1 | CR3 1 | CR2 1 |
| 003Ch | SICSR Reset Value | - 0 | CR1 1 | CR0 1 | WDGRF 0 | 0 | LVDRF x | AVDF x | AVDIE 0 |

Table 12. Clock register mapping and reset values (continued)

| Address (Hex.) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------|--------------------------------|----------|----------|----------|--------|---------------|--------------|-----------|-------------|
| 003Dh | AVDTHCR Reset Value | CK2 0 | CK1 0 | CK0 0 | - 0 | - 0 | - 0 | AVD1 0 | AVD0 0 |
| 0051h | CKCNTCS R Reset Value | - 0 | - 0 | - 0 | - 0 | AWU_FLAG 1 | RC_FLAG 0 | - 0 | RC/AWU 1 |

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Interrupts ST7LITE49M

8 Interrupts

8.1 Introduction

The ST7 enhanced interrupt management provides the following features:

- Hardware interrupts
- Software interrupt (TRAP)
- Nested or concurrent interrupt management with flexible interrupt priority and level management:
 - Up to 4 software programmable nesting levels
 - 13 interrupt vectors fixed by hardware
 - 2 non maskable events: RESET, TRAP

This interrupt management is based on:

- Bit 5 and bit 3 of the CPU CC register (I1:0),
- Interrupt software priority registers (ISPRx),
- Fixed interrupt vector addresses located at the high addresses of the memory mapping (FFE0h to FFFFh) sorted by hardware priority order.

This enhanced interrupt controller guarantees full upward compatibility with the standard (not nested) ST7 interrupt controller.

8.2 Masking and processing flow

The interrupt masking is managed by the I1 and I0 bits of the CC register and the ISPRx registers which give the interrupt software priority level of each interrupt vector (see *Table 13*). The processing flow is shown in *Figure 20*.

When an interrupt request has to be serviced:

- Normal processing is suspended at the end of the current instruction execution.
- The PC, X, A and CC registers are saved onto the stack.
- I1 and I0 bits of CC register are set according to the corresponding values in the ISPRx registers of the serviced interrupt vector.
- The PC is then loaded with the interrupt vector of the interrupt to service and the first instruction of the interrupt service routine is fetched (refer to interrupt mappin table for vector addresses).

The interrupt service routine should end with the IRET instruction which causes the contents of the saved registers to be recovered from the stack.

Note: As a consequence of the IRET instruction, the I1 and I0 bits will be restored from the stack and the program in the previous level will resume.

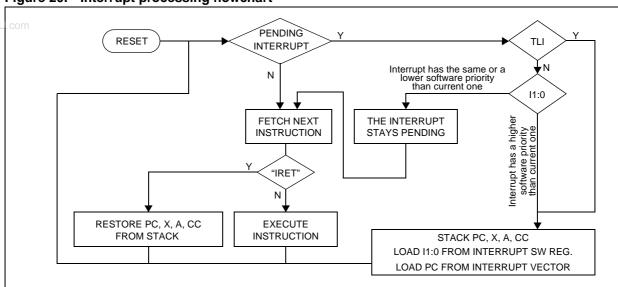
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Table 13. Interrupt software priority levels

| Interrupt software priority | Level | I1 | 10 |
|-------------------------------|--------------------|----|----|
| Level 0 (main) | 1.000 | 1 | 0 |
| Level 1 | Low | 0 | 1 |
| Level 2 | ♦ High | U | 0 |
| Level 3 (= interrupt disable) | - Tilgii | 1 | 1 |

Figure 20. Interrupt processing flowchart



Interrupts ST7LITE49M

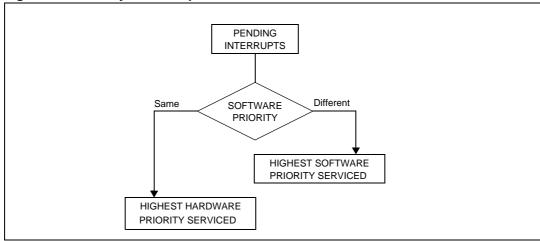
8.2.1 Servicing pending interrupts

As several interrupts can be pending at the same time, the interrupt to be taken into account is determined by the following two-step process:

- The highest software priority interrupt is serviced,
- If several interrupts have the same software priority then the interrupt with the highest hardware priority is serviced first.

Figure 21 describes this decision process.

Figure 21. Priority decision process



When an interrupt request is not serviced immediately, it is latched and then processed when its software priority combined with the hardware priority becomes the highest one.

Note: 1 The hardware priority is exclusive while the software one is not. This allows the previous process to succeed with only one interrupt.

2 RESET and TRAP can be considered as having the highest software priority in the decision process.

8.2.2 Interrupt vector sources

Two interrupt source types are managed by the ST7 interrupt controller: the non-maskable type (RESET, TRAP) and the maskable type (external or from internal peripherals).

Non-maskable sources

These sources are processed regardless of the state of the I1 and I0 bits of the CC register (see *Figure 20*). After stacking the PC, X, A and CC registers (except for RESET), the corresponding vector is loaded in the PC register and the I1 and I0 bits of the CC are set to disable interrupts (level 3). These sources allow the processor to exit Halt mode.

- TRAP (non maskable software interrupt)
 This software interrupt is serviced when the TRAP instruction is executed. It will be serviced according to the flowchart in *Figure 20*.
- RESET

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The RESET source has the highest priority in the ST7. This means that the first current routine has the highest software priority (level 3) and the highest hardware priority. See the RESET chapter for more details.

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ST7LITE49M Interrupts

Maskable sources

Maskable interrupt vector sources can be serviced if the corresponding interrupt is enabled and if its own interrupt software priority (in ISPRx registers) is higher than the one currently being serviced (I1 and I0 in CC register). If any of these two conditions is false, the interrupt is latched and thus remains pending.

External interrupts

External interrupts allow the processor to exit from Halt low power mode. External interrupt sensitivity is software selectable through the External Interrupt Control register (EICR).

External interrupt triggered on edge will be latched and the interrupt request automatically cleared upon entering the interrupt service routine.

If several input pins of a group connected to the same interrupt line are selected

Peripheral interrupts

Usually the peripheral interrupts cause the MCU to exit from Halt mode except those mentioned in *Table 17: Interrupt mapping*.

A peripheral interrupt occurs when a specific flag is set in the peripheral status registers and if the corresponding enable bit is set in the peripheral control register. The general sequence for clearing an interrupt is based on an access to the status register followed by a read or write to an associated register.

Note: The clearing sequence resets the internal latch. A pending interrupt (that is, waiting for being serviced) will therefore be lost if the clear sequence is executed.

simultaneously, these will be logically ORed.

8.3 Interrupts and low power modes

All interrupts allow the processor to exit the Wait low power mode. On the contrary, only external and other specified interrupts allow the processor to exit from the Halt modes (see column "Exit from Halt" in *Table 17: Interrupt mapping*). When several pending interrupts are present while exiting Halt mode, the first one serviced can only be an interrupt with exit from Halt mode capability and it is selected through the same decision process shown in *Figure 21*.

If an interrupt, that is not able to Exit from Halt mode, is pending with the highest priority when exiting Halt mode, this interrupt is serviced after the first one serviced.

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Note:

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8.4 Concurrent and nested management

The following *Figure 22* and *Figure 23* show two different interrupt management modes. The first is called concurrent mode and does not allow an interrupt to be interrupted, unlike the nested mode in *Figure 23*. The interrupt hardware priority is given in this order from the lowest to the highest: MAIN, IT5, IT4, IT3, IT2, IT1, IT0. The software priority is given for each interrupt.

Caution: A stack overflow may occur without notifying the software of the failure.

Figure 22. Concurrent interrupt management

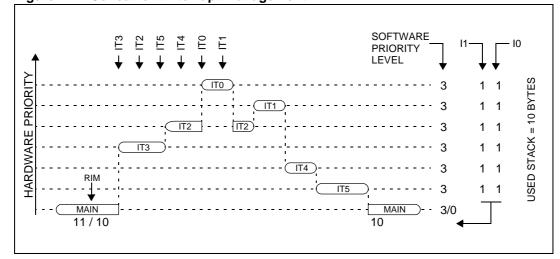
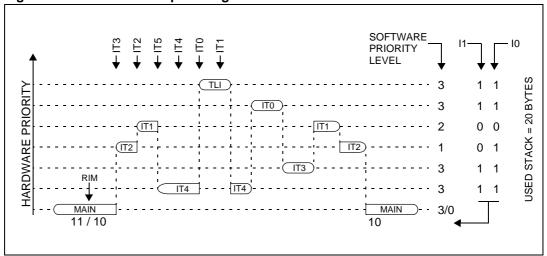


Figure 23. Nested interrupt management



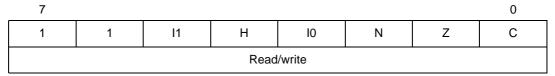
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ST7LITE49M Interrupts

8.5 Description of interrupt registers

8.5.1 CPU CC register interrupt bits

Reset value: 111x 1010(xAh)



Bit 5, 3 = I1, I0 Software Interrupt Priority bits

These two bits indicate the current interrupt software priority (see *Table 14*).

These two bits are set/cleared by hardware when entering in interrupt. The loaded value is given by the corresponding bits in the interrupt software priority registers (ISPRx).

They can be also set/cleared by software with the RIM, SIM, HALT, WFI, IRET and PUSH/POP instructions (see *Table 16: Dedicated interrupt instruction set*).

TRAP and RESET events can interrupt a level 3 program.

Table 14. Setting the interrupt software priority

| Interrupt software priority | Level | I 1 | 10 |
|--------------------------------|------------------|------------|----|
| Level 0 (main) | Low | 1 | 0 |
| Level 1 | Low | 0 | 1 |
| Level 2 | ↓ High | U | 0 |
| Level 3 (= interrupt disable*) | riigii | 1 | 1 |

8.5.2 Interrupt software priority registers (ISPRx)

All ISPRx register bits are read/write except bit 7:4 of ISPR3 which are read only.

Reset value: 1111 1111 (FFh)

| | 7 | | | | | | | 0 |
|-------|-------|-------|-------|-------|------|------|-------|-------|
| ISPR0 | l1_3 | 10_3 | l1_2 | 10_2 | l1_1 | 10_1 | I1_0 | 10_0 |
| ISPR1 | l1_7 | 10_7 | I1_6 | 10_6 | l1_5 | 10_5 | l1_4 | 10_4 |
| ISPR2 | l1_11 | I0_11 | I1_10 | I0_10 | I1_9 | 10_9 | I1_8 | 10_8 |
| ISPR3 | 1 | 1 | 1 | 1 | 1 | 1 | l1_12 | 10_12 |

ISPRx registers contain the interrupt software priority of each interrupt vector. Each interrupt vector (except RESET and TRAP) has corresponding bits in these registers to define its software priority. This correspondence is shown in *Table 15*.

Each I1_x and I0_x bit value in the ISPRx registers has the same meaning as the I1 and I0 bits in the CC register.

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The RESET and TRAP vectors have no software priorities. When one is serviced, the I1 and I0 bits of the CC register are both set.

Level 0 cannot be written $(I1_x = 1, I0_x = 0)$. In this case, the previously stored value is kept (Example: previous = CFh, write = 64h, result = 44h).

Table 15. Interrupt vector vs ISPRx bits

| Vector address | ISPRx bits |
|----------------|-----------------------------------|
| FFFBh-FFFAh | I1_0 and I0_0 bits ⁽¹⁾ |
| FFF9h-FFF8h | I1_1 and I0_1 bits |
| | |
| FFE1h-FFE0h | I1_13 and I0_13 bits |

Bits in the ISPRx registers can be read and written but they are not significant in the interrupt process management.

Caution:

If the 11_x and 10_x bits are modified while the interrupt x is executed the following behavior has to be considered: If the interrupt x is still pending (new interrupt or flag not cleared) and the new software priority is higher than the previous one, the interrupt x is re-entered. Otherwise, the software priority stays unchanged up to the next interrupt request (after the IRET of the interrupt x).

Table 16. Dedicated interrupt instruction set⁽¹⁾

| Instruction | New description | Function/Example | I1 | н | 10 | N | Z | С |
|-------------|---------------------------------|-----------------------|----|---|----|---|---|---|
| HALT | Entering Halt mode | | 1 | | 0 | | | |
| IRET | Interrupt routine return | Pop CC, A, X, PC | I1 | Н | 10 | N | Z | С |
| JRM | Jump if I1:0 = 11 (level 3) | I1:0 = 11 | | | | | | |
| JRNM | Jump if I1:0 <> 11 | l1:0 <> 11 | | | | | | |
| POP CC | Pop CC from the Stack | Mem => CC | 11 | Н | 10 | N | Z | С |
| RIM | Enable interrupt (level 0 set) | Load 10 in I1:0 of CC | 1 | | 0 | | | |
| SIM | Disable interrupt (level 3 set) | Load 11 in I1:0 of CC | 1 | | 1 | | | |
| TRAP | Software trap | Software NMI | 1 | | 1 | | | |
| WFI | Wait for interrupt | | 1 | | 0 | | | |

During the execution of an interrupt routine, the HALT, POPCC, RIM, SIM and WFI instructions change the current software priority up to the next IRET instruction or one of the previously mentioned instructions.

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ST7LITE49M Interrupts

Table 17. Interrupt mapping

| Number | Source block | Description Re | | Priority order | Exit from HALT or AWUFH | Address vector |
|--------------------|------------------|--------------------------------------|--------|-------------------|----------------------------------|-------------------|
| | RESET | Reset | N/A | | yes | FFFEh-FFFFh |
| | TRAP | Software interrupt | IN/A | | no | FFFCh-FFFDh |
| 0 | AWU | Auto Wake Up interrupt | AWUCSR | Highest | yes ⁽¹⁾ | FFFAh-FFFBh |
| 1 | AVD | Auxiliary Voltage Detector interrupt | N/A | Priority | no | FFF8h-FFF9h |
| u.com ₂ | ei0 | External interrupt 0 (Port A) N/A | | | yes | FFF6h-FFF7h |
| 3 | ei1 | ei1 External interrupt 1 (Port B) | | | | FFF4h-FFF5h |
| 4 | ei2 | External interrupt 2 (Port C) | | | | FFF2h-FFF3h |
| 5 | | AT timer Output Compare interrupt | rupt | | no | FFF0h-FFF1h |
| 6 | AT TIMER | AT timer input Capture interrupt | ATCSR | | no | FFEEh-FFEFh |
| 7 ⁽²⁾ | AI HIVIER | AT timer overflow 1 interrupt | AICSK | | no | FFECh-FFEDh |
| 8 | | AT timer Overflow 2 interrupt | | | no | FFEAh-FFEBh |
| 9 | I ² C | I ² C interrupt N/A | | ▼ Lowest | no | FFE8h-FFE9h |
| 10 ⁽²⁾ | | Lite timer RTC interrupt | | Priority | yes | FFE6h-FFE7h |
| 11 | LITE TIMER | Lite timer Input Capture interrupt | LTCSR2 | | no | FFE4h-FFE5h |
| 12 | | Lite timer RTC2 interrupt | | | no | FFE2h-FFE3h |

^{1.} This interrupt exits the MCU from Auto Wake-up from Halt mode only.

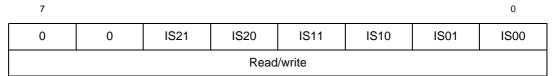
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^{2.} These interrupts exit the MCU from Active-Halt mode only.

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8.5.3 External Interrupt Control register (EICR)

Reset value: 0000 0000 (00h)



Bits 7:6 = Reserved, must be kept cleared.

Bits 5:4 = **IS2[1:0]** ei2 sensitivity bits

These bits define the interrupt sensitivity for ei2 (Port C) according to *Table 18*.

Bits 3:2 = **IS1[1:0]** ei1 sensitivity bits

These bits define the interrupt sensitivity for ei1 (Port B) according to Table 18.

Bits 1:0 = **ISO[1:0]** ei0 sensitivity bits

These bits define the interrupt sensitivity for ei0 (Port A) according to *Table 18*.

Note: 1 These 8 bits can be written only when the I bit in the CC register is set.

2 Changing the sensitivity of a particular external interrupt clears this pending interrupt. This can be used to clear unwanted pending interrupts. Refer to Section: External interrupt function.

Table 18. Interrupt sensitivity bits

| ISx1 | ISx0 | External interrupt sensitivity | | | |
|------|------|--------------------------------|--|--|--|
| 0 | 0 | Falling edge & low level | | | |
| 0 | 1 | Rising edge only | | | |
| 1 | 0 | Falling edge only | | | |
| 1 | 1 | Rising and falling edge | | | |

Power saving modes 9

Introduction 9.1

To give a large measure of flexibility to the application in terms of power consumption, four main power saving modes are implemented in the ST7 (see Figure 24):

- Slow
- Wait (and Slow-Wait)
- **Active Halt**
- Auto Wake up From Halt (AWUFH)
- Halt

After a reset the normal operating mode is selected by default (Run mode). This mode drives the device (CPU and embedded peripherals) by means of a master clock which is based on the main oscillator frequency (f_{OSC}).

From Run mode, the different power saving modes may be selected by setting the relevant register bits or by calling the specific ST7 software instruction whose action depends on the oscillator status.

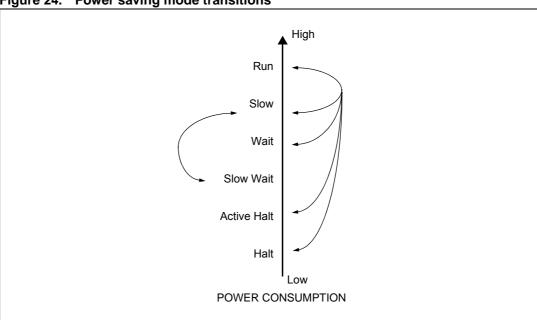


Figure 24. Power saving mode transitions

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9.2 Slow mode

mode.

www.DataSheet4U**Note**:

This mode has two targets:

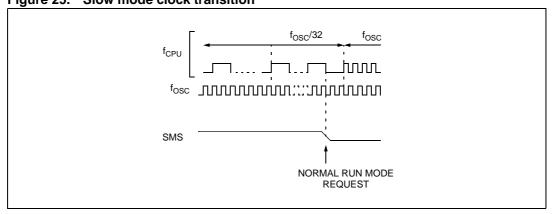
- To reduce power consumption by decreasing the internal clock in the device,
- To adapt the internal clock frequency (f_{CPU}) to the available supply voltage.

Slow mode is controlled by the SMS bit in the MCCSR register which enables or disables Slow mode.

In this mode, the oscillator frequency is divided by 32. The CPU and peripherals are clocked at this lower frequency.

Slow-Wait mode is activated when entering Wait mode while the device is already in Slow

Figure 25. Slow mode clock transition



9.3 Wait mode

Wait mode places the MCU in a low power consumption mode by stopping the CPU.

This power saving mode is selected by calling the 'WFI' instruction.

All peripherals remain active. During Wait mode, the I bit of the CC register is cleared, to enable all interrupts. All other registers and memory remain unchanged. The MCU remains in Wait mode until an interrupt or Reset occurs, whereupon the Program Counter branches to the starting address of the interrupt or Reset service routine.

The MCU will remain in Wait mode until a Reset or an Interrupt occurs, causing it to wake up.

Refer to *Figure 26* for a desription of the Wait mode flowchart..

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OSCILLATOR ON **PERIPHERALS** ON **WFI** INSTRUCTION OFF I BIT 0 Ν RESET INTERRUPT OSCILLATOR PERIPHERALS OFF CPU ON I BIT 0 256 CPU CLOCK CYCLE DELAY **OSCILLATOR** PERIPHERALS ON X ¹⁾ CPU I BIT FETCH RESET VECTOR OR SERVICE INTERRUPT

Figure 26. Wait mode flowchart

 Before servicing an interrupt, the CC register is pushed on the stack. The I bit of the CC register is set during the interrupt routine and cleared when the CC register is popped.

9.4 Active-Halt and Halt modes

Active-Halt and Halt modes are the two lowest power consumption modes of the MCU. They are both entered by executing the 'HALT' instruction. The decision to enter either in Active-Halt or Halt mode is given by the LTCSR/ATCSR register status as shown in the following table:

Table 19. Enabling/disabling Active-Halt and Halt modes

| LTCSR TBIE bit | ATCSR OVFIE bit | ATCSRCK1 bit | ATCSRCK0 bit | Meaning |
|----------------|-----------------|--------------|--------------|---------------------------|
| 0 | x | x | 0 | |
| 0 | 0 | x | x | Active-Halt mode disabled |
| 0 | 1 | 1 | 1 | |
| 1 | Х | Х | х | Active-Halt mode enabled |
| х | 1 | 0 | 1 | Active-Hait mode enabled |

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Power saving modes ST7LITE49M

9.4.1 Active-Halt mode

Active-Halt mode is the lowest power consumption mode of the MCU with a real time clock available. It is entered by executing the 'HALT' instruction when active halt mode is enabled.

The MCU can exit Active-Halt mode on reception of a Lite timer/ AT timer interrupt or a Reset.

- When exiting Active-Halt mode by means of a Reset, a 256 CPU cycle delay occurs.
 After the start up delay, the CPU resumes operation by fetching the Reset vector which woke it up (see Figure 28).
- When exiting Active-Halt mode by means of an interrupt, the CPU immediately resumes operation by servicing the interrupt vector which woke it up (see Figure 28).

When entering Active-Halt mode, the I bit in the CC register is cleared to enable interrupts. Therefore, if an interrupt is pending, the MCU wakes up immediately.

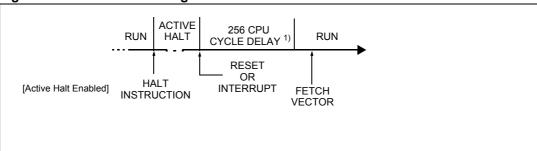
In Active-Halt mode, only the main oscillator and the selected timer counter (LT/AT) are running to keep a wake-up time base. All other peripherals are not clocked except those which get their clock supply from another clock generator (such as external or auxiliary oscillator).

Caution:

As soon as Active-Halt is enabled, executing a HALT instruction while the Watchdog is active does not generate a Reset if the WDGHALT bit is reset.

This means that the device cannot spend more than a defined delay in this power saving mode.

Figure 27. Active-Halt timing overview



1. This delay occurs only if the MCU exits Active-Halt mode by means of a RESET.

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ST7LITE49M Power saving modes

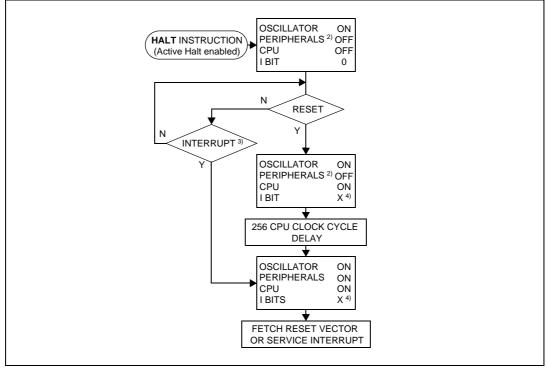


Figure 28. Active-Halt mode flowchart

- 1. This delay occurs only if the MCU exits Active-Halt mode by means of a RESET.
- 2. Peripherals clocked with an external clock source can still be active.
- 3. Only the Lite timer RTC and AT timer interrupts can exit the MCU from Active-Halt mode.
- Before servicing an interrupt, the CC register is pushed on the stack. The I bit of the CC register is set during the interrupt routine and cleared when the CC register is popped.

9.4.2 Halt mode

The Halt mode is the lowest power consumption mode of the MCU. It is entered by executing the HALT instruction when active halt mode is disabled.

The MCU can exit Halt mode on reception of either a specific interrupt (see *Table 17: Interrupt mapping*) or a Reset. When exiting Halt mode by means of a Reset or an interrupt, the main oscillator is immediately turned on and the 256 CPU cycle delay is used to stabilize it. After the start up delay, the CPU resumes operation by servicing the interrupt or by fetching the Reset vector which woke it up (see *Figure 30*).

When entering Halt mode, the I bit in the CC register is forced to 0 to enable interrupts. Therefore, if an interrupt is pending, the MCU wakes immediately.

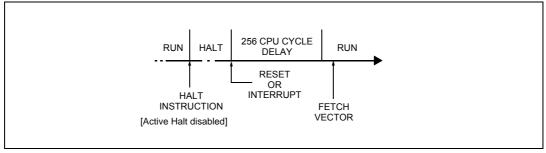
In Halt mode, the main oscillator is turned off causing all internal processing to be stopped, including the operation of the on-chip peripherals. All peripherals are not clocked except the ones which get their clock supply from another clock generator (such as an external or auxiliary oscillator).

The compatibility of Watchdog operation with Halt mode is configured by the "WDGHALT" option bit of the option byte. The HALT instruction when executed while the Watchdog system is enabled, can generate a Watchdog Reset (see Section 14.1: Option bytes for more details).

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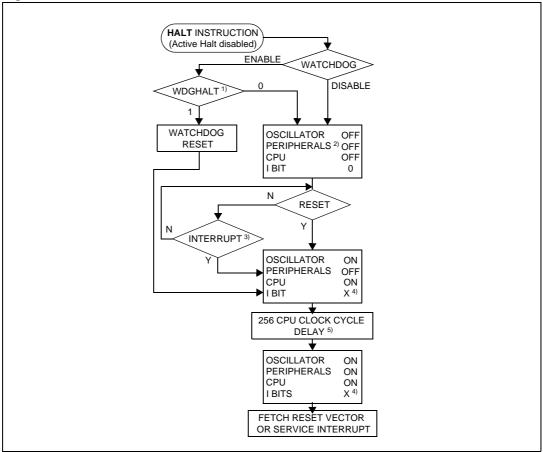
Power saving modes ST7LITE49M

Figure 29. Halt timing overview



1. A reset pulse of at least 42 μ s must be applied when exiting from Halt mode.

Figure 30. Halt mode flowchart



- 1. WDGHALT is an option bit. See option byte section for more details.
- 2. Peripheral clocked with an external clock source can still be active.
- Only some specific interrupts can exit the MCU from Halt mode (such as external interrupt). Refer to Table 17: Interrupt mapping for more details.
- 4. Before servicing an interrupt, the CC register is pushed on the stack. The I bit of the CC register is set during the interrupt routine and cleared when the CC register is popped.
- 5. The CPU clock must be switched to 1MHz (RC/8) or AWU RC before entering Halt mode.

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Halt mode recommendations

- Make sure that an external event is available to wake up the microcontroller from Halt mode.
- When using an external interrupt to wake up the microcontroller, reinitialize the
 corresponding I/O as "Input Pull-up with Interrupt" before executing the HALT
 instruction. The main reason for this is that the I/O may be wrongly configured due to
 external interference or by an unforeseen logical condition.
- For the same reason, reinitialize the level sensitiveness of each external interrupt as a precautionary measure.
- The opcode for the HALT instruction is 0x8E. To avoid an unexpected HALT instruction due to a Program Counter failure, it is advised to clear all occurrences of the data value 0x8E from memory. For example, avoid defining a constant in ROM with the value 0x8E.
- As the HALT instruction clears the I bit in the CC register to allow interrupts, the user may choose to clear all pending interrupt bits before executing the HALT instruction. This avoids entering other peripheral interrupt routines after executing the external interrupt routine corresponding to the wake-up event (reset or external interrupt).

9.5 Auto Wake Up from Halt mode

Auto Wake Up From Halt (AWUFH) mode is similar to Halt mode with the addition of a specific internal RC oscillator for wake-up (Auto Wake-Up from Halt oscillator) which replaces the main clock which was active before entering Halt mode. Compared to Active-Halt mode, AWUFH has lower power consumption (the main clock is not kept running), but there is no accurate realtime clock available.

It is entered by executing the HALT instruction when the AWUEN bit in the AWUCSR register has been set.

AWU RC

oscillator

to 8-bit timer Input Capture

AWUFH
interrupt
quivider

AWUFH
interrupt
(ei0 source)

Figure 31. AWUFH mode block diagram

vvv vv.DataOii

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As soon as Halt mode is entered, and if the AWUEN bit has been set in the AWUCSR register, the AWU RC oscillator provides a clock signal (f_{AWU_RC}). Its frequency is divided by a fixed divider and a programmable prescaler controlled by the AWUPR register. The output of this prescaler provides the delay time. When the delay has elapsed, the following actions are performed:

- the AWUF flag is set by hardware,
- an interrupt wakes-up the MCU from Halt mode,
- the main oscillator is immediately turned on and the 256 CPU cycle delay is used to stabilize it.

After this start-up delay, the CPU resumes operation by servicing the AWUFH interrupt. The AWU flag and its associated interrupt are cleared by software reading the AWUCSR register.

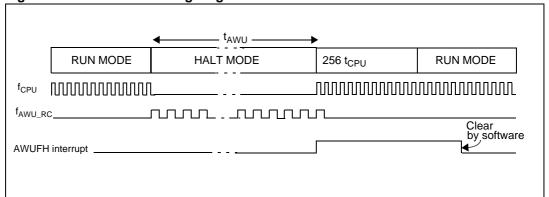
To compensate for any frequency dispersion of the AWU RC oscillator, it can be calibrated by measuring the clock frequency f_{AWU_RC} and then calculating the right prescaler value. Measurement mode is enabled by setting the AWUM bit in the AWUCSR register in Run mode. This connects f_{AWU_RC} to the Input Capture of the 8-bit Lite timer, allowing the f_{AWU_RC} to be measured using the main oscillator clock as a reference timebase.

Similarities with Halt mode

The following AWUFH mode behaviour is the same as normal Halt mode:

- The MCU can exit AWUFH mode by means of any interrupt with exit from Halt capability or a reset (see Section 9.4: Active-Halt and Halt modes).
- When entering AWUFH mode, the I bit in the CC register is forced to 0 to enable interrupts. Therefore, if an interrupt is pending, the MCU wakes up immediately.
- In AWUFH mode, the main oscillator is turned off causing all internal processing to be stopped, including the operation of the on-chip peripherals. None of the peripherals are clocked except those which get their clock supply from another clock generator (such as an external or auxiliary oscillator like the AWU oscillator).
- The compatibility of watchdog operation with AWUFH mode is configured by the WDGHALT option bit in the option byte. Depending on this setting, the HALT instruction when executed while the watchdog system is enabled, can generate a watchdog Reset.

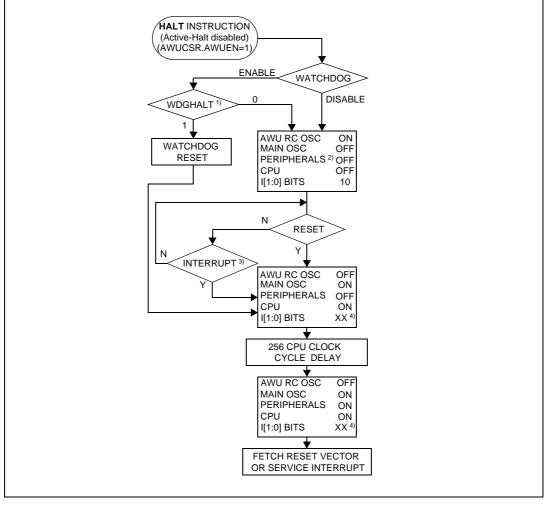




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Figure 33. AWUFH mode flowchart



- 1. WDGHALT is an option bit. See option byte section for more details.
- 2. Peripheral clocked with an external clock source can still be active.
- 3. Only an AWUFH interrupt and some specific interrupts can exit the MCU from Halt mode (such as external interrupt). Refer to *Table 17: Interrupt mapping* for more details.
- Before servicing an interrupt, the CC register is pushed on the stack. The I[1:0] bits of the CC register are set to the current software priority level of the interrupt routine and recovered when the CC register is popped.

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Power saving modes ST7LITE49M

9.5.1 Register description

9.5.2 AWUFH Control/Status register (AWUCSR)

Reset value: 0000 0000 (00h)

7 0 0 0 0 0 AWU AWUM AWUEN

Read/Write

Bits 7:3 = Reserved

Bit 2= AWUF Auto Wake Up flag

This bit is set by hardware when the AWU module generates an interrupt and cleared by software on reading AWUCSR. Writing to this bit does not change its value.

- 0: No AWU interrupt occurred
- 1: AWU interrupt occurred

Bit 1= AWUM Auto Wake Up Measurement bit

This bit enables the AWU RC oscillator and connects its output to the Input Capture of the 8-bit Lite timer. This allows the timer to be used to measure the AWU RC oscillator dispersion and then compensate this dispersion by providing the right value in the AWUPRE register.

- 0: Measurement disabled
- 1: Measurement enabled

Bit 0 = AWUEN Auto Wake Up From Halt Enabled bit

This bit enables the Auto Wake Up From Halt feature: once Halt mode is entered, the AWUFH wakes up the microcontroller after a time delay dependent on the AWU prescaler value. It is set and cleared by software.

- 0: AWUFH (Auto Wake Up From Halt) mode disabled
- 1: AWUFH (Auto Wake Up From Halt) mode enabled

Note: Whatever the clock source, this bit should be set to enable the AWUFH mode once the HALT instruction has been executed.

9.5.3 AWUFH Prescaler register (AWUPR)

Reset value: 1111 1111 (FFh)

7

| AWUPR | 7 AWUPR6 | AWUPR5 | AWUPR4 | AWUPR3 | AWUPR2 | AWUPR1 | AWUPR0 |
|------------|----------|--------|--------|--------|--------|--------|--------|
| Read/Write | | | | | | | |

Bits 7:0= AWUPR[7:0] Auto Wake Up Prescaler

These 8 bits define the AWUPR Dividing factor (see Table 20).

Table 20. Configuring the dividing factor

| AWUPR[7:0] | Dividing factor |
|------------|-----------------|
| 00h | Forbidden |
| 01h | 1 |
| | |
| FEh | 254 |
| FFh | 255 |

In AWU mode, the time during which the MCU stays in Halt mode, t_{AWU} , is given by the equation below. See also *Figure 32 on page 66*.

$$t_{AWU} = 64 \times AWUPR \times \frac{1}{f_{AWURC}} + t_{RCSTRT}$$

The AWUPR prescaler register can be programmed to modify the time during which the MCU stays in Halt mode before waking up automatically.

Note: If 00h is written to AWUPR, the AWUPR remains unchanged.

Table 21. AWU register mapping and reset values

| Address (Hex.) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------|--------------------------|--------|-------------|--------|-------------|--------|--------|--------|-------------|
| 0048h | AWUCSR Reset Value | 0 | 0 | 0 | 0 | 0 | AWUF | AWUM | AWUEN |
| 0049h | AWUPR Reset Value | AWUPR7 | AWUPR6 1 | AWUPR5 | AWUPR4 1 | AWUPR3 | AWUPR2 | AWUPR1 | AWUPR0 1 |

I/O ports ST7LITE49M

10 I/O ports

10.1 Introduction

The I/O ports allow data transfer. An I/O port can contain up to 8 pins. Each pin can be programmed independently either as a digital input or digital output. In addition, specific pins may have several other functions. These functions can include external interrupt, alternate signal input/output for on-chip peripherals or analog input.

www.DataSheet4U10.2 Functional description

A Data register (DR) and a Data Direction register (DDR) are always associated with each port. The Option register (OR), which allows input/output options, may or may not be implemented. The following description takes into account the OR register. Refer to the Port Configuration table for device specific information.

An I/O pin is programmed using the corresponding bits in the DDR, DR and OR registers: bit x corresponding to pin x of the port.

Figure 34 shows the generic I/O block diagram.

10.2.1 Input modes

Clearing the DDRx bit selects input mode. In this mode, reading its DR bit returns the digital value from that I/O pin.

If an OR bit is available, different input modes can be configured by software: floating or pullup. Refer to I/O Port Implementation section for configuration.

Note: 1 Writing to the DR modifies the latch value but does not change the state of the input pin.

2 Do not use read/modify/write instructions (BSET/BRES) to modify the DR register.

External interrupt function

Depending on the device, setting the ORx bit while in input mode can configure an I/O as an input with interrupt. In this configuration, a signal edge or level input on the I/O generates an interrupt request via the corresponding interrupt vector (eix).

Falling or rising edge sensitivity is programmed independently for each interrupt vector. The External Interrupt Control register (EICR) or the Miscellaneous register controls this sensitivity, depending on the device.

Each external interrupt vector is linked to a dedicated group of I/O port pins (see pinout description and interrupt section). If several I/O interrupt pins on the same interrupt vector are selected simultaneously, they are logically combined. For this reason if one of the interrupt pins is tied low, it may mask the others.

External interrupts are hardware interrupts. Fetching the corresponding interrupt vector automatically clears the request latch. Changing the sensitivity of a particular external interrupt clears this pending interrupt. This can be used to clear unwanted pending interrupts.

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Spurious interrupts

When enabling/disabling an external interrupt by setting/resetting the related OR register bit, a spurious interrupt is generated if the pin level is low and its edge sensitivity includes falling/rising edge. This is due to the edge detector input which is switched to '1' when the external interrupt is disabled by the OR register.

To avoid this unwanted interrupt, a "safe" edge sensitivity (rising edge for enabling and falling edge for disabling) has to be selected before changing the OR register bit and configuring the appropriate sensitivity again.

Caution:

In case a pin level change occurs during these operations (asynchronous signal input), as interrupts are generated according to the current sensitivity, it is advised to disable all interrupts before and to reenable them after the complete previous sequence in order to avoid an external interrupt occurring on the unwanted edge.

This corresponds to the following steps:

- Set the interrupt mask with the SIM instruction (in cases where a pin level change could occur)
- b) Select rising edge
- a) Enable the external interrupt through the OR register
- a) Select the desired sensitivity if different from rising edge
- Reset the interrupt mask with the RIM instruction (in cases where a pin level change could occur)
- 2. To disable an external interrupt:
 - Set the interrupt mask with the SIM instruction SIM (in cases where a pin level change could occur)
 - b) Select falling edge
 - c) Disable the external interrupt through the OR register
 - a) Select rising edge
 - a) Reset the interrupt mask with the RIM instruction (in cases where a pin level change could occur)

10.2.2 Output modes

Setting the DDRx bit selects output mode. Writing to the DR bits applies a digital value to the I/O through the latch. Reading the DR bits returns the previously stored value.

If an OR bit is available, different output modes can be selected by software: push-pull or open-drain. Refer to I/O Port Implementation section for configuration.

Table 22. DR Value and output pin status

| DR | Push-Pull | Open-Drain |
|----|-----------------|-----------------|
| 0 | V _{OL} | V _{OL} |
| 1 | V _{OH} | Floating |



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10.2.3 Alternate functions

Many ST7s I/Os have one or more alternate functions. These may include output signals from, or input signals to, on-chip peripherals. Table 2 describes which peripheral signals can be input/output to which ports.

A signal coming from an on-chip peripheral can be output on an I/O. To do this, enable the on-chip peripheral as an output (enable bit in the peripheral's control register). The peripheral configures the I/O as an output and takes priority over standard I/O programming. The I/O's state is readable by addressing the corresponding I/O data register.

Configuring an I/O as floating enables alternate function input. It is not recommended to configure an I/O as pull-up as this will increase current consumption. Before using an I/O as an alternate input, configure it without interrupt. Otherwise spurious interrupts can occur.

Configure an I/O as input floating for an on-chip peripheral signal which can be input and output.

Caution:

I/Os which can be configured as both an analog and digital alternate function need special attention. The user must control the peripherals so that the signals do not arrive at the same time on the same pin. If an external clock is used, only the clock alternate function should be employed on that I/O pin and not the other alternate function.

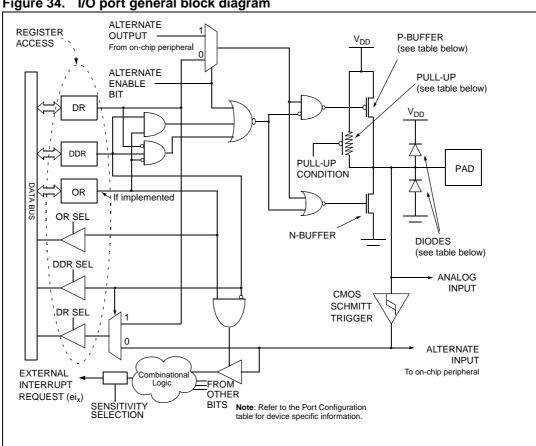


Figure 34. I/O port general block diagram

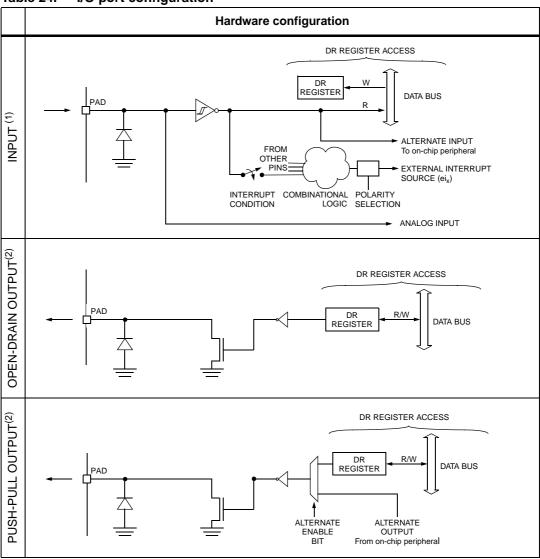
ST7LITE49M I/O ports

Table 23. I/O port mode options⁽¹⁾

| Configuration mode | | Pull-Up | P-Buffer | Diodes | | |
|--------------------|---------------------------------|---------|----------|--------------------|--------------------|--|
| | | Pull-Op | P-Bullel | to V _{DD} | to V _{SS} | |
| Input | Floating with/without Interrupt | Off | Off | | | |
| Input | Pull-up with Interrupt | On | Oii | On | On | |
| Output | Push-pull | Off | On | Oli | Oli | |
| Output | Open Drain (logic level) | Off - | Off | | | |

1. Off means implemented not activated, On means implemented and activated.

Table 24. I/O port configuration



- When the I/O port is in input configuration and the associated alternate function is enabled as an output, reading the DR register will read the alternate function output status.
- When the I/O port is in output configuration and the associated alternate function is enabled as an input, the alternate function reads the pin status given by the DR register content.

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I/O ports ST7LITE49M

10.2.4 Analog alternate function

Configure the I/O as floating input to use an ADC input. The analog multiplexer (controlled by the ADC registers) switches the analog voltage present on the selected pin to the common analog rail, connected to the ADC input.

Analog Recommendations

Do not change the voltage level or loading on any I/O while conversion is in progress. Do not have clocking pins located close to a selected analog pin.

Caution:

The analog input voltage level must be within the limits stated in the absolute maximum ratings.

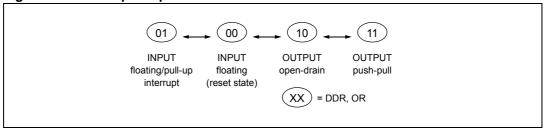
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10.3 I/O port implementation

The hardware implementation on each I/O port depends on the settings in the DDR and OR registers and specific I/O port features such as ADC input or open drain.

Switching these I/O ports from one state to another should be done in a sequence that prevents unwanted side effects. Recommended safe transitions are illustrated in *Figure 35*. Other transitions are potentially risky and should be avoided, since they may present unwanted side-effects such as spurious interrupt generation.

Figure 35. Interrupt I/O port state transitions



10.4 Unused I/O pins

Unused I/O pins must be connected to fixed voltage levels. Refer to Section 13.9: I/O port pin characteristics.

10.5 Low power modes

Table 25. Effect of low power modes on I/O ports

| Mode | Description |
|------|--|
| Wait | No effect on I/O ports. External interrupts cause the device to exit from Wait mode. |
| Halt | No effect on I/O ports. External interrupts cause the device to exit from Halt mode. |

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10.6 Interrupts

The external interrupt event generates an interrupt if the corresponding configuration is selected with DDR and OR registers and if the I bit in the CC register is cleared (RIM instruction).

Table 26. Description of interrupt events

| Interrupt Event | Event flag | Enable Control bit | Exit from Wait | Exit from Halt |
|---|------------|-----------------------|-------------------|-------------------|
| External interrupt on selected external event | - | DDRx ORx | Yes | Yes |

See application notes AN1045 software implementation of I^2C bus master, and AN1048 - software LCD driver

10.7 Device-specific I/O port configuration

The I/O port register configurations are summarised in *Section 10.7.1: Standard ports* and *Section 10.7.2: Other ports*.

10.7.1 Standard ports

Table 27. PA5:0, PB7:0, PC7:4 and PC2:0 pins

| Mode | DDR | OR |
|-------------------------|-----|----|
| floating input | 0 | 0 |
| pull-up interrupt input | 0 | 1 |
| open drain output | 1 | 0 |
| push-pull output | 1 | 1 |

10.7.2 Other ports

Table 28. PA7:6 pins

| Mode | DDR | OR |
|-------------------|-----|----|
| floating input | 0 | 0 |
| interrupt input | 0 | 1 |
| open drain output | 1 | 0 |
| push-pull output | 1 | 1 |

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Table 29. PC3 pins

| Mode | DDR | OR |
|-------------------|-----|----|
| floating input | 0 | 0 |
| pull-up input | 0 | 1 |
| open drain output | 1 | 0 |
| push-pull output | 1 | 1 |

Table 30. Port configuration

Input Output **Port** Pin name OR = 0OR = 1 OR = 0OR = 1 PA5:0 pull-up interrupt floating open drain push-pull Port A PA7:6 floating interrupt true open drain Port B PB7:0 floating pull-up interrupt open drain push-pull PC7:4, floating pull-up interrupt open drain push-pull PC2:0 Port C PC3 floating pull-up open drain push-pull

Table 31. I/O port register mapping and reset values

| Address (Hex.) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------|----------------------|----------|---|---|---|---|---|---|----------|
| 0000h | PADR Reset Value | MSB 0 | 0 | 0 | 0 | 0 | 0 | 0 | LSB 0 |
| 0001h | PADDR Reset Value | MSB 0 | 0 | 0 | 0 | 0 | 0 | 0 | LSB 0 |
| 0002h | PAOR Reset Value | MSB 0 | 0 | 0 | 0 | 0 | 0 | 0 | LSB 0 |
| 0003h | PBDR Reset Value | MSB 0 | 0 | 0 | 0 | 0 | 0 | 0 | LSB 0 |
| 0004h | PBDDR Reset Value | MSB 0 | 0 | 0 | 0 | 0 | 0 | 0 | LSB 0 |
| 0005h | PBOR Reset Value | MSB 0 | 0 | 0 | 0 | 0 | 0 | 0 | LSB 0 |
| 0006h | PCDR Reser Value | MSB 0 | 0 | 0 | 0 | 0 | 0 | 0 | LSB 0 |
| 0007h | PCDDR Reset Value | MSB 0 | 0 | 0 | 0 | 0 | 0 | 0 | LSB 0 |
| 0008h | PCOR Reset Value | MSB 0 | 0 | 0 | 0 | 1 | 0 | 0 | LSB 0 |

11 On-chip peripherals

11.1 Watchdog timer (WDG)

11.1.1 Introduction

The Watchdog timer is used to detect the occurrence of a software fault, usually generated by external interference or by unforeseen logical conditions, which causes the application program to abandon its normal sequence. The Watchdog circuit generates an MCU reset on expiry of a programmed time period, unless the program refreshes the counter's contents before the T6 bit becomes cleared.

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11.1.2 Main features

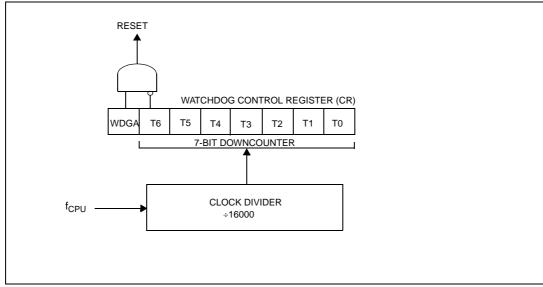
- Programmable free-running downcounter (64 increments of 16000 CPU cycles)
- Programmable reset
- Reset (if watchdog activated) when the T6 bit reaches zero
- Optional reset on HALT instruction (configurable by option byte)
- Hardware Watchdog selectable by option byte

11.1.3 Functional description

The counter value stored in the CR register (bits T[6:0]), is decremented every 16000 machine cycles, and the length of the timeout period can be programmed by the user in 64 increments.

If the watchdog is activated (the WDGA bit is set) and when the 7-bit timer (bits T[6:0]) rolls over from 40h to 3Fh (T6 becomes cleared), it initiates a reset cycle pulling low the RESET pin for typically 30 μ s.

Figure 36. Watchdog block diagram



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The application program must write in the CR register at regular intervals during normal operation to prevent an MCU reset. This downcounter is free-running: it counts down even if the watchdog is disabled. The value to be stored in the CR register must be between FFh and C0h (see *Table 32: Watchdog timing*):

- The WDGA bit is set (watchdog enabled)
- The T6 bit is set to prevent generating an immediate reset
- The T[5:0] bits contain the number of increments which represents the time delay before the watchdog produces a reset.

Following a reset, the watchdog is disabled. Once activated it cannot be disabled, except by a reset.

The T6 bit can be used to generate a software reset (the WDGA bit is set and the T6 bit is cleared).

If the watchdog is activated, the HALT instruction will generate a Reset.

Table 32. Watchdog timing⁽¹⁾⁽²⁾

| f _{CPU} = 8MHz | | | | |
|-------------------------|-------------|-------------|--|--|
| WDG counter code | min [ms] | max [ms] | | |
| C0h | 1 | 2 | | |
| FFh | 127 | 128 | | |

^{1.} The timing variation shown in *Table 32* is due to the unknown status of the prescaler when writing to the CR register.

11.1.4 Hardware watchdog option

If Hardware Watchdog is selected by option byte, the watchdog is always active and the WDGA bit in the CR is not used.

Refer to the option byte description in Section 14 on page 175.

Using Halt mode with the WDG (WDGHALT option)

If Halt mode with Watchdog is enabled by option byte (No watchdog reset on HALT instruction), it is recommended before executing the HALT instruction to refresh the WDG counter, to avoid an unexpected WDG reset immediately after waking up the microcontroller. Same behaviour in active-halt mode.

11.1.5 Interrupts

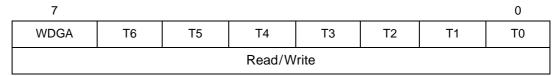
None.

^{2.} The number of CPU clock cycles applied during the Reset phase (256 or 4096) must be taken into account in addition to these timings.

11.1.6 Register description

Control register (WDGCR)

Reset value: 0111 1111 (7Fh)



Bit 7 = WDGA Activation bit

This bit is set by software and only cleared by hardware after a reset. When WDGA = 1, the watchdog can generate a reset.

0: Watchdog disabled

1: Watchdog enabled

Note: This bit is not used if the hardware watchdog option is enabled by option byte.

Bit 6:0 = **T[6:0]** 7-bit timer (MSB to LSB)

These bits contain the decremented value. A reset is produced when it rolls over from 40h to 3Fh (T6 becomes cleared).

Table 33. Watchdog timer register mapping and reset values

| Address (Hex.) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------|-------------------------|-----------|---------|---------|---------|---------|---------|---------|---------|
| 0033h | WDGCR Reset Value | WDGA 0 | T6 1 | T5 1 | T4 1 | T3 1 | T2 1 | T1 1 | T0 1 |

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11.2 Dual 12-bit autoreload timer

11.2.1 Introduction

The 12-bit Autoreload timer can be used for general-purpose timing functions. It is based on one or two free-running 12-bit upcounters with an Input Capture register and four PWM output channels. There are 7 external pins:

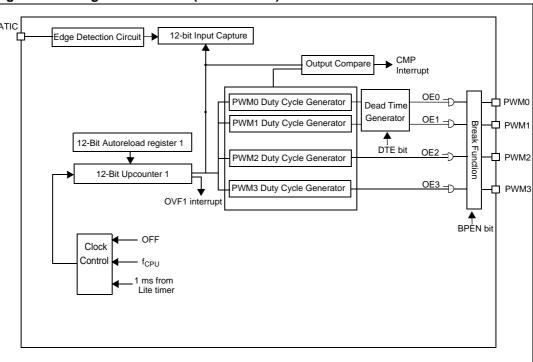
- Four PWM outputs
- ATIC/LTIC pins for the Input Capture function
- BREAK pin for forcing a break condition on the PWM outputs

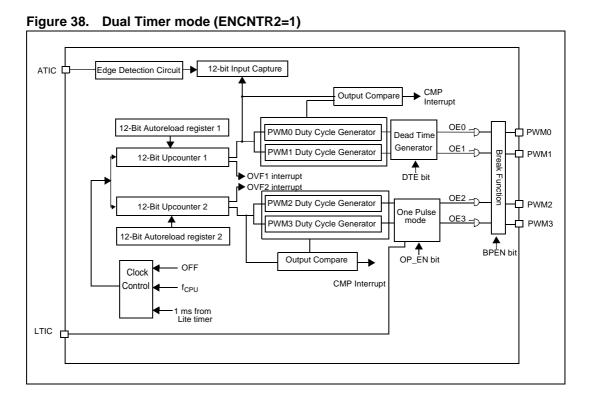
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11.2.2 Main features

- Single Timer or Dual Timer mode with two 12-bit upcounters (CNTR1/CNTR2) and two 12-bit autoreload registers (ATR1/ATR2)
- Maskable overflow interrupts
- PWM mode
 - Generation of four independent PWMx signals
 - Dead time generation for Half bridge driving mode with programmable dead time
 - Frequency 2kHz-4MHz (@ 8 MHz f_{CPU})
 - Programmable duty-cycles
 - Polarity control
 - Programmable output modes
- Output Compare mode
- Input Capture mode
 - 12-bit Input Capture register (ATICR)
 - Triggered by rising and falling edges
 - Maskable IC interrupt
 - Long range Input Capture
- Internal/External Break control
- Flexible Clock control
- One Pulse mode on PWM2/3
- Force update

Figure 37. Single Timer mode (ENCNTR2=0)





11.2.3 Functional description

PWM mode

This mode allows up to four Pulse Width Modulated signals to be generated on the PWMx output pins.

PWM frequency

The four PWM signals can have the same frequency (f_{PWM}) or can have two different frequencies. This is selected by the ENCNTR2 bit which enables Single Timer or Dual Timer mode (see *Figure 37* and *Figure 38*). The frequency is controlled by the counter period and the ATR register value. In Dual Timer mode, PWM2 and PWM3 can be generated with a different frequency controlled by CNTR2 and ATR2.

$$f_{PWM} = f_{COUNTER}/(4096 - ATR)$$

Following the above formula, if $f_{COUNTER}$ equals 4 Mhz, the maximum value of f_{PWM} is 2 MHz (ATR register value = 4094), and the minimum value is 1 KHz (ATR register value = 0).

The maximum value of ATR is 4094 because it must be lower than the DC4R value which must be 4095 in this case.

To update the DCRx registers at 32MHz, the following precautions must be taken:

- If the PWM frequency is < 1MHz and the TRANx bit is set asynchronously, it should be set twice after a write to the DCRx registers.
- If the PWM frequency is > 1MHz, the TRANx bit should be set along with FORCEx bit with the same instruction (use a load instruction and not 2 bset instructions).

Duty cycle

The duty cycle is selected by programming the DCRx registers. These are preload registers. The DCRx values are transferred in Active duty cycle registers after an overflow event if the corresponding transfer bit (TRANx bit) is set.

The TRAN1 bit controls the PWMx outputs driven by counter 1 and the TRAN2 bit controls the PWMx outputs driven by counter 2.

PWM generation and output compare are done by comparing these active DCRx values with the counter.

The maximum available resolution for the PWMx duty cycle is:

Resolution =
$$1/(4096 - ATR)$$

where ATR is equal to 0. With this maximum resolution, 0% and 100% duty cycle can be obtained by changing the polarity.

At reset, the counter starts counting from 0.

When a upcounter overflow occurs (OVF event), the preloaded Duty cycle values are transferred to the active Duty Cycle registers and the PWMx signals are set to a high level. When the upcounter matches the active DCRx value the PWMx signals are set to a low level. To obtain a signal on a PWMx pin, the contents of the corresponding active DCRx register must be greater than the contents of the ATR register.

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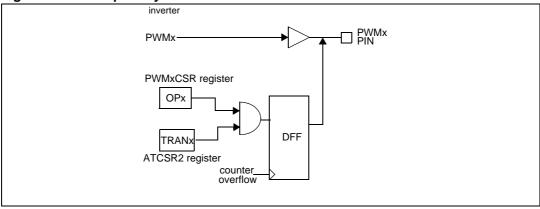
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The maximum value of ATR is 4094 because it must be lower than the DCR value which must be 4095 in this case.

Polarity inversion

The polarity bits can be used to invert any of the four output signals. The inversion is synchronized with the counter overflow if the corresponding transfer bit in the ATCSR2 register is set (reset value). See *Figure 39*.

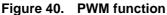
Figure 39. PWM polarity inversion

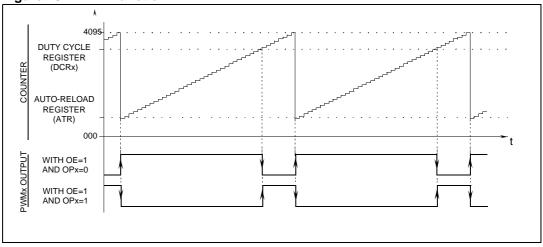


The Data Flip Flop (DFF) applies the polarity inversion when triggered by the counter overflow input.

Output control

The PWMx output signals can be enabled or disabled using the OEx bits in the PWMCR register.





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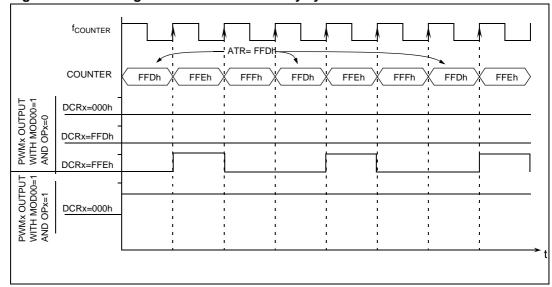


Figure 41. PWM signal from 0% to 100% duty cycle

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Dead time generation

A dead time can be inserted between PWM0 and PWM1 using the DTGR register. This is required for half-bridge driving where PWM signals must not be overlapped. The non-overlapping PWM0/PWM1 signals are generated through a programmable dead time by setting the DTE bit.

Dead time = $DT[6:0] \times Tcounter1$

DTGR[7:0] is buffered inside so as to avoid deforming the current PWM cycle. The DTGR effect will take place only after an overflow.

Note:

- 1 Dead time is generated only when DTE=1 and DT[6:0] ≠ 0. If DTE is set and DT[6:0]=0, PWM output signals will be at their reset state.
- 2 Half Bridge driving is possible only if polarities of PWM0 and PWM1 are not inverted, i.e. if OP0 and OP1 are not set. If polarity is inverted, overlapping PWM0/PWM1 signals will be generated.
- 3 Dead Time generation does not work at 1msec timebase.

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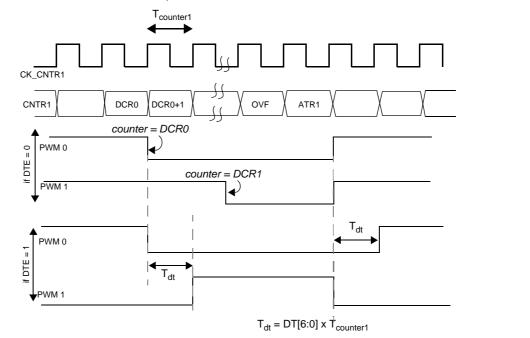


Figure 42. Dead time generation

In the above example, when the DTE bit is set:

- PWM goes low at DCR0 match and goes high at ATR1+Tdt
- PWM1 goes high at DCR0+Tdt and goes low at ATR match.

With this programmable delay (Tdt), the PWM0 and PWM1 signals which are generated are not overlapped.

Break function

The break function can be used to perform an emergency shutdown of the application being driven by the PWM signals.

The break function is activated by the external BREAK pin. This can be selected by using the BRSEL bit in BREAKCR register. In order to use the break function it must be previously enabled by software setting the BPEN bit in the BREAKCR register.

The Break active level can be programmed by the BREDGE bit in the BREAKCR register. When an active level is detected on the BREAK pin, the BA bit is set and the break function is activated. In this case, the PWM signals are forced to BREAK value if respective OEx bit is set in PWMCR register.

Software can set the BA bit to activate the break function without using the BREAK pin. The BREN1 and BREN2 bits in the BREAKEN register are used to enable the break activation on the 2 counters respectively. In Dual Timer mode, the break for PWM2 and PWM3 is enabled by the BREN2 bit. In Single Timer mode, the BREN1 bit enables the break for all PWM channels.

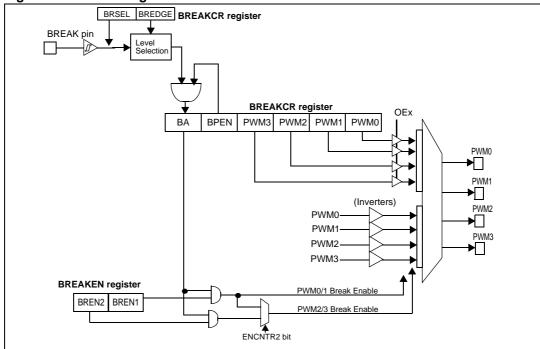
When a break function is activated (BA bit =1 and BREN1/BREN2 =1):

- The break pattern (PWM[3:0] bits in the BREAKCR) is forced directly on the PWMx output pins if respective OEx is set. (after the inverter).
- The 12-bit PWM counter CNTR1 is put to its reset value, i.e. 00h (if BREN1 = 1).
- The 12-bit PWM counter CNTR2 is put to its reset value,i.e. 00h (if BREN2 = 1).
- ATR1, ATR2, Preload and Active DCRx are put to their reset values.
- Counters stop counting.

When the break function is deactivated after applying the break (BA bit goes from 1 to 0 by software), Timer takes the control of PWM ports.

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Output compare mode

To use this function, load a 12-bit value in the Preload DCRxH and DCRxL registers.

When the 12-bit upcounter CNTR1 reaches the value stored in the Active DCRxH and DCRxL registers, the CMPFx bit in the PWMxCSR register is set and an interrupt request is generated if the CMPIE bit is set.

In Single Timer mode the output compare function is performed only on CNTR1. The difference between both the modes is that, in Single Timer mode, CNTR1 can be compared with any of the four DCR registers, and in Dual Timer mode, CNTR1 is compared with DCR0 or DCR1 and CNTR2 is compared with DCR2 or DCR3.

Note: 1 The output compare function is only available for DCRx values other than 0 (reset value).

2 Duty cycle registers are buffered internally. The CPU writes in Preload Duty Cycle registers and these values are transferred in Active Duty Cycle registers after an overflow event if the corresponding transfer bit (TRANx bit) is set. Output compare is done by comparing these active DCRx values with the counters.

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(ATCSR2) TRAN1

(ATCSR) OVF

ACTIVE DUTY CYCLE REGX

CNTR1

CMP

INTERRUPT REQUEST

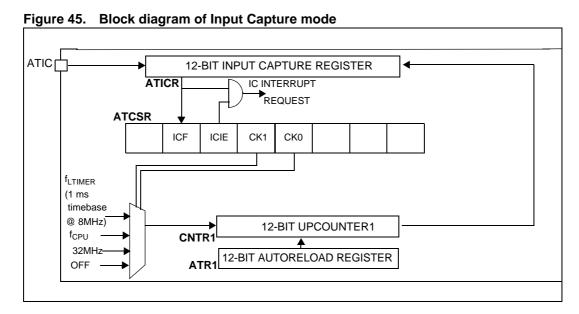
CMPIE (ATCSR)

Figure 44. Block diagram of output compare mode (single timer)

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Input Capture mode

The 12-bit ATICR register is used to latch the value of the 12-bit free running upcounter CNTR1 after a rising or falling edge is detected on the ATIC pin. When an Input Capture occurs, the ICF bit is set and the ATICR register contains the value of the free running upcounter. An IC interrupt is generated if the ICIE bit is set. The ICF bit is reset by reading the ATICRH/ATICRL register when the ICF bit is set. The ATICR is a read only register and always contains the free running upcounter value which corresponds to the most recent Input Capture. Any further Input Capture is inhibited while the icf bit is set.



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fCOUNTER COUNTER1 02h 03h 05h 06h 07h 08h 09h 0Ah ATIC PIN INTERRUPT INTERRUPT ATICR READ ICF FLAG 09h xxh ı 04h

Figure 46. Input Capture timing diagram

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Long range input Capture

Pulses that last more than 8 μ s can be measured with an accuracy of 4 μ s if f_{OSC} equals 8 MHz in the following conditions:

- The 12-bit AT4 timer is clocked by the Lite timer (RTC pulse: CK[1:0] = 01 in the ATCSR register)
- The ICS bit in the ATCSR2 register is set so that the LTIC pin is used to trigger the AT4 timer capture.
- The signal to be captured is connected to LTIC pin
- Input Capture registers LTICR, ATICRH and ATICRL are read

This configuration allows to cascade the Lite timer and the 12-bit AT4 timer to get a 20-bit Input Capture value. Refer to *Figure 47*.

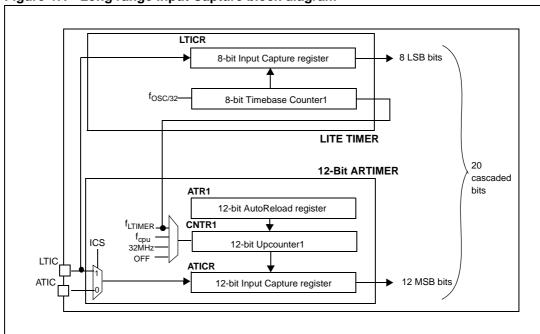


Figure 47. Long range Input Capture block diagram

Since the Input Capture flags (ICF) for both timers (AT4 timer and LT timer) are set when signal transition occurs, software must mask one interrupt by clearing the corresponding ICIE bit before setting the ICS bit.

If the ICS bit changes (from 0 to 1 or from 1 to 0), a spurious transition might occur on the Input Capture signal because of different values on LTIC and ATIC. To avoid this situation, it is recommended to do as follows:

- 1. First, reset both ICIE bits.
- 2. Then set the ICS bit.
- 3. Reset both ICF bits.
- And then set the ICIE bit of desired interrupt.

Computing a pulse length in long Input Capture mode is not straightforward since both timers are used. The following steps are required:

- 1. At the first Input Capture on the rising edge of the pulse, we assume that values in the registers are the following:
 - LTICR = LT1
 - ATICRH = ATH1
 - ATICRL = ATL1
 - Hence ATICR1 [11:0] = ATH1 & ATL1. Refer to Figure 48 on page 90.
- 2. At the second Input Capture on the falling edge of the pulse, we assume that the values in the registers are as follows:
 - LTICR = LT2
 - ATICRH = ATH2
 - ATICRL = ATL2
 - Hence ATICR2 [11:0] = ATH2 & ATL2.

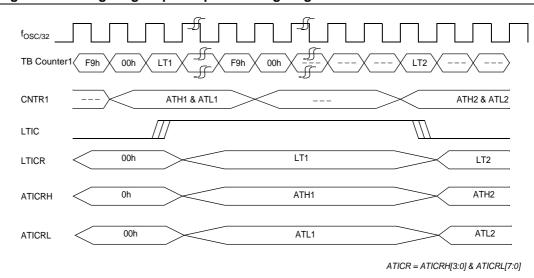
Now pulse width P between first capture and second capture is given by:

$$\begin{array}{l} P = \mbox{decimal} \times (F9 - LT1 + LT2 + 1) \times 0.004 \mbox{ms} \\ + \mbox{decimal} ((FFF \times N) + N + ATICR2 - ATICR1 - 1) \times 1 \mbox{ms} \end{array}$$

where N is the number of overflows of 12-bit CNTR1.

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Figure 48. Long range Input Capture timing diagram



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One Pulse mode

One Pulse mode can be used to control PWM2/3 signal with an external LTIC pin. This mode is available only in Dual Timer mode i.e. only for CNTR2, when the OP_EN bit in PWM3CSR register is set.

One Pulse mode is activated by the external LTIC input. The active edge of the LTIC pin is selected by the OPEDGE bit in the PWM3CSR register.

After getting the active edge of the LTIC pin, CNTR2 is reset (000h) and PWM3 is set to high. CNTR2 starts counting from 000h, when it reaches the active DCR3 value then PWM3 goes low. Till this time, any further transitions on the LTIC signal will have no effect. If there are LTIC transistions after CNTR2 reaches DCR3 value, CNTR2 is reset again and PWM3 goes high.

If there is no LTIC active edge, CNTR2 counts until it reaches the ATR2 value, then it is reset again and PWM3 is set to high. The counter again starts couting from 000h, when it reaches the active DCR3 value PWM3 goes low, the counter counts until it reaches ATR2, it resets and PWM3 is set to high and so on.

The same operation applies for PWM2, but in this case the comparison is done on DCR2. OP_EN and OPEDGE bits take effect on the fly and are not synchronized with Counter 2 overflow. The output bit OP2/3 can be used to inverse the polarity of PWM2/3 in one-pulse mode. The update of these bits (OP2/3) is synchronized with the counter 2 overflow, they will be updated if the TRAN2 bit is set.

The time taken from activation of LTIC input and CNTR2 reset is between 1 and 2 t_{cpu} cycles, i.e. 125n to 250ns (with 8MHz f_{cpu}).

Litetimer Input Capture interrupt should be disabled while 12-bit ARtimer is in One Pulse mode. This is to avoid spurious interrupts.

The priority of the various conditions for PWM3 is the following: Break > one-pulse mode with active LTIC edge > Forced overflow by s/w > one-pulse mode without active LTIC edge > normal PWM operation.

It is possible to update DCR2/3 and OP2/3 at the counter 2 reset, the update is synchronized with the counter reset. This is managed by the overflow interrupt which is generated if counter is reset either due to ATR match or active pulse at LTIC pin. DCR2/3 and OP2/3 update in one-pulse mode is performed dynamically using a software force update. DCR3 update in this mode is not synchronized with any event. That may lead to a longer next PWM3 cycle duration than expected just after the change.

In One Pulse mode ATR2 value must be greater than DCR2/3 value for PWM2/3. (opposite to normal PWM mode).

If there is an active edge on the LTIC pin after the counter has reset due to an ATR2 match, then the timer again gets reset and appears as modified Duty cycle depending on whether the new DCR value is less than or more than the previous value.

The TRAN2 bit should be set along with the FORCE2 bit with the same instruction after a write to the DCR register.

ATR2 value should be changed after an overflow in one pulse mode to avoid any irregular PWM cycle.

When exiting from one pulse mode, the OP_EN bit in the PWM3CSR register should be reset first and then the ENCNTR2 bit (if counter 2 must be stopped).

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How to enter One Pulse mode

The steps required to enter One Pulse mode are the following:

- Load ATR2H/ATR2L with required value.
- 2. Load DCR3H/DCR3L for PWM3. ATR2 value must be greater than DCR3.
- 3. Set OP3 in PWM3CSR if polarity change is required.
- 4. Select CNTR2 by setting ENCNTR2 bit in ATCSR2.
- 5. Set TRAN2 bit in ATCSR2 to enable transfer.
- 6. "Wait for Overflow" by checking the OVF2 flag in ATCSR2.
- 7. Select counter clock using CK<1:0> bits in ATCSR.
- 8. Set OP_EN bit in PWM3CSR to enable one-pulse mode.
- 9. Enable PWM3 by OE3 bit of PWMCR.

The "Wait for Overflow" in step 6 can be replaced by a forced update.

Follow the same procedure for PWM2 with the bits corresponding to PWM2.

Note: When break is applied in one-pulse mode, CNTR2, DCR2/3 & ATR2 registers are reset. So, these registers have to be intialised again when break is removed.

Figure 49. Block diagram of One Pulse mode

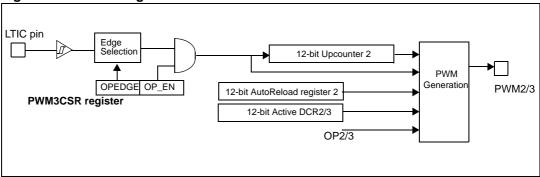
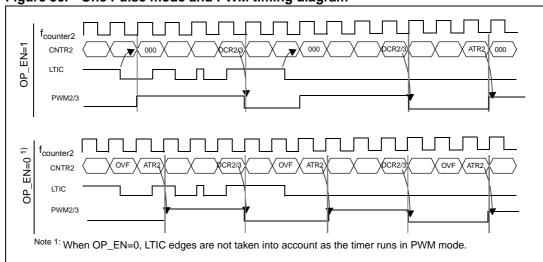


Figure 50. One Pulse mode and PWM timing diagram



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FORCE2

TRAN2

DCR2/3

DCR2/3

DCR2/3)old

Extra PWM3 period due to DCR3 update dynamically in one-pulse mode.

Figure 51. Dynamic DCR2/3 update in One Pulse mode

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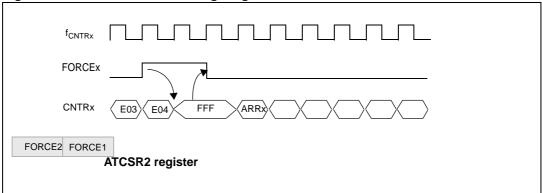
Force update

In order not to wait for the counter_x overflow to load the value into active DCRx registers, a programmable counter_x overflow is provided. For both counters, a separate bit is provided which when set, make the counters start with the overflow value, i.e. FFFh. After overflow, the counters start counting from their respective auto reload register values.

These bits are FORCE1 and FORCE2 in the ATCSR2 register. FORCE1 is used to force an overflow on Counter 1 and, FORCE2 is used for Counter 2. These bits are set by software and reset by hardware after the respective counter overflow event has occurred.

This feature can be used at any time. All related features such as PWM generation, Output Compare, Input Capture, One-pulse (refer to *Figure 51: Dynamic DCR2/3 update in One Pulse mode*) etc can be used this way.





11.2.4 Low power modes

Table 34. Effect of low power modes on autoreload timer

| Mode | Description | | | | |
|------|-----------------------|--|--|--|--|
| Wait | No effect on AT timer | | | | |
| Halt | AT timer halted. | | | | |

11.2.5 Interrupts

Table 35. Description of interrupt events

| Interrupt Event | Event Flag | Enable Control bit | Exit from Wait | Exit from Halt | Exit from Active-Halt | | |
|-----------------|---------------|-----------------------|-------------------|-------------------|-----------------------|--|--|
| Overflow Event | OVF1 | OVIE1 | Yes | No | Yes | | |
| AT4 IC Event | ICF | ICIE | Yes | No | No | | |
| Overflow Event2 | OVF2 | OVIE2 | Yes | No | No | | |

Note:

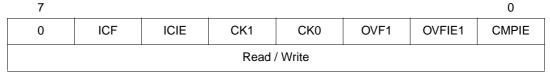
The AT4 IC is connected to an interrupt vector. The OVF event is mapped on a separate vector (see Interrupts chapter).

They generate an interrupt if the enable bit is set in the ATCSR register and the interrupt mask in the CC register is reset (RIM instruction).

11.2.6 Register description

Timer Control Status register (ATCSR)

Reset value: 0x00 0000 (x0h)



Bit 7 = Reserved

Bit 6 = **ICF** Input Capture flag

This Bit is set by hardware and cleared by software by reading the ATICR register (a read access to ATICRH or ATICRL clears this flag). Writing to this bit does not change the bit value.

0: No Input Capture

1: An Input Capture Has Occurred

Bit 5 = ICIE IC Interrupt Enable bit

This bit is set and cleared by software.

0: Input Capture Interrupt Disabled

1: Input Capture Interrupt Enabled

Bits 4:3 = CK[1:0] Counter Clock Selection bits

These bits are set and cleared by software and cleared by hardware after a reset. they select the clock frequency of the counter.

Table 36. Counter clock selection

| Counter clock selection | CK1 | CK0 |
|---|-----|-----|
| OFF | 0 | 0 |
| selection forbidden | 1 | 1 |
| f _{LTIMER} (1 ms timebase @ 8 MHz) | 0 | 1 |
| f _{CPU} | 1 | 0 |

Bit 2 = **OVF1** Overflow flag

This bit is set by hardware and cleared by software by reading the ATCSR register. It indicates the transition of the Counter1 CNTR1 from FFFh to ATR1 value.

0: No Counter Overflow Occurred

1: Counter Overflow Occurred

Bit 1 = **OVFIE1** Overflow Interrupt Enable bit

This bit is read/write by software and cleared by hardware after a reset.

0: Overflow Interrupt Disabled.

1: Overflow Interrupt Enabled.

Bit 0 = CMPIE Compare Interrupt Enable bit

This bit is read/write by software and cleared by hardware after a reset. it can be used to mask the interrupt generated when any of the cmpfx bit is set.

- 0: Output Compare Interrupt Disabled.
- 1: Output Compare Interrupt Enabled.

Counter register 1 High (CNTR1H)

Reset value: 0000 0000 (00h)

15 8
0 0 0 0 CNTR1_ CNTR1_9 CNTR1_8
Read only

Counter register 1 Low (CNTR1L)

Reset value: 0000 0000 (00h)

7 0

CNTR1_7 CNTR1_6 CNTR1_5 CNTR1_4 CNTR1_3 CNTR1_2 CNTR1_1 CNTR1_0

Read only

Bits 15:12 = Reserved

Bits 11:0 = CNTR1[11:0] Counter value

This 12-bit register is read by software and cleared by hardware after a reset. The counter CNTR1 increments continuously as soon as a counter clock is selected. To obtain the 12-bit value, software should read the counter value in two consecutive read operations. As there is no latch, it is recommended to read LSB first. In this case, CNTR1H can be incremented between the two read operations and to have an accurate result when $f_{timer} = f_{CPU}$, special care must be taken when CNTR1L values close to FFh are read.

When a counter overflow occurs, the counter restarts from the value specified in the ATR1 register.

Autoreload register (ATR1H)

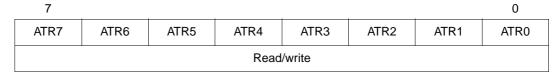
Reset value: 0000 0000 (00h)

15 8 0 0 0 0 ATR11 ATR10 ATR9 ATR8 Read/write

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Autoreload register (ATR1L)

Reset value: 0000 0000 (00h)

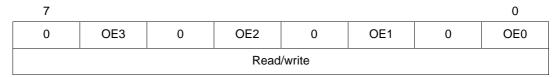


Bits 11:0 = ATR1[11:0] Autoreload register 1:

This is a 12-bit register which is written by software. The ATR1 register value is automatically loaded into the upcounter CNTR1 when an overflow occurs. The register value is used to set the PWM frequency.

PWM Output Control register (PWMCR)

Reset value: 0000 0000 (00h)



Bits 7:0 = **OE[3:0]** PWMx output enable bits

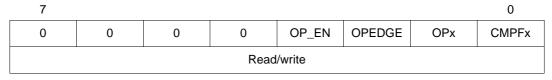
These bits are set and cleared by software and cleared by hardware after a reset.

0: PWM mode disabled. PWMx Output Alternate function disabled (I/O pin free for general purpose I/O)

1: PWM mode enabled

PWMX Control Status register (PWMxCSR)

Reset value: 0000 0000 (00h)



Bits 7:4= Reserved, must be kept cleared.

Bit 3 = OP_EN One Pulse Mode Enable bit

This bit is read/write by software and cleared by hardware after a reset. This bit enables the One Pulse feature for PWM2 and PWM3 (only available for PWM3CSR)

- 0: One Pulse mode disable for PWM2/3.
- 1: One Pulse mode enable for PWM2/3.

Bit 2 = OPEDGE One Pulse Edge Selection bit

This bit is read/write by software and cleared by hardware after a reset. This bit selects the polarity of the LTIC signal for One Pulse feature. This bit will be effective only if OP_EN bit is set (only available for PWM3CSR)

- 0: Falling edge of LTIC is selected.
- 1: Rising edge of LTIC is selected.

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Bit 1 = **OPx** *PWMx Output Polarity bit*

This bit is read/write by software and cleared by hardware after a reset. This bit selects the polarity of the PWM signal.

- 0: The PWM signal is not inverted.
- 1: The PWM signal is inverted.

Bit 0 = **CMPFx** PWMx Compare flag

This bit is set by hardware and cleared by software by reading the PWMxCSR register. It indicates that the upcounter value matches the Active DCRx register value.

- 0: Upcounter value does not match DCRx value.
- 1: Upcounter value matches DCRx value.

Break Control register (BREAKCR)

Reset value: 0000 0000 (00h)

7 0 BREDGE BA BPEN PWM3 PWM2 PWM1 PWM0 Read/write

Bit 7 = Reserved.

Bit 6 = **BREDGE** Break Input Edge Selection bit

This bit is read/write by software and cleared by hardware after reset. It selects the active level of Break signal.

- 0: Low level of Break selected as active level
- 1: High level of Break selected as active level

Bit 5 = **BA** Break Active bit

This bit is read/write by software, cleared by hardware after reset and set by hardware when the active level defined by the BREDGE bit is applied on the BREAK pin. It activates/deactivates the Break function.

- 0: Break not active
- 1: Break active

Bit 4 = **BPEN** Break Pin Enable bit

This bit is read/write by software and cleared by hardware after Reset.

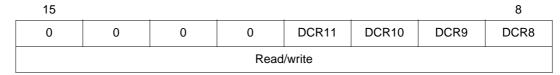
- 0: Break pin disabled
- 1: Break pin enabled

Bits 3:0 = PWM[3:0] Break Pattern bits

These bits are read/write by software and cleared by hardware after a reset. They are used to force the four PWMx output signals into a stable state when the Break function is active and corresponding OEx bit is set.

PWMx Duty Cycle register High (DCRxH)

Reset value: 0000 0000 (00h)

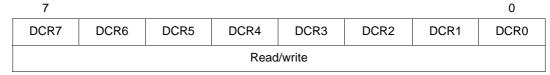


Bits 15:12 = Reserved.

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PWMx Duty Cycle register Low (DCRxL)

Reset value: 0000 0000 (00h)

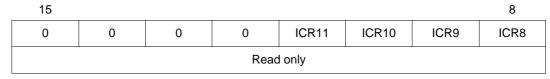


Bits 11:0 = **DCRx[11:0]** *PWMx Duty Cycle Value:* this 12-bit value is written by software. It defines the duty cycle of the corresponding PWM output signal (see *Figure 40*).

In PWM mode (OEx=1 in the PWMCR register) the DCR[11:0] bits define the duty cycle of the PWMx output signal (see *Figure 40*). In Output Compare mode, they define the value to be compared with the 12-bit upcounter value.

Input Capture register High (ATICRH)

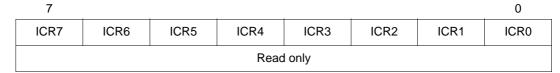
Reset value: 0000 0000 (00h)



Bits 15:12 = Reserved.

Input Capture register Low (ATICRL)

Reset value: 0000 0000 (00h)

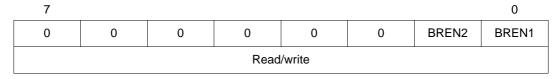


Bits 11:0 = ICR[11:0] Input Capture Data.

This is a 12-bit register which is readable by software and cleared by hardware after a reset. The ATICR register contains captured the value of the 12-bit CNTR1 register when a rising or falling edge occurs on the ATIC or LTIC pin (depending on ICS). Capture will only be performed when the ICF flag is cleared.

Break Enable register (BREAKEN)

Reset value: 0000 0011 (03h)



Bits 7:2 = Reserved, must be kept cleared.

Bit 1 = **BREN2** Break Enable for Counter 2 bit

This bit is read/write by software. It enables the break functionality for Counter2 if BA bit is set in BREAKCR. It controls PWM2/3 if ENCNTR2 bit is set.

- 0: No Break applied for CNTR2
- 1: Break applied for CNTR2

Bit 0 = **BREN1** Break Enable for Counter 1 bit

This bit is read/write by software. It enables the break functionality for Counter1. If BA bit is set, it controls PWM0/1 by default, and controls PWM2/3 also if ENCNTR2 bit is reset.

- 0: No Break applied for CNTR1
- 1: Break applied for CNTR1

Timer Control register 2 (ATCSR2)

Reset value: 0000 0011 (03h)

7

| ſ | FORCE2 | FORCE1 | ICS | OVFIE2 | OVF2 | ENCNTR2 | TRAN2 | TRAN1 |
|---|------------|--------|-----|--------|------|---------|-------|-------|
| | Read/write | | | | | | | |

Bit 7 = FORCE2 Force Counter 2 Overflow bit

This bit is read/set by software. When set, it loads FFFh in the CNTR2 register. It is reset by hardware one CPU clock cycle after counter 2 overflow has occurred.

0: No effect on CNTR2

1: Loads FFFh in CNTR2

Note: This bit must not be reset by software

Bit 6 = FORCE1 Force Counter 1 Overflow bit

This bit is read/set by software. When set, it loads FFFh in CNTR1 register. It is reset by hardware one CPU clock cycle after counter 1 overflow has occurred.

0: No effect on CNTR1

1: Loads FFFh in CNTR1

Note: This bit must not be reset by software

Bit 5 = ICS Input Capture Shorted bit

This bit is read/write by software. It allows the ATtimer CNTR1 to use the LTIC pin for long Input Capture.

0: ATIC for CNTR1 Input Capture

1: LTIC for CNTR1 Input Capture

Bit 4 = **OVFIE2** Overflow interrupt 2 enable bit

This bit is read/write by software and controls the overflow interrupt of counter2.

0: Overflow interrupt disabled.

1: Overflow interrupt enabled.

Bit 3 = **OVF2** Overflow flag

This bit is set by hardware and cleared by software by reading the ATCSR2 register. It indicates the transition of the counter2 from FFFh to ATR2 value.

- 0: No counter overflow occurred
- 1: Counter overflow occurred

Bit 2 = ENCNTR2 Enable counter2 for PWM2/3

This bit is read/write by software and switches the PWM2/3 operation to the CNTR2 counter. If this bit is set, PWM2/3 will be generated using CNTR2.

- 0: PWM2/3 is generated using CNTR1.
- 1: PWM2/3 is generated using CNTR2.

Note: Counter 2 gets frozen when the ENCNTR2 bit is reset. When ENCNTR2 is set again, the counter will restart from the last value.

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Bit 1= TRAN2 Transfer enable2 bit

This bit is read/write by software, cleared by hardware after each completed transfer and set by hardware after reset. It controls the transfers on CNTR2.

It allows the value of the Preload DCRx registers to be transferred to the Active DCRx registers after the next overflow event.

The OPx bits are transferred to the shadow OPx bits in the same way.

Note: 1 DCR2/3 transfer will be controlled using this bit if ENCNTR2 bit is set.

2 This bit must not be reset by software

Bit 0 = TRAN1 Transfer enable 1 bit

This bit is read/write by software, cleared by hardware after each completed transfer and set by hardware after reset. It controls the transfers on CNTR1. It allows the value of the Preload DCRx registers to be transferred to the Active DCRx registers after the next overflow event.

The OPx bits are transferred to the shadow OPx bits in the same way.

Note: 1 DCR0,1 transfers are always controlled using this bit.

- 2 DCR2/3 transfer will be controlled using this bit if ENCNTR2 is reset.
- 3 This bit must not be reset by software

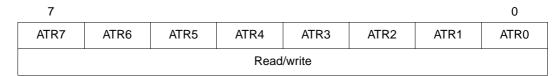
Autoreload register 2 (ATR2H)

Reset value: 0000 0000 (00h)

| 15 | | | | | | | 8 | | |
|----|------------|---|---|-------|-------|------|------|--|--|
| 0 | 0 | 0 | 0 | ATR11 | ATR10 | ATR9 | ATR8 | | |
| | Read/write | | | | | | | | |

Autoreload register (ATR2L)

Reset value: 0000 0000 (00h)



Bits 11:0 = ATR2[11:0] Autoreload register 2

This is a 12-bit register which is written by software. The ATR2 register value is automatically loaded into the upcounter CNTR2 when an overflow of CNTR2 occurs. The register value is used to set the PWM2/PWM3 frequency when ENCNTR2 is set.

Dead Time Generator register (Dtgr)

Reset value: 0000 0000 (00h)

7 0

| DTE | DT6 | DT5 | DT4 | DT3 | DT2 | DT1 | DT0 |
| Read/write

Bit 7 = **DTE** Dead Time Enable bit

This bit is read/write by software. It enables a dead time generation on PWM0/PWM1.

0: No Dead time insertion.

1: Dead time insertion enabled.

Bits 6:0 = DT[6:0] Dead Time value

These bits are read/write by software. They define the dead time inserted between PWM0/PWM1. Dead time is calculated as follows:

Dead Time = DT[6:0] x Tcounter1

Note: If DTE is set and DT[6:0]=0, PWM output signals will be at their reset state.

Table 37. Register mapping and reset values

| Add. (Hex) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------------------------|--------------|--------------|--------------|--------------|---------------|---------------|--------------|--------------|
| 0011 | ATCSR Reset Value | 0 | ICF 0 | ICIE 0 | CK1 0 | CK0 0 | OVF1 0 | OVFIE1 0 | CMPIE 0 |
| 0012 | CNTR1H Reset Value | 0 | 0 | 0 | 0 | CNTR1_11 0 | CNTR1_10 0 | CNTR1_9 0 | CNTR1_8 0 |
| 0013 | CNTR1L Reset Value | CNTR1_7 0 | CNTR1_8 0 | CNTR1_7 0 | CNTR1_6 0 | CNTR1_3 0 | CNTR1_2 0 | CNTR1_1 0 | CNTR1_0 0 |
| 0014 | ATR1H Reset Value | 0 | 0 | 0 | 0 | ATR11 0 | ATR10 0 | ATR9 0 | ATR8 0 |
| 0015 | ATR1L Reset Value | ATR7 0 | ATR6 0 | ATR5 0 | ATR4 0 | ATR3 0 | ATR2 0 | ATR1 0 | ATR0 0 |
| 0016 | PWMCR Reset Value | 0 | OE3 0 | 0 | OE2 0 | 0 | OE1 0 | 0 | OE0 0 |
| 0017 | PWM0CSR Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | OP0 0 | CMPF0 0 |
| 0018 | PWM1CSR Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | OP1 0 | CMPF1 0 |
| 0019 | PWM2CSR Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | OP2 0 | CMPF2 0 |
| 001A | PWM3CSR Reset Value | 0 | 0 | 0 | 0 | OP_EN 0 | OPEDGE 0 | OP3 0 | CMPF3 0 |
| 001B | DCR0H Reset Value | 0 | 0 | 0 | 0 | DCR11 0 | DCR10 0 | DCR9 0 | DCR8 0 |

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Table 37. Register mapping and reset values (continued)

| Add. (Hex) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|-----------------------------|--------|-------------|---------|-----------|------------|------------|------------|------------|
| 001C | DCR0L | DCR7 | DCR6 | DCR5 | DCR4 | DCR3 | DCR2 | DCR1 | DCR0 |
| | Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 001D | DCR1H Reset Value | 0 | 0 | 0 | 0 | DCR11 0 | DCR10 0 | DCR9 0 | DCR8 0 |
| 001E | DCR1L | DCR7 | DCR6 | DCR5 | DCR4 | DCR3 | DCR2 | DCR1 | DCR0 |
| | Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 001F | DCR2H Reset Value | 0 | 0 | 0 | 0 | DCR11 0 | DCR10 0 | DCR9 0 | DCR8 0 |
| 0020 | DCR2L | DCR7 | DCR6 | DCR5 | DCR4 | DCR3 | DCR2 | DCR1 | DCR0 |
| | Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0021 | DCR3H Reset Value | 0 | 0 | 0 | 0 | DCR11 0 | DCR10 0 | DCR9 0 | DCR8 0 |
| 0022 | DCR3L | DCR7 | DCR6 | DCR5 | DCR4 | DCR3 | DCR2 | DCR1 | DCR0 |
| | Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0023 | ATICRH Reset Value | 0 | 0 | 0 | 0 | ICR11 0 | ICR10 0 | ICR9 0 | ICR8 0 |
| 0024 | ATICRL | ICR7 | ICR6 | ICR5 | ICR4 | ICR3 | ICR2 | ICR1 | ICR0 |
| | Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0025 | ATCSR2 | FORCE2 | FORCE1 | O | OVFIE2 | OVF2 | ENCNTR2 | TRAN2 | TRAN1 |
| | Reset Value | 0 | 0 | O | 0 | 0 | 0 | 1 | 1 |
| 0026 | BREAKCR Reset Value | 0 | BREDGE 0 | BA 0 | BPEN 0 | PWM3 0 | PWM2 0 | PWM1 0 | PWM0 0 |
| 0027 | ATR2H Reset Value | 0 | 0 | 0 | 0 | ATR11 0 | ATR10 0 | ATR9 0 | ATR8 0 |
| 0028 | ATR2L | ATR7 | ATR6 | ATR5 | ATR4 | ATR3 | ATR2 | ATR1 | ATR0 |
| | Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0029 | DTGR | DTE | DT6 | DT5 | DT4 | DT3 | DT2 | DT1 | DT0 |
| | Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 002A | BREAKEN Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | BREN2 1 | BREN1 1 |

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11.3 Lite timer 2 (LT2)

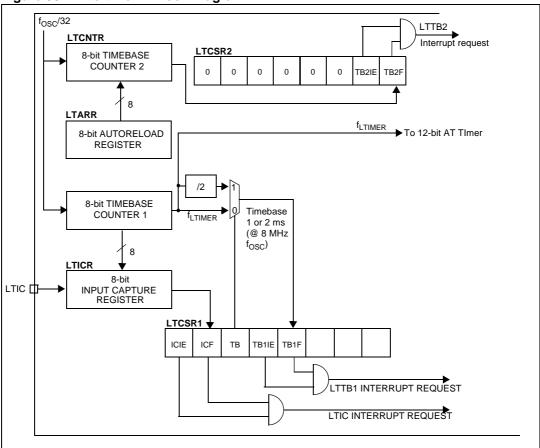
11.3.1 Introduction

The Lite timer can be used for general-purpose timing functions. It is based on two freerunning 8-bit upcounters and an 8-bit Input Capture register

11.3.2 Main Features

- Realtime Clock
 - One 8-bit upcounter 1 ms or 2 ms timebase period (@ 8 MHz f_{OSC})
 - One 8-bit upcounter with autoreload and programmable timebase period from 4μs to 1.024ms in 4μs increments (@ 8 MHz f_{OSC})
 - 2 Maskable timebase interrupts
- Input Capture
 - 8-bit Input Capture register (LTICR)
- Maskable interrupt with wake-up from Halt mode capability

Figure 53. Lite timer 2 Block Diagram



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11.3.3 Functional description

Timebase Counter 1

The 8-bit value of Counter 1 cannot be read or written by software. After an MCU reset, it starts incrementing from 0 at a frequency of $f_{OSC}/32$. An overflow event occurs when the counter rolls over from F9h to 00h. If $f_{OSC} = 8$ MHz, then the time period between two counter overflow events is 1 ms. This period can be doubled by setting the TB bit in the LTCSR1 register.

When Counter 1 overflows, the TB1F bit is set by hardware and an interrupt request is generated if the TB1IE bit is set. The TB1F bit is cleared by software reading the LTCSR1 register.

Input Capture

The 8-bit Input Capture register is used to latch the free-running upcounter (Counter 1) 1 after a rising or falling edge is detected on the LTIC pin. When an Input Capture occurs, the ICF bit is set and the LTICR register contains the counter 1 value. An interrupt is generated if the ICIE bit is set. The ICF bit is cleared by reading the LTICR register.

The LTICR is a read-only register and always contains the data from the last Input Capture. Input Capture is inhibited if the ICF bit is set.

Timebase Counter 2

Counter 2 is an 8-bit autoreload upcounter. It can be read by accessing the LTCNTR register. After an MCU reset, it increments at a frequency of $f_{\rm OSC}/32$ starting from the value stored in the LTARR register. A counter overflow event occurs when the counter rolls over from FFh to the LTARR reload value. Software can write a new value at any time in the LTARR register, this value will be automatically loaded in the counter when the next overflow occurs.

When Counter 2 overflows, the TB2F bit in the LTCSR2 register is set by hardware and an interrupt request is generated if the TB2IE bit is set. The TB2F bit is cleared by software reading the LTCSR2 register.

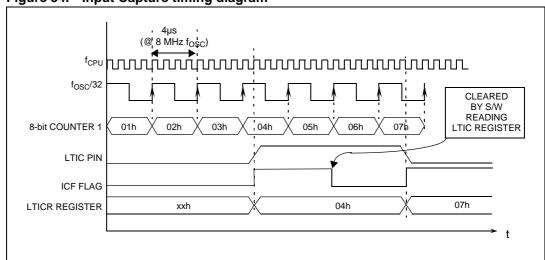


Figure 54. Input Capture timing diagram

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11.3.4 Low power modes

Table 38. Effect of low power modes on Lite timer 2

| Mode | Description | | |
|-------------|--|--|--|
| Slow | No effect on Lite timer (this peripheral is driven directly by f _{OSC} /32) | | |
| Wait | No effect on Lite timer | | |
| Active Halt | No effect on Lite timer | | |
| Halt | Lite timer stops counting | | |

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11.3.5 Interrupts

Table 39. Description of interrupt events

| Interrupt Event | Event Flag | Enable Control Bit | Exit from Wait | Exit from Active Halt | Exit from Halt |
|------------------|---------------|--------------------------|----------------------|--------------------------------|----------------------|
| Timebase 1 Event | TB1F | TB1IE | | Yes | |
| Timebase 2 Event | TB2F | TB2IE | Yes | No | No |
| IC Event | ICF | ICIE | | No | |

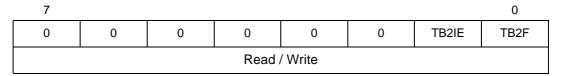
The TBxF and ICF interrupt events are connected to separate interrupt vectors (see Section 8: Interrupts).

They generate an interrupt if the enable bit is set in the LTCSR1 or LTCSR2 register and the interrupt mask in the CC register is reset (RIM instruction).

11.3.6 Register description

Lite Timer Control/Status register 2 (LTCSR2)

Reset value: 0000 0000 (00h)



Bits 7:2 = Reserved, must be kept cleared.

Bit 1 = TB2IE Timebase 2 Interrupt enable bit

This bit is set and cleared by software.

- 0: Timebase (TB2) interrupt disabled
- 1: Timebase (TB2) interrupt enabled

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Bit 0 = **TB2F** Timebase 2 Interrupt flag

This bit is set by hardware and cleared by software reading the LTCSR register. Writing to this bit has no effect.

0: No Counter 2 overflow

1: A Counter 2 overflow has occurred

Lite Timer Autoreload register (LTARR)

Reset value: 0000 0000 (00h)

7 0
AR7 AR6 AR5 AR4 AR3 AR2 AR1 AR0
Read / Write

Bits 7:0 = AR[7:0] Counter 2 Reload value

These bits register is read/write by software. The LTARR value is automatically loaded into Counter 2 (LTCNTR) when an overflow occurs.

Lite Timer Counter 2 (LTCNTR)

Reset value: 0000 0000 (00h)

7 0

CNT7 CNT6 CNT5 CNT4 CNT3 CNT2 CNT1 CNT0

Read only

Bits 7:0 = CNT[7:0] Counter 2 Reload value

This register is read by software. The LTARR value is automatically loaded into Counter 2 (LTCNTR) when an overflow occurs.

Lite Timer Control/status register (LTCSR1)

Reset value: 0x00 0000 (x0h)

7 0

ICIE ICF TB TB1IE TB1F

Read / Write

Bit 7 = ICIE Interrupt Enable bit

This bit is set and cleared by software.

0: Input Capture (IC) interrupt disabled

1: Input Capture (IC) interrupt enabled

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Bit 6 = ICF Input Capture flag

This bit is set by hardware and cleared by software by reading the LTICR register. Writing to this bit does not change the bit value.

After an MCU reset, software must initialize the ICF bit by reading the LTICR register

0: No Input Capture

Note:

1: An Input Capture has occurred

Bit 5 = **TB** Timebase period selection bit

This bit is set and cleared by software.

0: Timebase period = t_{OSC} * 8000 (1ms @ 8 MHz)

1: Timebase period = t_{OSC} * 16000 (2ms @ 8 MHz)

Bit 4 = TB1IE Timebase Interrupt enable bit

This bit is set and cleared by software.

0: Timebase (TB1) interrupt disabled

1: Timebase (TB1) interrupt enabled

Bit 3 = **TB1F** Timebase Interrupt flag

This bit is set by hardware and cleared by software reading the LTCSR register. Writing to this bit has no effect.

0: No counter overflow

1: A counter overflow has occurred

Bits 2:0 = Reserved

Lite Timer Input Capture register (LTICR)

Reset value: 0000 0000 (00h)

7 0

ICR7 ICR6 ICR5 ICR4 ICR3 ICR2 ICR1 ICR0

Read only

Bits 7:0 = ICR[7:0] Input Capture value

These bits are read by software and cleared by hardware after a reset. If the ICF bit in the LTCSR is cleared, the value of the 8-bit up-counter will be captured when a rising or falling edge occurs on the LTIC pin.

Table 40. Lite Timer register mapping and reset values

| Address (Hex.) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------|-----------------------|----------|----------|----------|----------|----------|----------|------------|-----------|
| 0C | LTCSR2 Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | TB2IE 0 | TB2F 0 |
| 0D | LTARR Reset Value | AR7 0 | AR6 0 | AR5 0 | AR4 0 | AR3 0 | AR2 0 | AR1 0 | AR0 0 |

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Table 40. Lite Timer register mapping and reset values

| Address (Hex.) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------|-----------------------|-----------|----------|---------|------------|-----------|------|------|------|
| 0E | LTCNTR | CNT7 | CNT6 | CNT5 | CNT4 | CNT3 | CNT2 | CNT1 | CNT0 |
| | Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0F | LTCSR1 Reset Value | ICIE 0 | ICF x | TB 0 | TB1IE 0 | TB1F 0 | 0 | 0 | 0 |
| 10 | LTICR | ICR7 | ICR6 | ICR5 | ICR4 | ICR3 | ICR2 | ICR1 | ICR0 |
| | Reset Value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

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11.4 I²C bus interface (I²C)

11.4.1 Introduction

The I²C Bus Interface serves as an interface between the microcontroller and the serial I²C bus. It provides both multimaster and slave functions, and controls all I²C bus-specific sequencing, protocol, arbitration and timing. It supports fast I²C mode (400kHz).

11.4.2 Main features

- Parallel-bus/l²C protocol converter
- Multi-master capability
- 7-bit/10-bit Addressing
- Transmitter/Receiver flag
- End-of-byte transmission flag
- Transfer problem detection

I²C master features:

- Clock generation
- I²C bus busy flag
- Arbitration Lost Flag
- End of byte transmission flag
- Transmitter/Receiver Flag
- Start bit detection flag
- Start and Stop generation

I²C slave features:

- Stop bit detection
- I²C bus busy flag
- Detection of misplaced start or stop condition
- Programmable I²C Address detection
- Transfer problem detection
- End-of-byte transmission flag
- Transmitter/Receiver flag

11.4.3 General description

In addition to receiving and transmitting data, this interface converts it from serial to parallel format and vice versa, using either an interrupt or polled handshake. The interrupts are enabled or disabled by software. The interface is connected to the I²C bus by a data pin (SDAI) and by a clock pin (SCLI). It can be connected both with a standard I²C bus and a Fast I²C bus. This selection is made by software.

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Mode selection

The interface can operate in the four following modes:

- Slave transmitter/receiver
- Master transmitter/receiver

By default, it operates in slave mode.

The interface automatically switches from slave to master after it generates a START condition and from master to slave in case of arbitration loss or a STOP generation, allowing then Multi-Master capability.

Communication flow

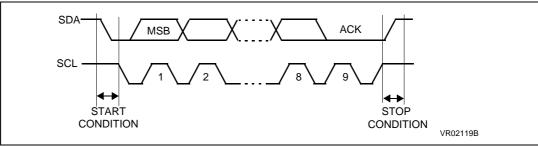
In Master mode, it initiates a data transfer and generates the clock signal. A serial data transfer always begins with a start condition and ends with a stop condition. Both start and stop conditions are generated in master mode by software.

In Slave mode, the interface is capable of recognising its own address (7 or 10-bit), and the General Call address. The General Call address detection may be enabled or disabled by software.

Data and addresses are transferred as 8-bit bytes, MSB first. The first byte(s) following the start condition contain the address (one in 7-bit mode, two in 10-bit mode). The address is always transmitted in Master mode.

A 9th clock pulse follows the 8 clock cycles of a byte transfer, during which the receiver must send an acknowledge bit to the transmitter. Refer to *Figure 55*.

Figure 55. I²C bus protocol



Acknowledge may be enabled and disabled by software.

The I²C interface address and/or general call address can be selected by software.

The speed of the I^2C interface may be selected between Standard (up to 100KHz) and Fast I^2C (up to 400KHz).

SDA/SCL line control

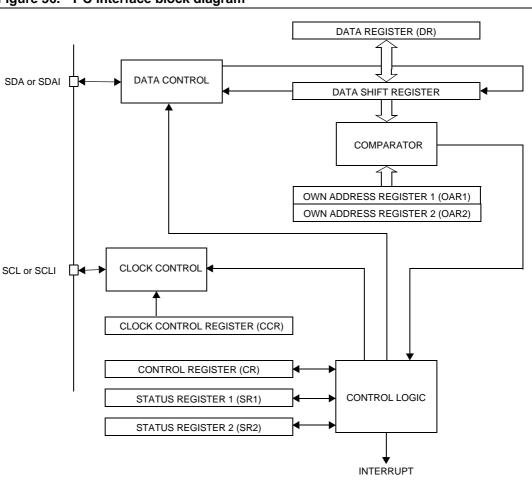
Transmitter mode: the interface holds the clock line low before transmission to wait for the microcontroller to write the byte in the Data register.

Receiver mode: the interface holds the clock line low after reception to wait for the microcontroller to read the byte in the Data register.

The SCL frequency (F_{scl}) is controlled by a programmable clock divider which depends on the I²C bus mode.

When the I^2C cell is enabled, the SDA and SCL ports must be configured as floating inputs. In this case, the value of the external pull-up resistor used depends on the application. When the I^2C cell is disabled, the SDA and SCL ports revert to being standard I/O port pins.

Figure 56. I²C interface block diagram



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11.4.4 Functional description

Refer to the CR, SR1 and SR2 registers in Section 11.4.7. for the bit definitions.

By default the I²C interface operates in Slave mode (M/SL bit is cleared) except when it initiates a transmit or receive sequence.

First the interface frequency must be configured using the FRi bits in the OAR2 register.

Slave mode

As soon as a start condition is detected, the address is received from the SDA line and sent to the shift register; then it is compared with the address of the interface or the General Call address (if selected by software).

Note:

In 10-bit addressing mode, the comparision includes the header sequence (11110xx0) and the two most significant bits of the address.

- Header matched (10-bit mode only): the interface generates an acknowledge pulse if the ACK bit is set.
- Address not matched: the interface ignores it and waits for another Start condition.
- Address matched: the interface generates in sequence:
 - Acknowledge pulse if the ACK bit is set.
 - EVF and ADSL bits are set with an interrupt if the ITE bit is set.

Then the interface waits for a read of the SR1 register, **holding the SCL line low** (see *Figure 57* Transfer sequencing EV1).

Next, in 7-bit mode read the DR register to determine from the least significant bit (Data Direction Bit) if the slave must enter Receiver or Transmitter mode.

In 10-bit mode, after receiving the address sequence the slave is always in receive mode. It will enter transmit mode on receiving a repeated Start condition followed by the header sequence with matching address bits and the least significant bit set (11110xx1).

Slave receiver

Following the address reception and after SR1 register has been read, the **slave receives bytes from the SDA line into the** DR register **via t**he internal shift register. After each byte the interface generates in sequence:

- Acknowledge pulse if the ACK bit is set
- EVF and BTF bits are set with an interrupt if the ITE bit is set.

Then the interface waits for a read of the SR1 register followed by a read of the DR register, **holding the SCL line low** (see *Figure 57* Transfer sequencing EV2).

Slave transmitter

Following the address reception and after SR1 register has been read, **the slave sends bytes from** the DR register to **the SDA line** via **the** internal shift register.

The slave waits for a read of the SR1 register followed by a write in the DR register, **holding the SCL line low** (see *Figure 57* Transfer sequencing EV3).

When the acknowledge pulse is received the EVF and BTF bits are set by hardware with an interrupt if the ITE bit is set.

Closing slave communication

After the last data byte is transferred a Stop Condition is generated by the master. The interface detects this condition and sets:

EVF and STOPF bits with an interrupt if the ITE bit is set.

Then the interface waits for a read of the SR2 register (see *Figure 57* Transfer sequencing EV4).

Error cases

BERR: Detection of a Stop or a Start condition during a byte transfer. In this case, the EVF and the BERR bits are set with an interrupt if the ITE bit is set.

| Condition | Condit

If it is a Stop then the interface discards the data, released the lines and waits for another Start condition.

If it is a Start then the interface discards the data and waits for the next slave address on the bus.

• AF: Detection of a non-acknowledge bit. In this case, the EVF and AF bits are set with an interrupt if the ITE bit is set.

The AF bit is cleared by reading the I2CSR2 register. However, if read before the completion of the transmission, the AF flag will be set again, thus possibly generating a new interrupt. Software must ensure either that the SCL line is back at 0 before reading the SR2 register, or be able to correctly handle a second interrupt during the 9th pulse of a transmitted byte.

Note:

In both cases, SCL line is not held low; however, the SDA line can remain low if the last bits transmitted are all 0. It is then necessary to release both lines by software. The SCL line is not held low while AF=1 but by other flags (SB or BTF) that are set at the same time.

How to release the SDA / SCL lines

Set and subsequently clear the STOP bit while BTF is set. The SDA/SCL lines are released after the transfer of the current byte.

SMBus compatibility

ST7 I^2C is compatible with SMBus V1.1 protocol. It supports all SMBus adressing modes, SMBus bus protocols and CRC-8 packet error checking. Refer to AN1713: SMBus Slave Driver For ST7 I^2C Peripheral.

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Master mode

To switch from default Slave mode to Master mode a Start condition generation is needed.

Start condition

Setting the START bit while the BUSY bit is cleared causes the interface to switch to Master mode (M/SL bit set) and generates a Start condition.

Once the Start condition is sent, the EVF and SB bits are set by hardware with an interrupt if the ITE bit is set.

The master then waits for a read of the SR1 register followed by a write in the DR register with the Slave address, **holding the SCL line low** (see *Figure 57* Transfer sequencing EV5).

Slave address transmission

- The slave address is then sent to the SDA line via the internal shift register.
 - In 7-bit addressing mode, one address byte is sent.
 - In 10-bit addressing mode, sending the first byte including the header sequence causes the following event. The EVF bit is set by hardware with interrupt generation if the ITE bit is set.
- 2. The master then waits for a read of the SR1 register followed by a write in the DR register, **holding the SCL line low** (see *Figure 57* Transfer sequencing EV9).
- 3. Then the second address byte is sent by the interface.
- 4. After completion of this transfer (and acknowledge from the slave if the ACK bit is set), the EVF bit is set by hardware with interrupt generation if the ITE bit is set.
- The master waits for a read of the SR1 register followed by a write in the CR register (for example set PE bit), holding the SCL line low (see Figure 57 Transfer sequencing EV6).
- 6. Next the master must enter Receiver or Transmitter mode.

In 10-bit addressing mode, to switch the master to Receiver mode, software must generate a repeated Start condition and resend the header sequence with the least significant bit set (11110xx1).

Master receiver

Following the address transmission and after SR1 and CR registers have been accessed, the **master receives bytes from the SDA line into the** DR register **via t**he internal shift register. After each byte the interface generates in sequence:

- Acknowledge pulse if the ACK bit is set
- EVF and BTF bits are set by hardware with an interrupt if the ITE bit is set.

Then the interface waits for a read of the SR1 register followed by a read of the DR register, **holding the SCL line low** (see *Figure 57* Transfer sequencing EV7).

To close the communication: before reading the last byte from the DR register, set the STOP bit to generate the Stop condition. The interface goes automatically back to slave mode (M/SL bit cleared).

In order to generate the non-acknowledge pulse after the last received data byte, the ACK bit must be cleared just before reading the second last data byte.

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Note:

Note:

Master transmitter

Following the address transmission and after SR1 register has been read, **the master sends bytes from** the DR register to **the SDA line** via **the** internal shift register.

The master waits for a read of the SR1 register followed by a write in the DR register, **holding the SCL line low** (see *Figure 57* Transfer sequencing EV8).

When the acknowledge bit is received, the interface sets EVF and BTF bits with an interrupt if the ITE bit is set.

To close the communication: after writing the last byte to the DR register, set the STOP bit to generate the Stop condition. The interface goes automatically back to slave mode (M/SL bit cleared).

Error cases

 BERR: Detection of a Stop or a Start condition during a byte transfer. In this case, the EVF and BERR bits are set by hardware with an interrupt if ITE is set.

Note that BERR will not be set if an error is detected during the first pulse of each 9-bit transaction:

Single Master mode

If a Start or Stop is issued during the first pulse of a 9-bit transaction, the BERR flag will not be set and transfer will continue however the BUSY flag will be reset. To work around this, slave devices should issue a NACK when they receive a misplaced Start or Stop. The reception of a NACK or BUSY by the master in the middle of communication gives the possibility to reinitiate transmission.

Multimaster mode

Normally the BERR bit would be set whenever unauthorized transmission takes place while transfer is already in progress. However, an issue will arise if an external master generates an unauthorized Start or Stop while the I²C master is on the first pulse pulse of a 9-bit transaction. It is possible to work around this by polling the BUSY bit during I²C master mode transmission. The resetting of the BUSY bit can then be handled in a similar manner as the BERR flag being set.

- AF: Detection of a non-acknowledge bit. In this case, the EVF and AF bits are set by hardware with an interrupt if the ITE bit is set. To resume, set the Start or Stop bit. The AF bit is cleared by reading the I2CSR2 register. However, if read before the completion of the transmission, the AF flag will be set again, thus possibly generating a new interrupt. Software must ensure either that the SCL line is back at 0 before reading the SR2 register, or be able to correctly handle a second interrupt during the 9th pulse of a transmitted byte.
- ARLO: Detection of an arbitration lost condition.

 In this case the ARLO bit is set by hardware (with an interrupt if the ITE bit is set and the interface goes automatically back to slave mode (the M/SL bit is cleared).

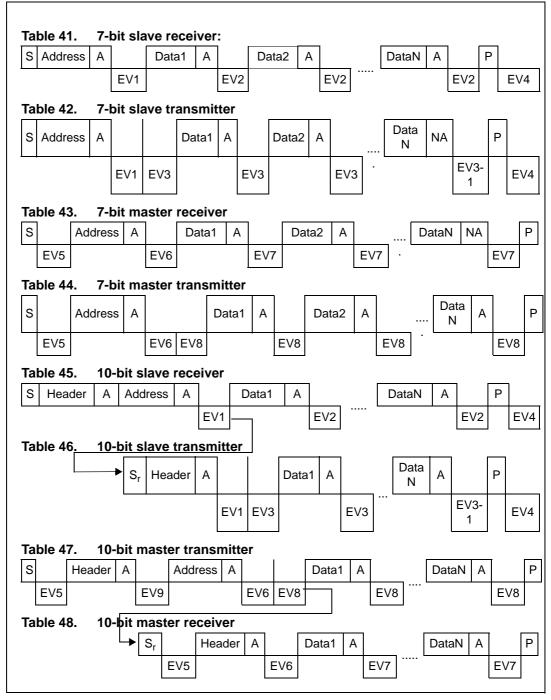
In all these cases, the SCL line is not held low; however,the SDA line can remain low if the last bits transmitted are all 0. It is then necessary to release both lines by software. The SCL line is not held low while AF=1 but by other flags (SB or BTF) that are set at the same time.

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Note:

Figure 57. Transfer sequencing



- S=Start, S_r = Repeated Start, P=Stop, A=Acknowledge, NA=Non-acknowledge, EVx=Event (with interrupt if ITE=1).
- 2. EV1: EVF=1, ADSL=1, cleared by reading SR1 register.
- 3. EV2: EVF=1, BTF=1, cleared by reading SR1 register followed by reading DR register.
- 4. EV3: EVF=1, BTF=1, cleared by reading SR1 register followed by writing DR register.
- 5. **EV3-1:** EVF=1, AF=1, BTF=1; AF is cleared by reading SR1 register. BTF is cleared by releasing the lines (STOP=1, STOP=0) or by writing DR register (DR=FFh). If lines are released by STOP=1, STOP=0, the

subsequent EV4 is not seen.

- 6. EV4: EVF=1, STOPF=1, cleared by reading SR2 register.
- 7. EV5: EVF=1, SB=1, cleared by reading SR1 register followed by writing DR register.
- 8. EV6: EVF=1, cleared by reading SR1 register followed by writing CR register (for example PE=1).
- 9. EV7: EVF=1, BTF=1, cleared by reading SR1 register followed by reading DR register.
- 10. EV8: EVF=1, BTF=1, cleared by reading SR1 register followed by writing DR register.
- 11. **EV9:** EVF=1, ADD10=1, cleared by reading SR1 register followed by writing DR register.

11.4.5 Low power modes

Table 49. Effect of low power modes on the I²C interface

| Mode | Description |
|------|---|
| Wait | No effect on I ² C interface. I ² C interrupts cause the device to exit from Wait mode. |
| Halt | I ² C registers are frozen. In Halt mode, the I ² C interface is inactive and does not acknowledge data on the bus. The I ² C interface resumes operation when the MCU is woken up by an interrupt with "exit from Halt mode" capability. |

11.4.6 Interrupts

Figure 58. Event flags and interrupt generation

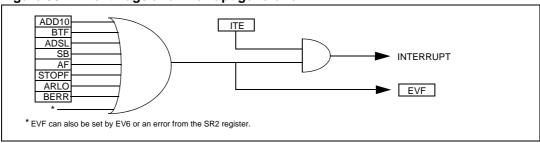


Table 50. Description of interrupt events

| Interrupt Event ⁽¹⁾ | Event Flag | Enable Control Bit | Exit from Wait | Exit from Halt |
|--|---------------|--------------------------|----------------------|----------------------|
| 10-bit Address Sent Event (Master mode) | ADD10 | | Yes | No |
| End of byte Transfer Event | BTF | | Yes | No |
| Address Matched Event (Slave mode) | ADSL | | Yes | No |
| Start Bit Generation Event (Master mode) | SB | ITE | Yes | No |
| Acknowledge Failure Event | AF | 116 | Yes | No |
| Stop Detection Event (Slave mode) | STOPF | | Yes | No |
| Arbitration Lost Event (Multimaster configuration) | ARLO | | Yes | No |
| Bus Error Event | BERR | | Yes | No |

The I²C interrupt events are connected to the same interrupt vector (see Interrupts chapter).
 They generate an interrupt if the corresponding Enable Control Bit is set and the I-bit in the CC register is reset (RIM instruction).

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11.4.7 Register description

I²C Control register (CR)

Reset value: 0000 0000 (00h)

7 0 0 PE ENGC START ACK STOP ITE Read / Write

Bit 7:6 = Reserved. Forced to 0 by hardware.

Bit 5 = **PE** Peripheral Enable bit

This bit is set and cleared by software.

- 0: Peripheral disabled
- 1: Master/Slave capability

Note: When PE=0, all the bits of the CR register and the SR register except the Stop bit are reset.

All outputs are released while PE=0

When PE=1, the corresponding I/O pins are selected by hardware as alternate functions.

To enable the l^2C interface, write the CR register **TWICE** with PE=1 as the first write only activates the interface (only PE is set).

Bit 4 = ENGC Enable General Call bit

This bit is set and cleared by software. It is also cleared by hardware when the interface is disabled (PE=0). The 00h General Call address is acknowledged (01h ignored).

- 0: General Call disabled
- 1: General Call enabled

In accordance with the l^2C standard, when GCAL addressing is enabled, an l^2C slave can only receive data. It will not transmit data to the master.

Bit 3 = **START** Generation of a Start condition bit. This bit is set and cleared by software. It is also cleared by hardware when the interface is disabled (PE=0) or when the Start condition is sent (with interrupt generation if ITE=1).

- In master mode:
 - 0: No start generation
 - 1: Repeated start generation
- In slave mode:
 - 0: No start generation
 - 1: Start generation when the bus is free

Bit 2 = **ACK** Acknowledge enable bit

This bit is set and cleared by software. It is also cleared by hardware when the interface is disabled (PE=0).

- 0: No acknowledge returned
- 1: Acknowledge returned after an address byte or a data byte is received

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Note:

Bit 1 = **STOP** Generation of a Stop condition bit

This bit is set and cleared by software. It is also cleared by hardware in master mode. Note: This bit is not cleared when the interface is disabled (PE=0).

- In master mode:
 - 0: No stop generation
 - 1: Stop generation after the current byte transfer or after the current Start condition is sent. The STOP bit is cleared by hardware when the Stop condition is sent.
- In slave mode:
 - 0: No stop generation
 - 1: Release the SCL and SDA lines after the current byte transfer (BTF=1). In this mode the STOP bit has to be cleared by software.

Bit 0 = ITE Interrupt Enable bit

This bit is set and cleared by software and cleared by hardware when the interface is disabled (PE=0).

- 0: Interrupts disabled
- 1: Interrupts enabled

Refer to Figure 58 for the relationship between the events and the interrupt.

SCL is held low when the ADD10, SB, BTF or ADSL flags or an EV6 event (See *Figure 57*) is detected.

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I²C Status register 1 (SR1)

Reset value: 0000 0000 (00h)

7 0

EVF ADD10 TRA BUSY BTF ADSL M/SL SB

Read Only

Bit 7 = EVF Event flag

This bit is set by hardware as soon as an event occurs. It is cleared by software reading SR2 register in case of error event or as described in *Figure 57*. It is also cleared by hardware when the interface is disabled (PE=0).

0: No event

- 1: One of the following events has occurred:
- BTF=1 (byte received or transmitted)
- ADSL=1 (Address matched in Slave mode while ACK=1)
- SB=1 (Start condition generated in Master mode)
- AF=1 (No acknowledge received after byte transmission)
- STOPF=1 (Stop condition detected in Slave mode)
- ARLO=1 (Arbitration lost in Master mode)
- BERR=1 (Bus error, misplaced Start or Stop condition detected)
- ADD10=1 (Master has sent header byte)
- Address byte successfully transmitted in Master mode.

Bit 6 = **ADD10** 10-bit addressing in Master mode

This bit is set by hardware when the master has sent the first byte in 10-bit address mode. It is cleared by software reading SR2 register followed by a write in the DR register of the second address byte. It is also cleared by hardware when the peripheral is disabled (PE=0).

- 0: No ADD10 event occurred.
- 1: Master has sent first address byte (header)

Bit 5 = TRA Transmitter/Receiver bit

When BTF is set, TRA=1 if a data byte has been transmitted. It is cleared automatically when BTF is cleared. It is also cleared by hardware after detection of Stop condition (STOPF=1), loss of bus arbitration (ARLO=1) or when the interface is disabled (PE=0).

- 0: Data byte received (if BTF=1)
- 1: Data byte transmitted

Bit 4 = **BUSY** Bus busy bit

This bit is set by hardware on detection of a Start condition and cleared by hardware on detection of a Stop condition. It indicates a communication in progress on the bus. The BUSY flag of the I2CSR1 register is cleared if a Bus Error occurs.

- 0: No communication on the bus
- 1: Communication ongoing on the bus

Bit 3 = BTF Byte Transfer Finished bit

This bit is set by hardware as soon as a byte is correctly received or transmitted with interrupt generation if ITE=1. It is cleared by software reading SR1 register followed by a read or write of DR register. It is also cleared by hardware when the interface is disabled (PE=0).

- Following a byte transmission, this bit is set after reception of the acknowledge clock pulse. In case an address byte is sent, this bit is set only after the EV6 event (See *Figure 57*). BTF is cleared by reading SR1 register followed by writing the next byte in DR register.
- Following a byte reception, this bit is set after transmission of the acknowledge clock pulse if ACK=1. BTF is cleared by reading SR1 register followed by reading the byte from DR register.

The SCL line is held low while BTF=1.

- 0: byte transfer not done
- 1: byte transfer succeeded

Bit 2 = **ADSL** Address matched bit (slave mode). This bit is set by hardware as soon as the received slave address matched with the OAR register content or a general call is recognized. An interrupt is generated if ITE=1. It is cleared by software reading SR1 register or by hardware when the interface is disabled (PE=0).

The SCL line is held low while ADSL=1.

- 0: Address mismatched or not received
- 1: Received address matched

Bit 1 = M/SL Master/Slave bit

This bit is set by hardware as soon as the interface is in Master mode (writing START=1). It is cleared by hardware after detecting a Stop condition on the bus or a loss of arbitration (ARLO=1). It is also cleared when the interface is disabled (PE=0).

- 0: Slave mode
- 1: Master mode

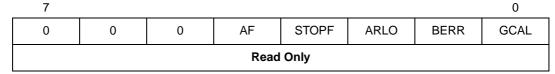
Bit 0 = **SB** Start bit (master mode).

This bit is set by hardware as soon as the Start condition is generated (following a write START=1). An interrupt is generated if ITE=1. It is cleared by software reading SR1 register followed by writing the address byte in DR register. It is also cleared by hardware when the interface is disabled (PE=0).

- 0: No Start condition
- 1: Start condition generated

I²C Status register 2 (SR2)

Reset value: 0000 0000 (00h)



Bit 7:5 = Reserved. Forced to 0 by hardware.

Bit 4 = **AF** Acknowledge failure bit

This bit is set by hardware when no acknowledge is returned. An interrupt is generated if ITE=1. It is cleared by software reading SR2 register or by hardware when the interface is disabled (PE=0).

The SCL line is not held low while AF=1 but by other flags (SB or BTF) that are set at the same time.

- 0: No acknowledge failure
- 1: Acknowledge failure

Bit 3 = **STOPF** Stop detection bit (slave mode)

This bit is set by hardware when a Stop condition is detected on the bus after an acknowledge (if ACK=1). An interrupt is generated if ITE=1. It is cleared by software reading SR2 register or by hardware when the interface is disabled (PE=0).

The SCL line is not held low while STOPF=1.

- 0: No Stop condition detected
- 1: Stop condition detected

Bit 2 = ARLO Arbitration lost bit

This bit is set by hardware when the interface loses the arbitration of the bus to another master. An interrupt is generated if ITE=1. It is cleared by software reading SR2 register or by hardware when the interface is disabled (PE=0).

After an ARLO event the interface switches back automatically to Slave mode (M/SL=0).

The SCL line is not held low while ARLO=1.

- 0: No arbitration lost detected
- 1: Arbitration lost detected

Note:

In a Multimaster environment, when the interface is configured in Master Receive mode it does not perform arbitration during the reception of the Acknowledge Bit. Mishandling of the ARLO bit from the I2CSR2 register may occur when a second master simultaneously requests the same data from the same slave and the I^2 C master does not acknowledge the data. The ARLO bit is then left at 0 instead of being set.

Bit 1 = **BERR** Bus error bit

This bit is set by hardware when the interface detects a misplaced Start or Stop condition. An interrupt is generated if ITE=1. It is cleared by software reading SR2 register or by hardware when the interface is disabled (PE=0).

The SCL line is not held low while BERR=1.

- 0: No misplaced Start or Stop condition
- 1: Misplaced Start or Stop condition

Note:

If a Bus Error occurs, a Stop or a repeated Start condition should be generated by the Master to re-synchronize communication, get the transmission acknowledged and the bus released for further communication

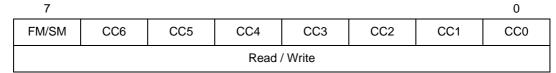
Bit 0 = GCAL General Call bit (slave mode).

This bit is set by hardware when a general call address is detected on the bus while ENGC=1. It is cleared by hardware detecting a Stop condition (STOPF=1) or when the interface is disabled (PE=0).

- 0: No general call address detected on bus
- 1: general call address detected on bus

I²C Clock Control register (CCR)

Reset value: 0000 0000 (00h)



Bit 7 = **FM/SM** Fast/Standard I^2C mode bit

This bit is set and cleared by software. It is not cleared when the interface is disabled (PE=0).

- 0: Standard I²C mode
- 1: Fast I²C mode

Bit 6:0 = CC[6:0] 7-bit clock divider bits

These bits select the speed of the bus (F_{SCL}) depending on the I^2C mode. They are not cleared when the interface is disabled (PE=0).

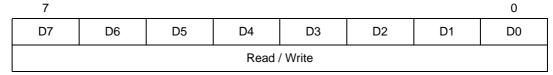
Refer to the Electrical Characteristics section for the table of values.

Note:

The programmed F_{SCL} assumes no load on SCL and SDA lines.

I²C Data register (DR)

Reset Value: 0000 0000 (00h)



Bit 7:0 = **D[7:0]** 8-bit Data register

These bits contain the byte to be received or transmitted on the bus.

- Transmitter mode: byte transmission start automatically when the software writes in the DR register.
- Receiver mode: the first data byte is received automatically in the DR register using the least significant bit of the address. Then, the following data bytes are received one by one after reading the DR register.

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I²C Own Address register (OAR1)

Reset value: 0000 0000 (00h)

7 0
ADD7 ADD6 ADD5 ADD4 ADD3 ADD2 ADD1 ADD0
Read / Write

In 7-bit addressing mode

Bit 7:1 = **ADD[7:1]** *Interface address*. These bits define the I^2C bus address of the interface. They are not cleared when the interface is disabled (PE=0).

Bit 0 = **ADD0** Address direction bit.

This bit is don't care, the interface acknowledges either 0 or 1. It is not cleared when the interface is disabled (PE=0).

Note:

Address 01h is always ignored.

In 10-bit addressing mode

Bit 7:0 = ADD[7:0] Interface address. These are the least significant bits of the I²C bus address of the interface. They are not cleared when the interface is disabled (PE=0).

I²C Own Address register (OAR2)

Reset value: 0100 0000 (40h)

7 0

FR1 FR0 0 0 0 ADD9 ADD8 0

Read / Write

Bit 7:6 = **FR[1:0]** Frequency bits

These bits are set by software only when the interface is disabled (PE=0). To configure the interface to I^2C specified delays select the value corresponding to the microcontroller frequency f_{CPU} .

Table 51. Configuration of I²C delay times

| f _{CPU} | FR1 | FR0 |
|------------------|-----|-----|
| < 6 MHz | 0 | 0 |
| 6 to 8 MHz | 0 | 1 |

Bit 5:3 = Reserved

Bit 2:1 = ADD[9:8] Interface address

These are the most significant bits of the I^2C bus address of the interface (10-bit mode only). They are not cleared when the interface is disabled (PE=0).

Bit 0 = Reserved.

Table 52. I²C register mapping and reset values

| Address (Hex.) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------|------------------------|------------|------------|-----------|-----------|------------|-----------|-----------|-----------|
| 0064h | I2CCR Reset Value | 0 | 0 | PE 0 | ENGC 0 | START 0 | ACK 0 | STOP 0 | ITE 0 |
| 0065h | I2CSR1 Reset Value | EVF 0 | ADD10 0 | TRA 0 | BUSY 0 | BTF 0 | ADSL 0 | M/SL 0 | SB 0 |
| 0066h | I2CSR2 Reset Value | 0 | 0 | 0 | AF 0 | STOPF 0 | ARLO 0 | BERR 0 | GCAL 0 |
| 0067h | I2CCCR Reset Value | FM/SM 0 | CC6 0 | CC5 0 | CC4 0 | CC3 0 | CC2 0 | CC1 0 | CC0 0 |
| 0068h | I2COAR1 Reset Value | ADD7 0 | ADD6 0 | ADD5 0 | ADD4 0 | ADD3 0 | ADD2 0 | ADD1 0 | ADD0 0 |
| 0069h | I2COAR2 Reset Value | FR1 0 | FR0 1 | 0 | 0 | 0 | ADD9 0 | ADD8 0 | 0 |
| 006Ah | I2CDR Reset Value | MSB 0 | 0 | 0 | 0 | 0 | 0 | 0 | LSB 0 |

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11.5 10-bit A/D converter (ADC)

11.5.1 Introduction

The on-chip Analog to Digital Converter (ADC) peripheral is a 10-bit, successive approximation converter with internal sample and hold circuitry. This peripheral has up to 10 multiplexed analog input channels (refer to device pin out description) that allow the peripheral to convert the analog voltage levels from up to 7 different sources.

The result of the conversion is stored in a 10-bit Data register. The A/D converter is controlled through a Control/Status register.

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11.5.2 Main Features

- 10-bit conversion
- Up to 7 channels with multiplexed input
- Linear successive approximation
- Data register (DR) which contains the results
- Conversion complete status flag
- On/off bit (to reduce consumption)

The block diagram is shown in *Figure 59*.

11.5.3 Functional description

Analog power supply

 V_{DDA} and V_{SSA} are the high and low level reference voltage pins. In some devices (refer to device pin out description) they are internally connected to the V_{DD} and V_{SS} pins.

Conversion accuracy may therefore be impacted by voltage drops and noise in the event of heavily loaded or badly decoupled power supply lines.

DIV 4 f_{CPU} f_{ADC} SLOW bit CH3 **ADCCSR** EOC SPEED ADO! CH2 CH1 CH0 AINO HOLD CONTROL $\mathsf{R}_{\mathsf{ADC}}$ AIN1 ANALOG TO DIGITAL ANALOG CONVERTER MUX **ADCDRH** D9 D8 D7 D4 D3 D2 D6 D5 **ADCDRL** 0 SLOV D0

Figure 59. ADC block diagram

Digital A/D conversion result

The conversion is monotonic, meaning that the result never decreases if the analog input does not and never increases if the analog input does not.

If the input voltage (V_{AIN}) is greater than V_{DDA} (high-level voltage reference) then the conversion result is FFh in the ADCDRH register and 03h in the ADCDRL register (without overflow indication).

If the input voltage (VAIN) is lower than VSSA (low-level voltage reference) then the conversion result in the ADCDRH and ADCDRL registers is 00 00h.

The A/D converter is linear and the digital result of the conversion is stored in the ADCDRH and ADCDRL registers. The accuracy of the conversion is described in the Electrical Characteristics Section.

R_{AIN} is the maximum recommended impedance for an analog input signal. If the impedance is too high, this will result in a loss of accuracy due to leakage and sampling not being completed in the alloted time.

Configuring the A/D conversion

The analog input ports must be configured as input, no pull-up, no interrupt (see Section 10: I/O ports). Using these pins as analog inputs does not affect the ability of the port to be read as a logic input.

To assign the analog channel to convert, select the CH[2:0] bits in the ADCCSR register.

Set the ADON bit to enable the A/D converter and to start the conversion. From this time on, the ADC performs a continuous conversion of the selected channel.

When a conversion is complete:

- The EOC bit is set by hardware.
- The result is in the ADCDR registers.

A read to the ADCDRH or a write to any bit of the ADCCSR register resets the EOC bit.

To read the 10 bits, perform the following steps:

- Poll the EOC bit
- 2. Read ADCDRL
- 3. Read ADCDRH. This clears EOC automatically.

To read only 8 bits, perform the following steps:

- 1. Poll EOC bit
- 2. Read ADCDRH. This clears EOC automatically.

Changing the conversion channel

The application can change channels during conversion. When software modifies the CH[3:0] bits in the ADCCSR register, the current conversion is stopped, the EOC bit is cleared, and the A/D converter starts converting the newly selected channel.

11.5.4 Low power modes

The A/D converter may be disabled by resetting the ADON bit. This feature allows reduced power consumption when no conversion is needed and between single shot conversions.

Table 53. Effect of low power modes on the A/D converter

| Mode | Description |
|------|---|
| Wait | No effect on A/D Converter |
| Halt | A/D Converter disabled. After wake up from Halt mode, the A/D Converter requires a stabilization time t _{STAB} (see Electrical Characteristics) before accurate conversions can be performed. |

11.5.5 Interrupts

None.

11.5.6 Register description

Control/status register (ADCCSR)

Reset value: 0000 0000 (00h)

 7
 0

 EOC
 SPEED
 ADON
 0
 CH3
 CH2
 CH1
 CH0

 Read only
 Read/write

Bit 7 = **EOC** End of Conversion bit

This bit is set by hardware. It is cleared by hardware when software reads the ADCDRH register or writes to any bit of the ADCCSR register.

0: Conversion is not complete

1: Conversion complete

Bit 6 = **SPEED** ADC clock selection bit

This bit is set and cleared by software. It is used together with the SLOW bit to configure the ADC clock speed. Refer to the table in the SLOW bit description (ADCDRL register).

Bit 5 = **ADON** A/D Converter on bit

This bit is set and cleared by software.

0: A/D converter is switched off

1: A/D converter is switched on

Bits 4:3 = **Reserved.** Must be kept cleared.

Bits 2:0 = CH[2:0] Channel Selection

These bits select the analog input to convert. They are set and cleared by software.

Table 54. Channel selection using CH[2:0]

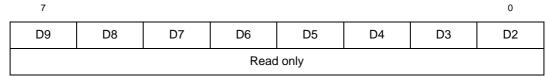
| Channel Pin ⁽¹⁾ | СНЗ | CH2 | CH1 | СН0 |
|----------------------------|-----|-----|-----|-----|
| AIN0 | 0 | 0 | 0 | 0 |
| AIN1 | 0 | 0 | 0 | 1 |
| AIN2 | 0 | 0 | 1 | 0 |
| AIN3 | 0 | 0 | 1 | 1 |
| AIN4 | 0 | 1 | 0 | 0 |
| AIN5 | 0 | 1 | 0 | 1 |
| AIN6 | 0 | 1 | 1 | 0 |
| AIN7 | 0 | 1 | 1 | 1 |
| AIN8 | 1 | 0 | 0 | 0 |
| AIN9 | 1 | 0 | 0 | 1 |

^{1.} The number of channels is device dependent. Refer to the device pinout description.

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Data register High (ADCDRH)

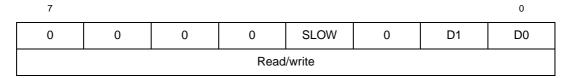
Reset value: xxxx xxxx (xxh)



Bits 7:0 = **D[9:2]** MSB of Analog Converted Value

Adc Control/data register Low (ADCDRL)

Reset value: 0000 00xx (0xh)



Bits 7:4 =Reserved. Forced by hardware to 0.

Bit 3 = **SLOW** Slow mode bit

This bit is set and cleared by software. It is used together with the SPEED bit in the ADCCSR register to configure the ADC clock speed as shown on the table below.

Table 55. Configuring the ADC clock speed

| f _{ADC} ⁽¹⁾ | SLOW | SPEED |
|---------------------------------|------|-------|
| f _{CPU} /2 | 0 | 0 |
| f _{CPU} | 0 | 1 |
| f _{CPU} /4 | 1 | Х |

^{1.} The maximum allowed value of f_{ADC} is 4 MHz (see Section 13.11 on page 172)

Bit 2 = Reserved. Forced by hardware to 0.

Bits 1:0 = **D[1:0]** LSB of Analog Converted value

Table 56. ADC register mapping and reset values

| Address (Hex.) | Register label | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------|-----------------------|----------|------------|-----------|---------|-----------|----------|----------|----------|
| 0036h | ADCCSR Reset Value | EOC 0 | SPEED 0 | ADON 0 | 0 0 | CH3 0 | CH2 0 | CH1 0 | CH0 0 |
| 0037h | ADCDRH Reset Value | D9 x | D8 x | D7 x | D6 x | D5 x | D4 x | D3 x | D2 x |
| 0038h | ADCDRL Reset Value | 0 0 | 0 | 0 0 | 0 | SLOW 0 | 0 | D1 x | D0 x |

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12.1 ST7 addressing modes

The ST7 core features 17 different addressing modes which can be classified in seven main groups:

Table 57. Description of addressing modes

| Addressing mode | Example |
|-----------------|-----------------|
| Inherent | nop |
| Immediate | ld A,#\$55 |
| Direct | ld A,\$55 |
| Indexed | ld A,(\$55,X) |
| Indirect | ld A,([\$55],X) |
| Relative | jrne loop |
| Bit operation | bset byte,#5 |

The ST7 Instruction set is designed to minimize the number of bytes required per instruction: To do so, most of the addressing modes may be subdivided in two submodes called long and short:

- Long addressing mode is more powerful because it can use the full 64 Kbyte address space, however it uses more bytes and more CPU cycles.
- Short addressing mode is less powerful because it can generally only access page zero (0000h - 00FFh range), but the instruction size is more compact, and faster. All memory to memory instructions use short addressing modes only (CLR, CPL, NEG, BSET, BRES, BTJT, BTJF, INC, DEC, RLC, RRC, SLL, SRL, SRA, SWAP)

The ST7 Assembler optimizes the use of long and short addressing modes.

Table 58. ST7 addressing mode overview

| Mode | | Syntax | Destination/ source | Pointer address | Pointer size | Length (bytes) | |
|-----------|----------|---------|------------------------|-----------------|--------------|-------------------|--|
| Inherent | | | nop | | | | + 0 |
| Immediate | | | ld A,#\$55 | | | | + 1 |
| Short | Direct | | ld A,\$10 | 00FF | | | + 1 |
| Long | Direct | | ld A,\$1000 | 0000FFFF | | | + 2 |
| No Offset | Direct | Indexed | ld A,(X) | 00FF | | | + 0 (with X register) + 1 (with Y register) |
| Short | Direct | Indexed | Id A,(\$10,X) | 001FE | | | + 1 |
| Long | Direct | Indexed | ld A,(\$1000,X) | 0000FFFF | | | + 2 |
| Short | Indirect | | ld A,[\$10] | 00FF | 00FF | byte | + 2 |
| Long | Indirect | | ld A,[\$10.w] | 0000FFFF | 00FF | word | + 2 |
| Short | Indirect | Indexed | ld A,([\$10],X) | 001FE | 00FF | byte | + 2 |

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Table 58. ST7 addressing mode overview (continued)

| Mode | | Syntax | Destination/ source | Pointer address | Pointer size | Length (bytes) | |
|----------|----------|----------|------------------------|----------------------------------|-----------------|-------------------|-----|
| Long | Indirect | Indexed | ld A,([\$10.w],X) | 0000FFFF | 00FF | word | + 2 |
| Relative | Direct | | jrne loop | PC- 128/PC+127 ⁽¹⁾ | | | +1 |
| Relative | Indirect | | jrne [\$10] | PC- 128/PC+127 ⁽¹⁾ | 00FF | byte | + 2 |
| Bit | Direct | | bset \$10,#7 | 00FF | | | + 1 |
| Bit | Indirect | | bset [\$10],#7 | 00FF | 00FF | byte | + 2 |
| Bit | Direct | Relative | btjt \$10,#7,skip | 00FF | | | + 2 |
| Bit | Indirect | Relative | btjt [\$10],#7,skip | 00FF | 00FF | byte | + 3 |

^{1.} At the time the instruction is executed, the Program Counter (PC) points to the instruction following JRxx.

12.1.1 Inherent mode

All Inherent instructions consist of a single byte. The opcode fully specifies all the required information for the CPU to process the operation.

Table 59. Instructions supporting Inherent addressing mode

| Instruction | Function | | | | |
|-------------|-------------------------------------|--|--|--|--|
| NOP | No operation | | | | |
| TRAP | S/W interrupt | | | | |
| WFI | Wait for interrupt (low power mode) | | | | |
| HALT | Halt oscillator (lowest power mode) | | | | |
| RET | Subroutine return | | | | |
| IRET | Interrupt subroutine return | | | | |
| SIM | Set interrupt mask | | | | |
| RIM | Reset interrupt mask | | | | |
| SCF | Set carry flag | | | | |
| RCF | Reset carry flag | | | | |
| RSP | Reset stack pointer | | | | |
| LD | Load | | | | |
| CLR | Clear | | | | |
| PUSH/POP | Push/Pop to/from the stack | | | | |
| INC/DEC | Increment/decrement | | | | |
| TNZ | Test negative or zero | | | | |
| CPL, NEG | 1 or 2 complement | | | | |

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Table 59. Instructions supporting Inherent addressing mode (continued)

| Instruction | Function |
|-------------------------|-----------------------------|
| MUL | Byte multiplication |
| SLL, SRL, SRA, RLC, RRC | Shift and rotate operations |
| SWAP | Swap nibbles |

12.1.2 Immediate mode

Immediate instructions have 2 bytes, the first byte contains the opcode, the second byte contains the operand value.

Table 60. Instructions supporting Inherent immediate addressing mode

| Immediate Instruction | Function |
|-----------------------|-----------------------|
| LD | Load |
| CP | Compare |
| ВСР | Bit compare |
| AND, OR, XOR | Logical operations |
| ADC, ADD, SUB, SBC | Arithmetic operations |

12.1.3 Direct modes

In Direct instructions, the operands are referenced by their memory address.

The direct addressing mode consists of two submodes:

Direct (Short) addressing mode

The address is a byte, thus requires only 1 byte after the opcode, but only allows 00 - FF addressing space.

Direct (Long) addressing mode

The address is a word, thus allowing 64 Kbyte addressing space, but requires 2 bytes after the opcode.

12.1.4 Indexed modes (No Offset, Short, Long)

In this mode, the operand is referenced by its memory address, which is defined by the unsigned addition of an index register (X or Y) with an offset.

The indirect addressing mode consists of three submodes:

Indexed mode (No Offset)

There is no offset (no extra byte after the opcode), and allows 00 - FF addressing space.

Indexed mode (Short)

The offset is a byte, thus requires only 1 byte after the opcode and allows 00 - 1FE addressing space.

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Indexed mode (Long)

The offset is a word, thus allowing 64 Kbyte addressing space and requires 2 bytes after the opcode.

12.1.5 Indirect modes (Short, Long)

The required data byte to do the operation is found by its memory address, located in memory (pointer).

The pointer address follows the opcode. The indirect addressing mode consists of two submodes:

Indirect mode (Short)

The pointer address is a byte, the pointer size is a byte, thus allowing 00 - FF addressing space, and requires 1 byte after the opcode.

Indirect mode (Long)

The pointer address is a byte, the pointer size is a word, thus allowing 64 Kbyte addressing space, and requires 1 byte after the opcode.

12.1.6 Indirect Indexed modes (Short, Long)

This is a combination of indirect and short indexed addressing modes. The operand is referenced by its memory address, which is defined by the unsigned addition of an index register value (X or Y) with a pointer value located in memory. The pointer address follows the opcode.

The indirect indexed addressing mode consists of two submodes:

Indirect Indexed mode (Short)

The pointer address is a byte, the pointer size is a byte, thus allowing 00 - 1FE addressing space, and requires 1 byte after the opcode.

Indirect Indexed mode (Long)

The pointer address is a byte, the pointer size is a word, thus allowing 64 Kbyte addressing space, and requires 1 byte after the opcode.

Table 61. Instructions supporting Direct, Indexed, Indirect and Indirect Indexed addressing modes

| Instructions | Function | | | | | |
|-----------------------------|--|--|--|--|--|--|
| Long and short instructions | | | | | | |
| LD | Load | | | | | |
| СР | Compare | | | | | |
| AND, OR, XOR | Logical operations | | | | | |
| ADC, ADD, SUB, SBC | Arithmetic addition/subtraction operations | | | | | |
| BCP | Bit compare | | | | | |

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Table 61. Instructions supporting Direct, Indexed, Indirect and Indirect Indexed addressing modes (continued)

| Instructions | Function | | | | | |
|-------------------------|------------------------------|--|--|--|--|--|
| Short instructions only | | | | | | |
| CLR | Clear | | | | | |
| INC, DEC | Increment/decrement | | | | | |
| TNZ | Test negative or zero | | | | | |
| CPL, NEG | 1 or 2 complement | | | | | |
| BSET, BRES | Bit operations | | | | | |
| BTJT, BTJF | Bit test and jump operations | | | | | |
| SLL, SRL, SRA, RLC, RRC | Shift and rotate operations | | | | | |
| SWAP | Swap nibbles | | | | | |
| CALL, JP | Call or jump subroutine | | | | | |

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12.1.7 Relative modes (Direct, Indirect)

This addressing mode is used to modify the PC register value by adding an 8-bit signed offset to it.

Table 62. Instructions supporting relative modes

| Available Relative Direct/Indirect instructions | Function | | | | |
|---|------------------|--|--|--|--|
| JRxx | Conditional jump | | | | |
| CALLR | Call relative | | | | |

The relative addressing mode consists of two submodes:

Relative mode (Direct)

The offset follows the opcode.

Relative mode (Indirect)

The offset is defined in memory, of which the address follows the opcode.

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12.2 Instruction groups

The ST7 family devices use an Instruction Set consisting of 63 instructions. The instructions may be subdivided into 13 main groups as illustrated in the following table:

Table 63. ST7 instruction set

| Load and Transfer | LD | CLR | | | | | | |
|----------------------------------|------|------|------|------|------|-------|-----|-----|
| Stack operation | PUSH | POP | RSP | | | | | |
| Increment/decrement | INC | DEC | | | | | | |
| Compare and tests | СР | TNZ | ВСР | | | | | |
| Logical operations | AND | OR | XOR | CPL | NEG | | | |
| Bit operation | BSET | BRES | | | | | | |
| Conditional bit test and branch | BTJT | BTJF | | | | | | |
| Arithmetic operations | ADC | ADD | SUB | SBC | MUL | | | |
| Shift and rotate | SLL | SRL | SRA | RLC | RRC | SWAP | SLA | |
| Unconditional jump or call | JRA | JRT | JRF | JP | CALL | CALLR | NOP | RET |
| Conditional branch | JRxx | | | | | | | |
| Interruption management | TRAP | WFI | HALT | IRET | | | | |
| Condition Code Flag modification | SIM | RIM | SCF | RCF | | | | |

Using a prebyte

The instructions are described with 1 to 4 bytes.

In order to extend the number of available opcodes for an 8-bit CPU (256 opcodes), three different prebyte opcodes are defined. These prebytes modify the meaning of the instruction they precede.

The whole instruction becomes by:

PC-2 End of previous instruction

PC-1 Prebyte

PC Opcode

PC+1 Additional word (0 to 2) according to the number of bytes required to compute the effective address

These prebytes enable instruction in Y as well as indirect addressing modes to be implemented. They precede the opcode of the instruction in X or the instruction using direct addressing mode. The prebytes are:

PDY 90 Replace an X based instruction using immediate, direct, indexed, or inherent addressing mode by a Y one.

PIX 92 Replace an instruction using direct, direct bit or direct relative addressing mode to an instruction using the corresponding indirect addressing mode.

It also changes an instruction using X indexed addressing mode to an instruction using indirect X indexed addressing mode.

PIY 91 Replace an instruction using X indirect indexed addressing mode by a Y one.

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ST7LITE49M Instruction set

12.2.1 Illegal Opcode Reset

In order to provide enhanced robustness to the device against unexpected behavior, a system of illegal opcode detection is implemented: a reset is generated if the code to be executed does not correspond to any opcode or prebyte value. This, combined with the Watchdog, allows the detection and recovery from an unexpected fault or interference.

A valid prebyte associated with a valid opcode forming an unauthorized combination does not generate a reset.

Table 64. Illegal opcode detection

| Mnemo | Description | Function/Example | Dst | Src | Н | I | N | Z | С |
|-------|----------------------------|---------------------|--------|-----|---|---|---|---|---|
| ADC | Add with Carry | A = A + M + C | Α | М | Н | | N | Z | С |
| ADD | Addition | A = A + M | А | М | Н | | N | Z | С |
| AND | Logical And | A = A . M | Α | М | | | N | Z | |
| ВСР | Bit compare A, Memory | tst (A . M) | Α | М | | | N | Z | |
| BRES | Bit Reset | bres Byte, #3 | М | | | | | | |
| BSET | Bit Set | bset Byte, #3 | М | | | | | | |
| BTJF | Jump if bit is false (0) | btjf Byte, #3, Jmp1 | М | | | | | | С |
| BTJT | Jump if bit is true (1) | btjt Byte, #3, Jmp1 | М | | | | | | С |
| CALL | Call subroutine | | | | | | | | |
| CALLR | Call subroutine relative | | | | | | | | |
| CLR | Clear | | reg, M | | | | 0 | 1 | |
| СР | Arithmetic Compare | tst(Reg - M) | reg | М | | | N | Z | С |
| CPL | One Complement | A = FFH-A | reg, M | | | | N | Z | 1 |
| DEC | Decrement | dec Y | reg, M | | | | N | Z | |
| HALT | Halt | | | | | 0 | | | |
| IRET | Interrupt routine return | Pop CC, A, X, PC | | | Н | I | N | Z | С |
| INC | Increment | inc X | reg, M | | | | N | Z | |
| JP | Absolute Jump | jp [TBL.w] | | | | | | | |
| JRA | Jump relative always | | | | | | | | |
| JRT | Jump relative | | | | | | | | |
| JRF | Never jump | jrf * | | | | | | | |
| JRIH | Jump if ext. interrupt = 1 | | | | | | | | |
| JRIL | Jump if ext. interrupt = 0 | | | | | | | | |
| JRH | Jump if H = 1 | H = 1 ? | | | | | | | |
| JRNH | Jump if H = 0 | H = 0 ? | | | | | | | |
| JRM | Jump if I = 1 | I = 1 ? | | | | | | | |
| JRNM | Jump if I = 0 | I = 0 ? | | | | | | | |
| JRMI | Jump if N = 1 (minus) | N = 1 ? | | | | | | | |

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Table 64. Illegal opcode detection (continued)

| | Mnemo | Description | Function/Example | Dst | Src | Н | ı | N | Z | С |
|-----------------|-------|-----------------------------|--------------------|---------|---------|---|---|---|---|---|
| | JRPL | Jump if N = 0 (plus) | N = 0 ? | | | | | | | |
| | JREQ | Jump if Z = 1 (equal) | Z = 1 ? | | | | | | | |
| | JRNE | Jump if $Z = 0$ (not equal) | Z = 0 ? | | | | | | | |
| | JRC | Jump if C = 1 | C = 1 ? | | | | | | | |
| ļ | JRNC | Jump if C = 0 | C = 0 ? | | | | | | | |
| | JRULT | Jump if C = 1 | Unsigned < | | | | | | | |
| www.DataSheet4U | JRUGE | Jump if C = 0 | Jmp if unsigned >= | | | | | | | |
| | JRUGT | Jump if $(C + Z = 0)$ | Unsigned > | | | | | | | |
| ļ | JRULE | Jump if $(C + Z = 1)$ | Unsigned <= | | | | | | | |
| ļ | LD | Load | dst <= src | reg, M | M, reg | | | N | Z | |
| ļ | MUL | Multiply | X,A = X * A | A, X, Y | X, Y, A | 0 | | | | 0 |
| ļ | NEG | Negate (2's compl) | neg \$10 | reg, M | | | | N | Z | С |
| | NOP | No Operation | | | | | | | | |
| ļ | OR | OR operation | A = A + M | Α | М | | | N | Z | |
| | POP | Pop from the Stack | pop reg | reg | М | | | | | |
| ļ | | | pop CC | CC | М | Н | I | Ν | Z | С |
| | PUSH | Push onto the Stack | push Y | М | reg, CC | | | | | |
| | RCF | Reset carry flag | C = 0 | | | | | | | 0 |
| | RET | Subroutine Return | | | | | | | | |
| | RIM | Enable Interrupts | I = 0 | | | | 0 | | | |
| | RLC | Rotate left true C | C <= Dst <= C | reg, M | | | | Ν | Z | С |
| | RRC | Rotate right true C | C => Dst => C | reg, M | | | | Ν | Z | С |
| | RSP | Reset Stack Pointer | S = Max allowed | | | | | | | |
| | SBC | Subtract with Carry | A = A - M - C | Α | М | | | Ν | Z | С |
| | SCF | Set carry flag | C = 1 | | | | | | | 1 |
| | SIM | Disable Interrupts | I = 1 | | | | 1 | | | |
| | SLA | Shift left Arithmetic | C <= Dst <= 0 | reg, M | | | | Ν | Z | С |
| | SLL | Shift left Logic | C <= Dst <= 0 | reg, M | | | | Ν | Z | С |
| | SRL | Shift right Logic | 0 => Dst => C | reg, M | | | | 0 | Z | С |
| | SRA | Shift right Arithmetic | Dst7 => Dst => C | reg, M | | | | Ν | Z | С |
| | SUB | Subtraction | A = A - M | Α | М | | | N | Z | С |
| | SWAP | SWAP nibbles | Dst[74]<=>Dst[30] | reg, M | | | | N | Z | |
| | TNZ | Test for Neg & Zero | tnz lbl1 | | | | | N | Z | |
| | TRAP | S/W trap | S/W interrupt | | | | 1 | | | |

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Table 64. Illegal opcode detection (continued)

| Mnemo | Description | Function/Example | Dst | Src | Н | ı | N | Z | С |
|-------|--------------------|------------------|-----|-----|---|---|---|---|---|
| WFI | Wait for Interrupt | | | | | 0 | | | |
| XOR | Exclusive OR | A = A XOR M | Α | М | | | N | Z | |

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Electrical characteristics ST7LITE49M

13 Electrical characteristics

13.1 Parameter conditions

Unless otherwise specified, all voltages are referred to V_{SS}.

13.1.1 Minimum and maximum values

Unless otherwise specified the minimum and maximum values are guaranteed in the worst conditions of ambient temperature, supply voltage and frequencies by tests in production on 100% of the devices with an ambient temperature at $T_A=25$ °C and $T_A=T_A$ max (given by the selected temperature range).

Data based on characterization results, design simulation and/or technology characteristics are indicated in the table footnotes and are not tested in production. Based on characterization, the minimum and maximum values refer to sample tests and represent the mean value plus or minus three times the standard deviation (mean $\pm 3\Sigma$).

13.1.2 Typical values

Unless otherwise specified, typical data are based on $T_A=25$ °C, $V_{DD}=5$ V (for the 4.5 V \leq V $_{DD}\leq$ 5.5 V voltage range) and $V_{DD}=3.3$ V (for the 3.0 V \leq V $_{DD}\leq$ 3.6 V voltage range). They are given only as design guidelines and are not tested.

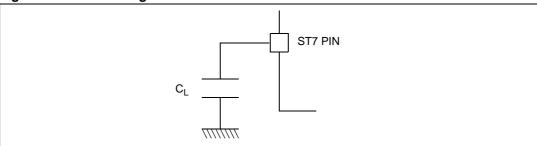
13.1.3 Typical curves

Unless otherwise specified, all typical curves are given only as design guidelines and are not tested.

13.1.4 Loading capacitor

The loading conditions used for pin parameter measurement are shown in Figure 60.

Figure 60. Pin loading conditions

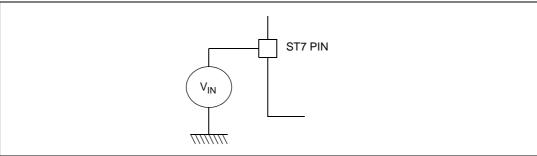


13.1.5 Pin input voltage

The input voltage measurement on a pin of the device is described in *Figure 61*.

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Figure 61. Pin input voltage



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13.2 Absolute maximum ratings

Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 65. Voltage characteristics

| Symbol | Ratings | Maximum value | Unit |
|-----------------------------------|---|--|---------|
| V _{DD} - V _{SS} | Supply voltage | 7.0 | V |
| V _{IN} | Input voltage on any pin ⁽¹⁾⁽²⁾ | V _{SS} -0.3 to V _{DD} +0.3 | V |
| V _{ESD(HBM)} | Electrostatic discharge voltage (Human Body model) | see Section 13.8.3 | on page |
| V _{ESD(CDM)} | Electrostatic discharge voltage (Charge Device model) | 158 | |

- 1. Directly connecting the $\overline{\text{RESET}}$ and I/O pins to V_{DD} or V_{SS} could damage the device if an unintentional internal reset is generated or an unexpected change of the I/O configuration occurs (for example, due to a corrupted Program Counter). To guarantee <u>safe operation</u>, this connection has to be done through a pull-up or pull-down resistor (typical: $4.7k\Omega$ for $\overline{\text{RESET}}$, $10k\Omega$ for I/Os). Unused I/O pins must be tied in the same way to V_{DD} or V_{SS} according to their reset configuration.
- I_{INJ(PIN)} must never be exceeded. This is implicitly insured if V_{IN} maximum is respected. If V_{IN} maximum cannot be respected, the injection current must be limited externally to the I_{INJ(PIN)} value. A positive injection is induced by V_{IN}>V_{DD} while a negative injection is induced by V_{IN}
 V_{SS}. For true open-drain pads, there is no positive injection current, and the corresponding V_{IN} maximum must always be respected

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Electrical characteristics ST7LITE49M

Table 66. Current characteristics

| Symbol | Ratings | Maximum value | Unit |
|---------------------------------------|---|---------------|------|
| I _{VDD} | Total current into V _{DD} power lines (source) ⁽¹⁾ | 75 | mA |
| I _{VSS} | Total current out of V _{SS} ground lines (sink) ⁽¹⁾ | 150 | |
| I _{IO} | Output current sunk by any standard I/O and control pin | 20 | |
| | Output current sunk by any high sink I/O pin | 40 | |
| | Output current source by any I/Os and control pin | - 25 | |
| I _{INJ(PIN)} (2)(3) | Injected current on RESET pin | ± 5 | |
| | Injected current on OSC1/CLKIN and OSC2 pins | ± 5 | |
| | Injected current on any other pin ⁽⁴⁾ | ± 5 | |
| ΣI _{INJ(PIN)} ⁽²⁾ | Total injected current (sum of all I/O and control pins) ⁽⁴⁾ | ± 20 | |

- 1. All power (V_{DD}) and ground (V_{SS}) lines must always be connected to the external supply.
- 2. I_{INJ(PIN)} must never be exceeded. This is implicitly insured if V_{IN} maximum is respected. If V_{IN} maximum cannot be respected, the injection current must be limited externally to the I_{INJ(PIN)} value. A positive injection is induced by V_{IN}>V_{DD} while a negative injection is induced by V_{IN}<V_{SS}. For true open-drain pads, there is no positive injection current, and the corresponding V_{IN} maximum must always be respected
- 3. Negative injection disturbs the analog performance of the device. In particular, it induces leakage currents throughout the device including the analog inputs. To avoid undesirable effects on the analog functions, care must be taken:
 - care must be taken:

 Analog input pins must have a negative injection less than 0.8 mA (assuming that the impedance of the analog voltage is lower than the specified limits)
 - Pure digital pins must have a negative injection less than 1.6mA. In addition, it is recommended to inject the current as far as possible from the analog input pins.
- 4. When several inputs are submitted to a current injection, the maximum ΣI_{INJ(PIN)} is the absolute sum of the positive and negative injected currents (instantaneous values). These results are based on characterisation with ΣI_{INJ(PIN)} maximum current injection on four I/O port pins of the device.

Table 67. Thermal characteristics

| Symbol | Ratings | Value | Unit |
|------------------|---|-------------|------|
| T _{STG} | Storage temperature range | -65 to +150 | °C |
| TJ | Maximum junction temperature (see <i>Table 105: Thermal characteristics on page 186</i>) | | |

13.3 Operating conditions

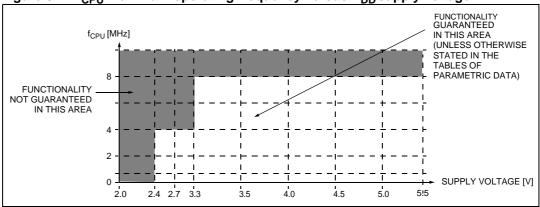
13.3.1 General operating conditions

 $T_A = -40$ to +125 °C unless otherwise specified.

Table 68. General operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|----------------------|--------------------------------|---------|------|--------|
| V | Supply voltage | f _{CPU} = 4 MHz. max. | 2.4 | 5.5 | V |
| V_{DD} | Supply voltage | f _{CPU} = 8 MHz. max. | 3.3 | 5.5 | V |
| f | CPU clock frequency | 3.3 V≤ V _{DD} ≤5.5 V | up | to 8 | MHz |
| † _{CPU} | OF O Glock frequency | 2.4 V≤V _{DD} <3.3 V | up to 4 | | IVIITZ |

Figure 62. f_{CPU} maximum operating frequency versus V_{DD} supply voltage



13.3.2 Operating conditions with Low Voltage Detector (LVD)

 $T_A = -40$ to 125 °C unless otherwise specified.

Table 69. Operating characteristics with LVD

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---|---|-------------------|-------------------|-------------------|------|
| V _{IT+(LVD)} | Reset release threshold (V _{DD} rise) | High Threshold Med. Threshold Low Threshold | 3.9 3.2 2.5 | 4.2 3.5 2.7 | 4.5 3.8 3.0 | V |
| V _{IT-(LVD)} | Reset generation threshold (V _{DD} fall) | High Threshold Med. Threshold Low Threshold | 3.7 3.0 2.4 | 4.0 3.3 2.6 | 4.3 3.6 2.9 | V |
| V _{hys} | LVD voltage threshold hysteresis | V _{IT+(LVD)} -V _{IT-(LVD)} | | 150 | | mV |
| V _{tPOR} | V _{DD} rise time rate ⁽¹⁾⁽²⁾ | | 2 | | | μs/V |
| I _{DD(LVD)} | LVD/AVD current consumption | V _{DD} = 5 V | | 80 | 140 | μА |

Not tested in production. The V_{DD} rise time rate condition is needed to ensure a correct device power-on and LVD reset release. When the V_{DD} slope is outside these values, the LVD may not release properly the reset of the MCU.

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Use of LVD with capacitive power supply: with this type of power supply, if power cuts occur in the
application, it is recommended to pull V_{DD} down to 0V to ensure optimum restart conditions. Refer to circuit
example in Figure 96 on page 171.

13.3.3 Auxiliary Voltage Detector (AVD) thresholds

 $T_A = -40$ to 125 °C unless otherwise specified.

Table 70. Operating characteristics with AVD⁽¹⁾

| Symbol | Parameter | eter Conditions M | | Typ ⁽²⁾ | Max ⁽²⁾ | Unit |
|-----------------------|---|---|-------------------|---------------------------|--------------------|------|
| V _{IT+(AVD)} | 1=>0 AVDF flag toggle threshold (V _{DD} rise) | High Threshold Med. Threshold Low Threshold | 4.0 3.4 2.6 | 4.4 3.7 2.9 | 4.8 4.1 3.2 | V |
| V _{IT-(AVD)} | 0=>1 AVDF flag toggle threshold (V _{DD} fall) | High Threshold Med. Threshold Low Threshold | 3.9 3.3 2.5 | 4.3 3.6 2.8 | 4.7 4.0 3.1 | V |
| V _{hys} | AVD voltage threshold hysteresis | V _{IT+(AVD)} -V _{IT-(AVD)} | | 150 | | mV |

^{1.} Refer to Section: Monitoring the VDD main supply.

13.3.4 Voltage drop between AVD flag setting and LVD reset generation

Table 71. Voltage drop

| Parameter | Min ⁽¹⁾ | Typ ⁽¹⁾ | Max ⁽¹⁾ | Unit |
|--|--------------------|---------------------------|--------------------|------|
| AVD med. Threshold - AVD low. threshold | 800 | 850 | 950 | |
| AVD high. Threshold - AVD low threshold | 1400 | 1450 | 1550 | |
| AVD high. Threshold - AVD med. threshold | 600 | 650 | 750 | |
| AVD low Threshold - LVD low threshold | 100 | 200 | 250 | mV |
| AVD med. Threshold - LVD low threshold | 950 | 1050 | 1150 | IIIV |
| AVD med. Threshold - LVD med. threshold | 250 | 300 | 400 | |
| AVD high. Threshold - LVD low threshold | 1600 | 1700 | 1800 | |
| AVD high. Threshold - LVD med. threshold | 900 | 1000 | 1050 | |

^{1.} Not tested in production, guaranteed by characterization.

^{2.} Not tested in production, guaranteed by characterization.

13.3.5 Internal RC oscillator

To improve clock stability and frequency accuracy, it is recommended to place a decoupling capacitor, typically 100 nF, between the V_{DD} and V_{SS} pins as close as possible to the ST7 device

Internal RC oscillator calibrated at 5.0 V

The ST7 internal clock can be supplied by an internal RC oscillator (selectable by option byte).

Table 72. Internal RC oscillator characteristics (5.0 V calibration)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|--|--|-------------------|-------|------|---------|
| f | Internal RC oscillator | RCCR = FF (reset value), $T_A=25 \text{ °C,V}_{DD}=5 \text{ V}$ | | 5.5 | | MHz |
| f _{RC} | rc frequency | RCCR=RCCR0 ⁽¹⁾ , T _A =25 °C,V _{DD} =5 V | 7.84 | 8 | 8.16 | IVII IZ |
| | Accuracy of Internal RC oscillator with RCCR=RCCR0 ¹⁾ | T _A =25 °C, VDD=4.5 to 5 V ⁽²⁾ | -2 ⁽³⁾ | | 2 | % |
| | | T _A =0 to +85 °C, V _{DD} =4.5 to 5.5 V ⁽²⁾ | -2.5 | | 4 | % |
| ACC _{RC} | | TA=0 to +125 °C, VDD=4.5 to 5.5 V ⁽²⁾ | -3 | | 6 | % |
| | | T_A =-40 to 0 °C, V_{DD} =4.5 to 5.5 $V^{(2)}$ | -4 | | 2.5 | % |
| t _{su(RC)} | RC oscillator setup time | T _A =25 °C, V _{DD} =5 V | | 4 (2) | | μS |

^{1.} See Section 7.1.1: Internal RC oscillator

Internal RC oscillator calibrated at 3.3 V

The ST7 internal clock can be supplied by an internal RC oscillator (selectable by option byte).

Table 73. Internal RC oscillator characteristics (3.3 V calibration)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------|-----------|--|------|-----|------|--------|
| f | | | | 4.3 | | MHz |
| † _{RC} | frequency | RCCR = RCCR1 ⁽¹⁾ , T _A =25 °C, V _{DD} =3.3 V | 7.84 | 8 | 8.16 | IVIITZ |

^{2.} Tested in production at 5.0 V only

^{3.} TDB stands for 'to be determined'.

Table 73. Internal RC oscillator characteristics (3.3 V calibration)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|--|--|------|-----------------|-----|------|
| | Accuracy of Internal RC oscillator with RCCR=RCCR1 ¹⁾ | $T_A=25$ °C, $V_{DD}=3.0$ to 3.6 $V^{(2)}$ | -2 | | 2 | % |
| ACC _{RC} | | $T_A=0$ to +85 °C, $V_{DD}=3.0$ to 3.6 $V^{(2)}$ | -2.5 | | 4 | % |
| ACCRC | | T_A =0 to +125 °C, V_{DD} =3.0 to 3.6 $V^{(2)}$ | -3 | | 6 | % |
| | | T_A =-40 to 0 °C, V_{DD} =3.0 to 3.6 $V^{(2)}$ | -4 | | 2.5 | % |
| t _{su(RC)} | RC oscillator setup time | T _A =25 °C, V _{DD} =3.3 V | | 4 ²⁾ | | μS |

1. See Section 7.1.1: Internal RC oscillator

2. Tested in production at 3.3 V only

Figure 63. Frequency vs voltage at four different ambient temperatures (RC at 5 V)

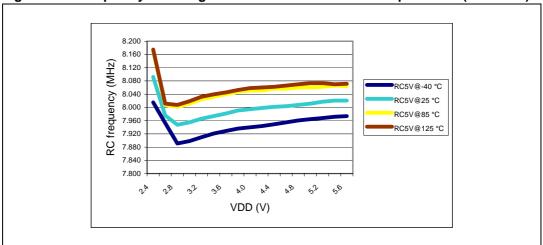


Figure 64. Frequency vs voltage at four different ambient temperatures (RC at 3.3 V)

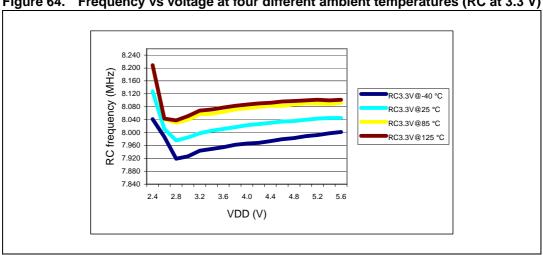
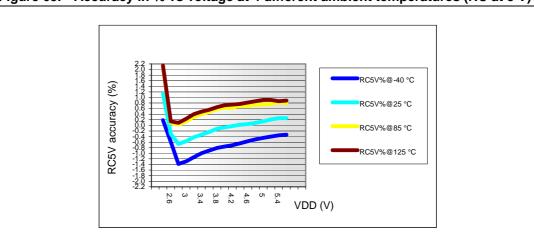
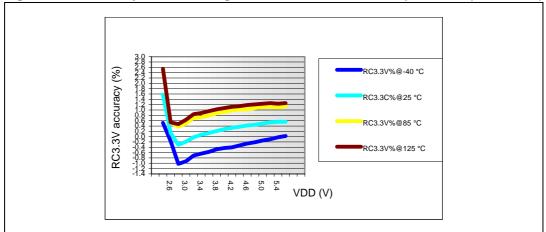


Figure 65. Accuracy in % vs voltage at 4 different ambient temperatures (RC at 5 V)



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Figure 66. Accuracy in % vs voltage at 4 different ambient temperatures (RC at 3.3V)



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13.4 Supply current characteristics

The following current consumption specified for the ST7 functional operating modes over temperature range does not take into account the clock source current consumption. To get the total device consumption, the two current values must be added (except for Halt mode for which the clock is stopped).

13.4.1 Supply current

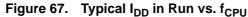
 $T_A = -40$ to +125 °C unless otherwise specified.

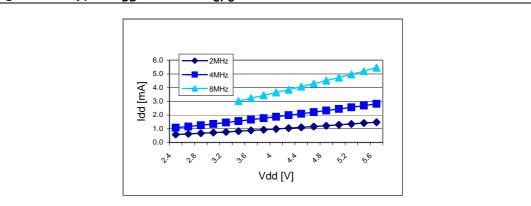
www.DataSheet4u Table 74. Supply current characteristics

| Symbol | Parameter | | Conditions | Тур | Max | Unit |
|-----------------|---|---------------------|--------------------------------|-----|--------------------|------------|
| | Cumply gurrant in Dun made(1) | | f _{CPU} = 4 MHz | 2.5 | 4.5 ⁽²⁾ | |
| | Supply current in Run mode ⁽¹⁾ | | f _{CPU} = 8 MHz | 5.0 | 9(2) | A |
| | Supply current in Wait mode ⁽³⁾ | | f _{CPU} = 4 MHz | 1.1 | 2 ⁽²⁾ | mA |
| | Supply current in wait mode. | | f _{CPU} = 8 MHz | 2 | 3.5 ⁽²⁾ | |
| | Supply current in Slow mode ⁽⁴⁾ | V _{DD} =5V | f _{CPU} /32 = 250 kHz | 550 | 900 | |
| | Supply current in Slow-Wait mode ⁽⁵⁾ | V _{DD} | f _{CPU} /32 = 250 kHz | 450 | 750 | μA - mA |
| | Supply current in AWUFH mode ⁽⁶⁾⁽⁷⁾ | | | 50 | 90 ⁽²⁾ | |
| | Supply current in Active Halt mode | | | 120 | 200 | |
| ı | Supply current in Halt mode ⁽⁸⁾ | | T _A =85°C | 0.5 | 5 | |
| I _{DD} | | | T _A =125°C | 0.5 | 5 | |
| | Supply current in Run mode ⁽¹⁾ | | f _{CPU} = 4 MHz | 1.4 | 2.5 ⁽²⁾ | |
| | Supply current in Wait mode ⁽³⁾ | | f _{CPU} = 4 MHz | 600 | 900 ⁽²⁾ | |
| | Supply current in Slow mode ⁽⁴⁾ | | f _{CPU} /32 = 250 kHz | 300 | 500 ⁽²⁾ | |
| | Supply current in Slow-Wait mode ⁽⁵⁾ | =3V | f _{CPU} /32 = 250 kHz | 250 | 450 ⁽²⁾ | |
| | Supply current in AWUFH mode ⁽⁶⁾⁽⁷⁾ | V _{DD} =3V | | 20 | 40 ⁽²⁾ | |
| | Supply current in Active Halt mode | | | 80 | 120 ⁽²⁾ | |
| | Supply current in Halt mode ⁽⁸⁾ | | T _A =85°C | 0.5 | 5 ⁽²⁾ | |
| | Зирріу сипені ін пан пюде | | T _A =125°C | 0.5 | 5(2) | |

CPU running with memory access, all I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load), all peripherals in reset state; clock input (CLKIN) driven by external square wave, LVD disabled.

- 2. Data based on characterization, not tested in production.
- All I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load), all peripherals in reset state; clock input (CLKIN) driven by external square wave, LVD disabled.
- Slow mode selected with f_{CPU} based on f_{OSC} divided by 32. All I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load), all peripherals in reset state; clock input (CLKIN) driven by external square wave, LVD disabled.
- Slow-Wait mode selected with f_{CPU} based on f_{OSC} divided by 32. All I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load), all peripherals in reset state; clock input (CLKIN) driven by external square wave, LVD disabled.
- 6. All I/O pins in input mode with a static value at V_{DD} or V_{SS} (no load). Data tested in production at V_{DD} max. and f_{CPU} max.
- 7. This consumption refers to the Halt period only and not the associated run period which is software dependent.
- 8. All I/O pins in output mode with a static value at V_{SS} (no load), LVD disabled. Data based on characterization results, tested in production at V_{DD} max and f_{CPU} max.





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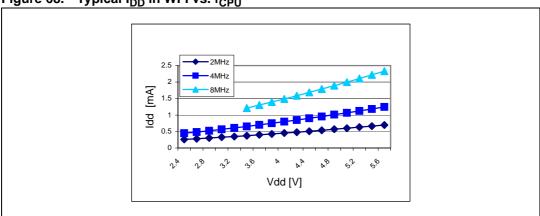
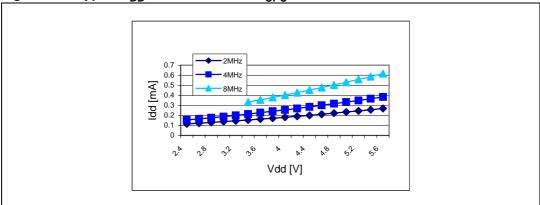
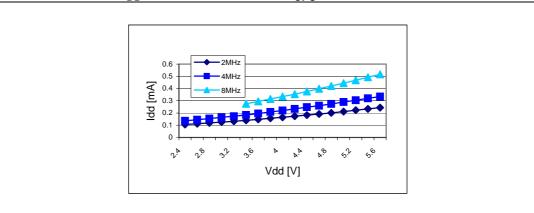


Figure 69. Typical I_{DD} in Slow mode vs. f_{CPU}



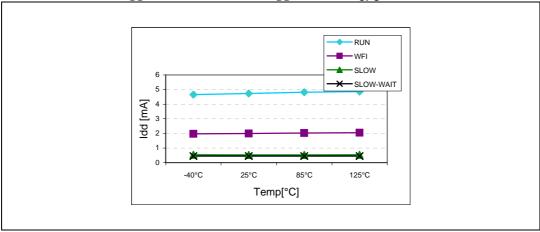
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Figure 70. Typical I_{DD} in Slow-Wait mode vs. f_{CPU}



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Figure 71. Typical I_{DD} vs. temperature at V_{DD} = 5V and f_{CPU} = 8 MHz



13.4.2 On-chip peripherals

Table 75. On-chip peripheral characteristics

| Symbol | Parameter | Cond | Тур | Unit | |
|----------------------|--|-------------------------|------------------------|------|----|
| I _{DD(AT)} | 12-bit Auto-Reload timer supply current ⁽¹⁾ | f _{CPU} =4 MHz | V _{DD} =3.0 V | 10 | |
| | 12-bit Auto-Reidau timer supply current | f _{CPU} =8 MHz | V _{DD} =5.0 V | 50 | |
| | I ² C supply current ⁽²⁾ | f _{CPU} =4 MHz | V _{DD} =3.0 V | 600 | μΑ |
| IDD(I2C) | | f _{CPU} =8 MHz | V _{DD} =5.0 V | 1000 | μΛ |
| I _{DD(ADC)} | ADC supply current when converting ⁽³⁾ | f _{ADC} =4 MHz | V _{DD} =3.0 V | 400 | |
| | ADC supply current when converting | IADC=4 IVII IZ | V _{DD} =5.0 V | 600 | |

^{1.} Data based on a differential I_{DD} measurement between reset configuration (timer stopped) and a timer running in PWM mode at f_{cpu} = 8 MHz.

Data based on a differential I_{DD} measurement between reset configuration (I²C disabled) and a permanent I²C master communication at 100 kHz (data sent equal to 55h). This measurement include the pad toggling consumption (4.7 kOhm external pull-up on clock and data lines).

^{3.} Data based on a differential $I_{\rm DD}$ measurement between reset configuration and continuous A/D conversions with amplifier disabled.

13.5 Communication interface characteristics

13.5.1 I²C interface

Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A unless otherwise specified.

Refer to I/O port characteristics for more details on the input/output alternate function characteristics (SDAI and SCLI). The ST7 I²C interface meets the electrical and timing requirements of the Standard I²C communication protocol.

 $T_A = -40$ °C to 125 °C, unless otherwise specified.

Table 76. I²C interface characteristics

| Symbo | l Parameter | Conditions | Min | Max | Unit |
|---------------------------------|--------------------------------|---|-----|-----|------|
| f _{SCL} ⁽¹⁾ | I ² C SCL frequency | f _{CPU} =4 MHz to 8 MHz, V _{DD} = 2.4 to 5.5 V | | 400 | kHz |

^{1.} The I²C interface will not function below the minimum clock speed of 4 MHz (see *Table 77*).

Table 77 gives the values to be written in the I2CCCR register to obtain the required I²C SCL line frequency.

Table 77. SCL frequency (multimaster I²C interface)⁽¹⁾⁽²⁾⁽³⁾

| | | out mequancy (manimum out) | | | | | | | | | |
|------------------|-----------------------|----------------------------|-------------------|---------------------------------------|--------------------------|------------------|-----------------------|---------------------------------------|--|--|--|
| | I2CCCR Value | | | | | | | | | | |
| | | f _{CPU} = | 4 MHz | | f _{CPU} = 8 MHz | | | | | | |
| f _{SCL} | V _{DD} = | : 3.3 V | V _{DD} : | = 5 V | V _{DD} = | 3.3 V | V _{DD} = 5 V | | | | |
| | R _P =3.3kΩ | $R_P=4.7k\Omega$ | $R_P=3.3k\Omega$ | R _P =4.7 k Ω | $R_P=3.3k\Omega$ | $R_P=4.7k\Omega$ | $R_P=3.3k\Omega$ | R _P =4.7 k Ω | | | |
| 400 | NA | NA | NA | NA | 84h | 83h | 84h | 84h | | | |
| 300 | NA | NA | NA | NA | 86h | 86h | 86h | 86h | | | |
| 200 | 84h | 84h | 84h | 84h | 8Ah | 8Ah | 8Ah | 8Ah | | | |
| 100 | 11h | 11h | 11h | 11h | 25h | 24h | 25h | 24h | | | |
| 50 | 25h | 25h | 25h | 25h | 4Ch | 4Ch | 4Dh | 4Ch | | | |
| 20 | 61h | 61h | 61h | 62h | FFh | FFh | FFh | FFh | | | |

^{1.} R_P = External pull-up resistance, $f_{SCL} = I^2C$ speed, NA = Not achievable, TBD = To be determined.

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^{2.} For fast mode speeds, achieved speed can have ±5% tolerance. For other speed ranges, achieved speed can have ±2% tolerance.

^{3.} The above variations depend on the accuracy of the external components used.

13.6 Clock and timing characteristics

Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A .

Table 78. General timings

| Symbol | Parameter ⁽¹⁾ | Conditions | Min | Typ ⁽²⁾ | Max | Unit |
|----------------------|--|------------------------|------|--------------------|------|------------------|
| t | Instruction cycle time | f _{CPU} =8MHz | 2 | 3 | 12 | t _{CPU} |
| ^t c(INST) | | | 250 | 375 | 1500 | ns |
| + | Interrupt reaction time ⁽³⁾ | t _0M⊔- | 10 | | 22 | t _{CPU} |
| τ _{ν(IT)} | $t_{v(IT)} = \Delta t_{c(INST)} + 10$ | f _{CPU} =8MHz | 1.25 | | 2.75 | μS |

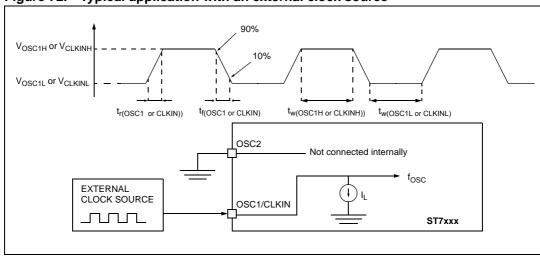
- 1. Guaranteed by Design. Not tested in production.
- 2. Data based on typical application software.
- 3. Time measured between interrupt event and interrupt vector fetch. $\Delta t_{\text{c(INST)}}$ is the number of t_{CPU} cycles needed to finish the current instruction execution.

Table 79. External clock source characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---|---|---|---------------------|-----|---------------------|------|
| V _{OSC1H} or V _{CLKIN_H} | OSC1/CLKIN input pin high level voltage | | 0.7xV _{DD} | | V_{DD} | V |
| V _{OSC1L} or V _{CLKIN_L} | OSC1/CLKIN input pin low level voltage | | V _{SS} | | 0.3xV _{DD} | ٧ |
| $\begin{array}{c} t_{\text{W}(\text{OSC1H})} \text{ or } \\ t_{\text{W}(\text{CLKINH})} \\ t_{\text{W}(\text{OSC1L})} \text{ or } \\ t_{\text{W}(\text{CLKINL})} \end{array}$ | OSC1/CLKIN high or low time ⁽¹⁾ | see Figure 72 | 15 | | | ns |
| $t_{r(OSC1)}$ or $t_{r(CLKIN)}$ $t_{f(OSC1)}$ or $t_{f(CLKIN)}$ | OSC1/CLKIN rise or fall time ⁽¹⁾ | | | | 15 | |
| IL | OSCx/CLKIN Input leakage current | V _{SS} ≤V _{IN} ≤V _{DD} | | | ±1 | μΑ |

^{1.} Data based on design simulation and/or technology characteristics, not tested in production.

Figure 72. Typical application with an external clock source



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13.6.1 Auto Wake Up from Halt oscillator (AWU)

Table 80. AWU from Halt characteristics

| Symbol | Parameter ⁽¹⁾ | Conditions | Min | Тур | Max | Unit |
|--------------------|-----------------------------|------------|-----|-----|-----|------|
| f _{AWU} | AWU Oscillator Frequency | | 16 | 32 | 64 | kHz |
| t _{RCSRT} | AWU Oscillator startup time | | | | 50 | μs |

^{1.} Guaranteed by Design. Not tested in production.

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13.6.2 Crystal and ceramic resonator oscillators

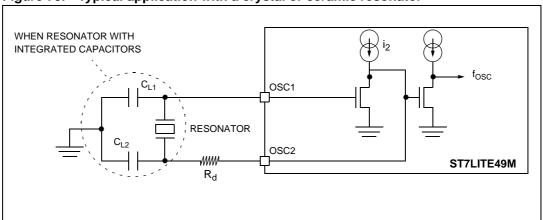
The ST7 internal clock can be supplied with ten different Crystal/Ceramic resonator oscillators. All the information given in this paragraph are based on characterization results with specified typical external components. In the application, the resonator and the load capacitors have to be placed as close as possible to the oscillator pins in order to minimize output distortion and start-up stabilization time. Refer to the crystal/ceramic resonator manufacturer for more details (frequency, package, accuracy...).

Table 81. Crystal/ceramic resonator oscillator characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------------------|--|------------|-----|--------------------|-----|------|
| f _{CrOSC} | Crystal Oscillator Frequency | | 2 | | 16 | MHz |
| C _{L1} C _{L2} | Recommended load capacitance versus equivalent serial resistance of the crystal or ceramic resonator (R _S) | | | TBD ⁽¹⁾ | | pF |

^{1.} TBD stands for 'to be determined'.

Figure 73. Typical application with a crystal or ceramic resonator



13.7 Memory characteristics

 $T_A = -40$ °C to 125 °C, unless otherwise specified.

Table 82. RAM and hardware registers characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------|------------------------------------|----------------------|-----|-----|-----|------|
| V_{RM} | Data retention mode ⁽¹⁾ | Halt mode (or Reset) | 1.6 | | | V |

Minimum V_{DD} supply voltage without losing data stored in RAM (in Halt mode or under Reset) or in hardware registers (only in Halt mode). Guaranteed by construction, not tested in production.

Table 83. Flash program memory characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-------------------|--|---|-----|------|------|--------|
| V _{DD} | Operating voltage for Flash Write/Erase | Refer to operating range of V _{DD} with T _{A,} Section 13.3.1 on page 145 | 2.4 | | 5.5 | V |
| t _{prog} | Programming time for 1~32 bytes ⁽¹⁾ | T _A =-40 to +125 °C | | 5 | 10 | ms |
| 1 -3 | Programming time for 4 kbytes | T _A =+25 °C | | 0.64 | 1.28 | S |
| t _{RET} | Data retention ⁽²⁾ | T _A =+55 °C ⁽³⁾ | 20 | | | years |
| N _{RW} | Write erase cycles | T _A =+25 °C | | | 10K | cycles |
| | (4) | Read / Write / Erase modes f _{CPU} = 8 MHz, V _{DD} = 5.5 V | | | 2.6 | mA |
| I _{DD} | Supply current ⁽⁴⁾ | No Read/No Write mode | | | 100 | μА |
| | | Power down mode / Halt | | 0 | 0.1 | μА |

^{1.} Up to 32 bytes can be programmed at a time.

Table 84. Data EEPROM memory characteristics

| Table 6 ii Data 22 i Noisi illoinei, y characterione | | | | | | |
|--|---|---|-----|-----|------|--------|
| Symbol | Parameter | eter Conditions | | Тур | Max | Unit |
| V _{DD} | Operating voltage for EEPROM Write/Erase | Refer to operating range of V _{DD} with T _{A,} Section 13.3.1 on page 145 | 2.4 | | 5.5 | V |
| t _{prog} | Programming time for 1~32 bytes | T _A =-40 to +125°C | | 5 | 10 | ms |
| t _{ret} | Data retention ⁽¹⁾ | T _A =+55°C ⁽²⁾ | 20 | | | years |
| N _{RW} | Write erase cycles | T _A =+25°C | | | 300K | cycles |

^{1.} Data based on reliability test results and monitored in production.

^{2.} Data based on reliability test results and monitored in production.

^{3.} The data retention time increases when the $T_{\mbox{\scriptsize A}}$ decreases.

^{4.} Guaranteed by Design. Not tested in production.

^{2.} The data retention time increases when the T_A decreases.

13.8 EMC characteristics

Susceptibility tests are performed on a sample basis during product characterization.

13.8.1 Functional EMS (electromagnetic susceptibility)

Based on a simple running application on the product (toggling 2 LEDs through I/O ports), the product is stressed by two electro magnetic events until a failure occurs (indicated by the LEDs).

- ESD: Electrostatic Discharge (positive and negative) is applied on all pins of the device until a functional disturbance occurs. This test conforms with the IEC 1000-4-2 standard.
- FTB: A Burst of Fast Transient voltage (positive and negative) is applied to V_{DD} and V_{SS} through a 100 pF capacitor, until a functional disturbance occurs. This test conforms with the IEC 1000-4-4 standard.

A device reset allows normal operations to be resumed. The test results are given in the table below based on the EMS levels and classes defined in application note AN1709.

Designing hardened software to avoid noise problems

EMC characterization and optimization are performed at component level with a typical application environment and simplified MCU software. It should be noted that good EMC performance is highly dependent on the user application and the software in particular.

Therefore it is recommended that the user applies EMC software optimization and prequalification tests in relation with the EMC level requested for his application.

Software recommendations

The software flowchart must include the management of runaway conditions such as:

- Corrupted Program Counter
- Unexpected reset
- Critical Data corruption (control registers...)
- Prequalification trials

Most of the common failures (unexpected reset and Program Counter corruption) can be reproduced by manually forcing a low state on the RESET pin or the Oscillator pins for 1 second.

To complete these trials, ESD stress can be applied directly on the device, over the range of specification values. When unexpected behaviour is detected, the software can be hardened to prevent unrecoverable errors occurring (see application note AN1015).

Table 85. EMS characteristics

| Symbol | Parameter | Conditions | Level/ Class |
|-------------------|--|---|-----------------|
| V _{FESD} | Voltage limits to be applied on any I/O pin to induce a functional disturbance | V _{DD} =5 V, T _A =+25 °C, f _{OSC} =8 MHz conforms to IEC 1000-4-2 | 2B |
| V _{FFTB} | Fast transient voltage burst limits to be applied through 100pF on V_{DD} and V_{SS} pins to induce a functional disturbance | V _{DD} =5 V, T _A =+25 °C, f _{OSC} =8 MHz conforms to IEC 1000-4-4 | 3B |

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13.8.2 Electromagnetic Interference (EMI)

Based on a simple application running on the product (toggling 2 LEDs through the I/O ports), the product is monitored in terms of emission. This emission test is in line with the norm SAE J 1752/3 which specifies the board and the loading of each pin.

Table 86. EMI characteristics⁽¹⁾

| Symbol | Symbol Parameter Conditions Monitored frequency band | | Max vs. [f _{OSC} /f _{CPU}] ⁽²⁾ | | Unit | |
|--------------------------|--|--|---|--------|---------|------|
| | | | rrequericy band | 8/4MHz | 16/8MHz | |
| | | | 0.1 MHz to 30 MHz | 28 | 32 | |
| 9 | Peak level | V _{DD} =5V, T _A =+25°C, , conforming to SAE | 30 MHz to 130 MHz | 31 | 34 | dBμV |
| S _{EMI} Peak le | reak level | J 1752/3 | 130 MHz to 1 GHz | 18 | 26 | |
| | | | SAE EMI Level | 3 | 3.5 | - |

^{1.} Data based on characterization results, not tested in production.

13.8.3 Absolute maximum ratings (electrical sensitivity)

Based on two different tests (ESD and LU) using specific measurement methods, the product is stressed in order to determine its performance in terms of electrical sensitivity. For more details, refer to the application note AN1181.

Electrostatic discharge (ESD)

Electrostatic discharges (a positive then a negative pulse separated by 1 second) are applied to the pins of each sample according to each pin combination. The sample size depends on the number of supply pins in the device (3 parts*(n+1) supply pin). Two models can be simulated: Human Body model and Machine model. This test conforms to the JESD22-A114A/A115A standard.

Table 87. Absolute maximum ratings

| Symbol | Ratings | Conditions | Maximum value ⁽¹⁾ | Unit |
|-----------------------|---|------------------------|---------------------------------|------|
| V _{ESD(HBM)} | Electrostatic discharge voltage (Human Body model) | T _A =+25 °C | 4000 | V |
| V _{ESD(CDM)} | Electrostatic discharge voltage (Charge Device model) | T _A =+25 °C | 500 | V |

^{1.} Data based on characterization results, not tested in production.

^{2.} TBD stands for 'to be determined'.

Static and dynamic latch-up

■ LU: 3 complementary static tests are required on 6 parts to assess the latch-up performance. A supply overvoltage (applied to each power supply pin) and a current injection (applied to each input, output and configurable I/O pin) are performed on each sample. This test conforms to the EIA/JESD 78 IC latch-up standard. For more details, refer to the application note AN1181.

Table 88. Electrical sensitivities

| Symbol | Parameter | Conditions | Class |
|--------|------------------------|--|-------|
| LU | Static latch-up class | T _A = +125 °C | А |
| DLU | Dynamic latch-up class | $V_{DD} = 5.5 \text{ V, } f_{OSC} = 4 \text{ MHz,}$ $T_A = +125 \text{ °C}$ | А |

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13.9 I/O port pin characteristics

13.9.1 General characteristics

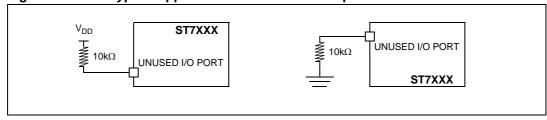
Subject to general operating conditions for V_{DD} , f_{OSC} , and T_A unless otherwise specified.

Table 89. General characteristics

| Symbol | Parameter | | Conditions | Min | Тур | Max | Unit | | | | | | | | | | | | | | |
|-----------------------|--|---------|--|-----------------------|---------|----------------------|------------------|---------|---------|---------|---------|---------|---------|---------|---------|---------|----------------------|--|--------------------|--|-----|
| V _{IL} | Input low level voltage | | | V _{SS} - 0.3 | | 0.3V _{DD} | V | | | | | | | | | | | | | | |
| V _{IH} | Input high level voltage | | | 0.7V _{DD} | | V _{DD} +0.3 | V | | | | | | | | | | | | | | |
| V _{hys} | Schmitt trigger voltage hysteresis ⁽¹⁾ | | | | 400 | | mV | | | | | | | | | | | | | | |
| IL | Input leakage current | \ | $V_{SS} \le V_{IN} \le V_{DD}$ Floating input mode | | | ±1 | | | | | | | | | | | | | | | |
| I _S | Static current consumption induced by each floating input pin ⁽²⁾ | Flo | | | 400 | | μΑ | | | | | | | | | | | | | | |
| В | Weak pull-up equivalent | V V | V _{DD} =5 V | 100 | 120 | 140 | kΩ | | | | | | | | | | | | | | |
| R _{PU} | resistor ⁽³⁾ | VIN=VSS | V _{IN} =V _{SS} | $V_{IN}=V_{SS}$ | VIN=VSS | VIN=VSS | VIN=VSS | VIN=VSS | VIN=VSS | VIN=VSS | VIN=VSS | VIN=VSS | VIN=VSS | VIN=VSS | VIN=VSS | VIN=VSS | V _{DD} =3 V | | 300 ⁽¹⁾ | | K22 |
| C _{IO} | I/O pin capacitance | | | | 5 | | pF | | | | | | | | | | | | | | |
| t _{f(IO)out} | Output high to low level fall time ⁽¹⁾ | | C _L =50 pF | | 25 | | ns | | | | | | | | | | | | | | |
| t _{r(IO)out} | Output low to high level rise time ⁽¹⁾ | Betw | een 10% and 90% | | 25 | | 115 | | | | | | | | | | | | | | |
| t _{w(IT)in} | External interrupt pulse time ⁽⁴⁾ | | | 1 | | | t _{CPU} | | | | | | | | | | | | | | |

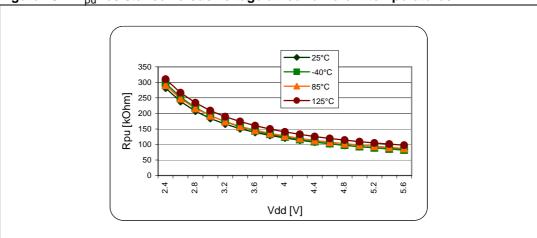
- 1. Data based on validation/design results.
- Configuration not recommended, all unused pins must be kept at a fixed voltage: using the output mode of the I/O for example or an external pull-up or pull-down resistor (see *Figure 74*). Static peak current value taken at a fixed V_{IN} value, based on design simulation and technology characteristics, not tested in production. This value depends on V_{DD} and temperature values.
- 3. The R_{PU} pull-up equivalent resistor is based on a resistive transistor.
- To generate an external interrupt, a minimum pulse width has to be applied on an I/O port pin configured as an external interrupt source.

Figure 74. Two typical applications with unused I/O pin



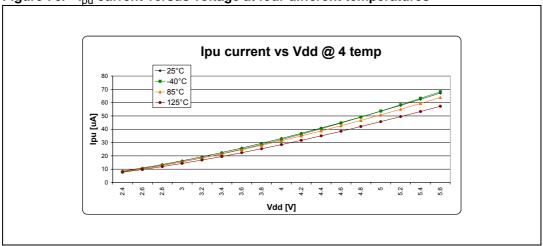
- During normal operation the ICCCLK pin must be pulled-up, internally or externally (external pull-up of 10k mandatory in noisy environment). This is to avoid entering ICC mode unexpectedly during a reset.
- 2. I/O can be left unconnected if it is configured as output (0 or 1) by the software. This has the advantage of greater EMC robustness and lower cost.

Figure 75. R_{pu} resistance versus voltage at four different temperatures



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Figure 76. I_{pu} current versus voltage at four different temperatures



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13.9.2 Output driving current

Subject to general operating conditions for V_{DD} , f_{CPU} , and T_A unless otherwise specified.

Table 90. Output driving current characteristics

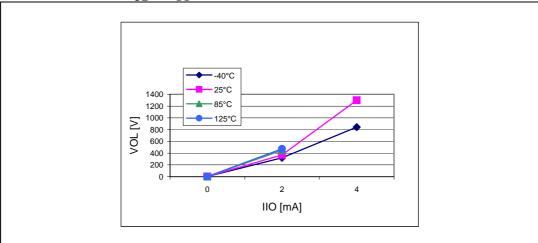
| Symbol | Parameter | | Conditions | Min | Max | Unit |
|-----------------------------------|---|------------------|---|----------------------|------|------|
| | Output low level voltage for a standard I/O pin when 8 pins are sunk at same time | | I _{IO} =+5 mA, T _A ≤ 125°C | | 1.0 | |
| V. (1) | (see Figure 79) | | I_{IO} =+2mA, T_A ≤ 125 °C | | 0.4 | |
| V _{OL} ⁽¹⁾ | Output low level voltage for a high sink I/O pin when 4 pins are sunk at same time | | I _{IO} =+20mA,T _A ≤ 125 °C | | 1.3 | |
| | (see Figure 82) | V _{DD} | I_{IO} =+8mAT _A \leq 125 °C | | 0.75 | |
| V _{OH} ⁽²⁾ | Output high level voltage for an I/O pin when 4 pins are sourced at same time | | I_{IO} =-5mA, T_{A} \leq 125 °C | V _{DD} -1.5 | | |
| | (see Figure 90) | (see Figure 90) | I _{IO} =-2mAT _A ≤ 125 °C | V _{DD} -0.8 | | |
| V _{OL} ⁽¹⁾⁽³⁾ | Output low level voltage for a standard I/O pin when 8 pins are sunk at same time (see Figure 78 and Figure 81) | ^ | I _{IO} =+2mAT _A ≤ 125 °C | | 0.5 | |
| | Output low level voltage for a high sink I/O pin when 4 pins are sunk at same time | $V_{DD} = 3$ | I_{IO} =+8mAT _A \leq 125 °C | | 0.5 | V |
| V _{OH} ⁽²⁾⁽³⁾ | Output high level voltage for an I/O pin when 4 pins are sourced at same time (Figure 89) | > | I _{IO} =-2mAT _A ≤ 125 °C | V _{DD} -0.8 | | |
| V _{OL} ⁽¹⁾⁽³⁾ | Output low level voltage for a standard I/O pin when 8 pins are sunk at same time (see Figure 77) | ^ | I _{IO} =+2mAT _A ≤ 125 °C | | 0.6 | |
| VOL | Output low level voltage for a high sink I/O pin when 4 pins are sunk at same time (see Figure 80) | $V_{DD} = 2.4$ \ | I _{IO} =+8mAT _A ≤ 125 °C | | 0.6 | |
| V _{OH} (2)(3) | Output high level voltage for an I/O pin when 4 pins are sourced at same time (see <i>Figure 88</i>) | > | I _{IO} =-2mAT _A ≤ 125 °C | V _{DD} -0.9 | | |

The I_{IO} current sunk must always respect the absolute maximum rating specified in Section Table 66. and the sum of I_{IO} (I/O ports and control pins) must not exceed I_{VSS}.

^{2.} The I_{IO} current sourced must always respect the absolute maximum rating specified in *Section Table 66*. and the sum of I_{IO} (I/O ports and control pins) must not exceed I_{VDD}.

^{3.} Not tested in production, based on characterization results.

Figure 77. Typical V_{OL} at $V_{DD} = 2.4 \text{ V}$ (standard)



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Figure 78. Typical V_{OL} at $V_{DD} = 3 \text{ V (standard)}$

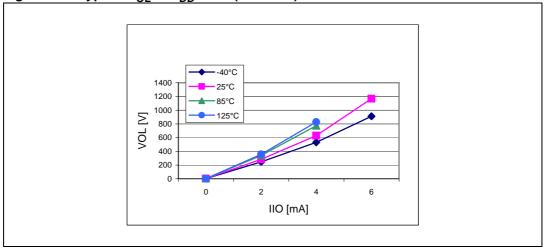
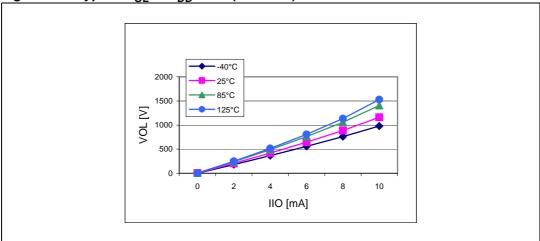
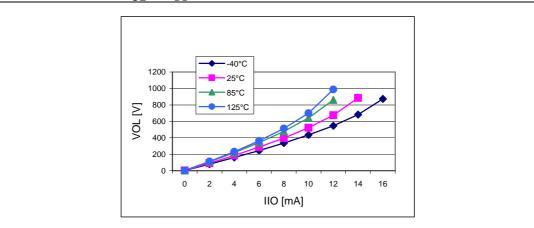


Figure 79. Typical V_{OL} at $V_{DD} = 5 \text{ V (standard)}$



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Figure 80. Typical V_{OL} at $V_{DD} = 2.4 \text{ V (high sink)}$



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Figure 81. Typical V_{OL} at $V_{DD} = 3 V$ (high sink)

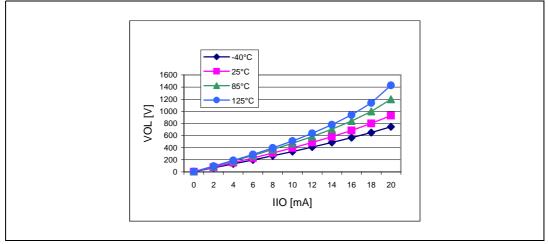


Figure 82. Typical V_{OL} at $V_{DD} = 5 \text{ V (high sink)}$

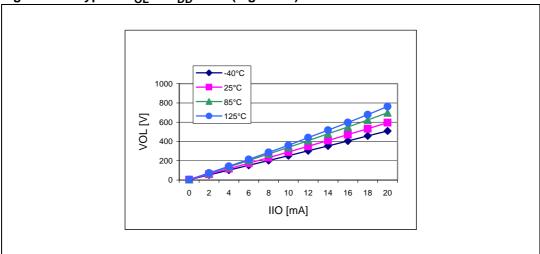
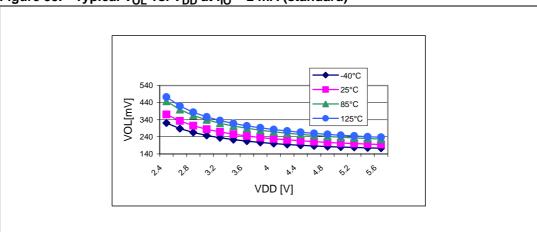
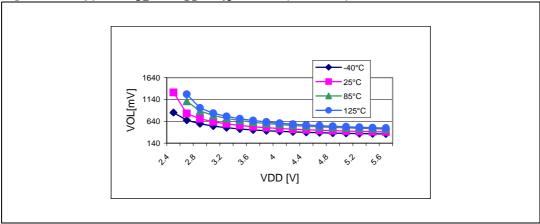


Figure 83. Typical V_{OL} vs. V_{DD} at I_{IO} = 2 mA (standard)

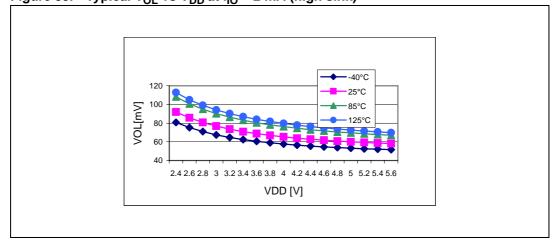


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Figure 84. Typical V_{OL} vs. V_{DD} at I_{IO} = 4 mA (standard)

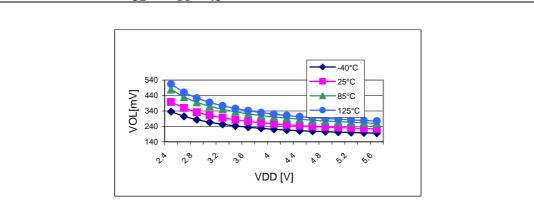






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Figure 86. Typical V_{OL} vs V_{DD} at I_{O} = 8 mA (high sink)



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Figure 87. Typical V_{OL} vs V_{DD} at I_{IO} = 12 mA (high sink)

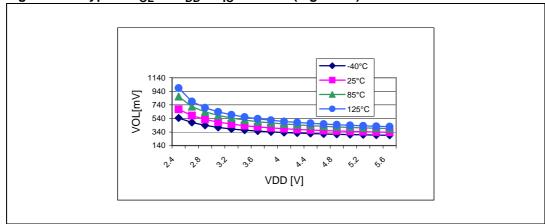
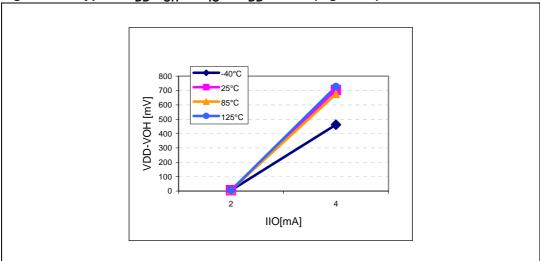
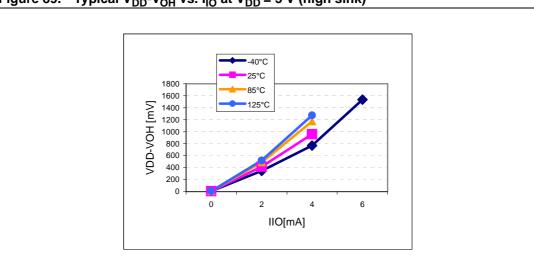


Figure 88. Typical V_{DD} - V_{OH} vs. I_{IO} at V_{DD} = 2.4 V (high sink)

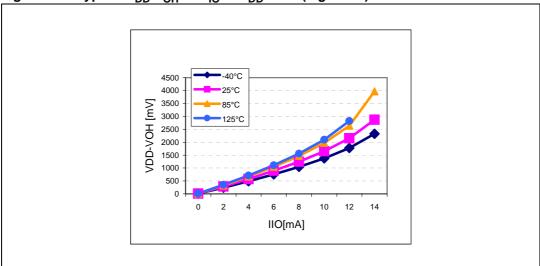






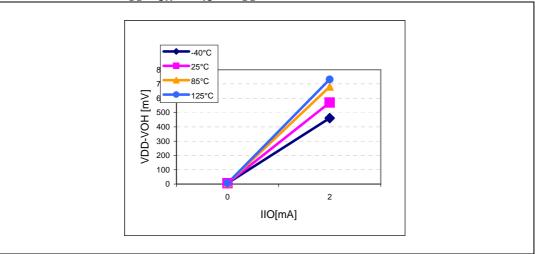
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Figure 91. Typical V_{DD} - V_{OH} vs. I_{IO} at V_{DD} = 2.4 V (standard)



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Figure 92. Typical V_{DD} - V_{OH} vs. I_{IO} at V_{DD} = 3 V (standard)

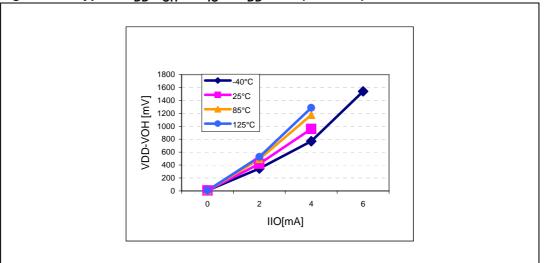
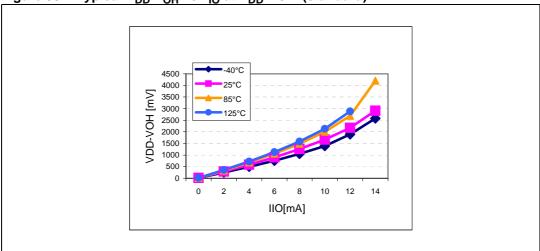
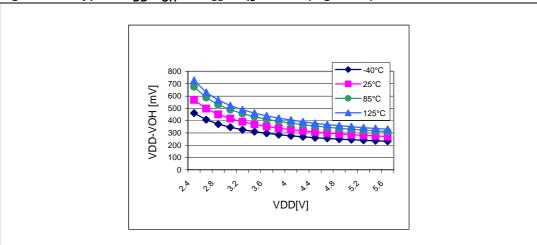


Figure 93. Typical V_{DD} - V_{OH} vs. I_{IO} at V_{DD} = 5 V (standard)



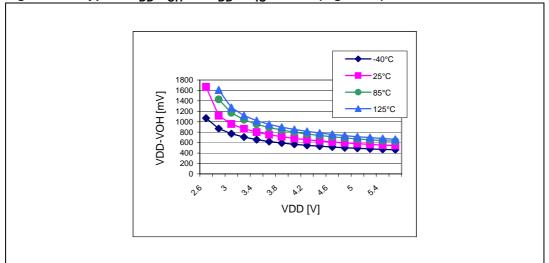
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Figure 94. Typical V_{DD} - V_{OH} vs. V_{DD} at I_{IO} = 2 mA (high sink)



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Figure 95. Typical V_{DD} - V_{OH} vs. V_{DD} at I_{IO} = 4 mA (high sink)



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13.10 Control pin characteristics

13.10.1 Asynchronous RESET pin

 T_A = -40 to 125 °C, unless otherwise specified.

Table 91. Asynchronous RESET pin characteristics

| Symbol | Parameter | Co | onditions | Min | Тур | Max | Unit |
|-------------------------|---|--|-----------------------|-----------------------|-------------------|----------------------|------|
| V_{IL} | Input low level voltage | | | V _{SS} - 0.3 | | 0.37V _{DD} | V |
| U.com V _{IH} | Input high level voltage | | | 0.7V _{DD} | | V _{DD} +0.3 | V |
| V _{hys} | Schmitt trigger voltage hysteresis ⁽¹⁾ | | | | 2 | | ٧ |
| V _{OL} | Output low level voltage (2) | V _{DD} =5V | I _{IO} =+2mA | | 200 | | mV |
| D. | Pull up aquivalent resister(3) | Pull-up equivalent resistor ⁽³⁾ $V_{IN}=V_{SS} = V_{DD}=5V$ $V_{DD}=3V$ | | 30 | 50 | 70 | kΩ |
| R _{ON} | Full-up equivalent resistor | | | | 90 ⁽¹⁾ | | K22 |
| t _{w(RSTL)out} | Generated reset pulse duration | Internal reset sources | | | 90 ⁽¹⁾ | | μS |
| t _{h(RSTL)in} | External reset pulse hold time ⁽⁴⁾ | | | 20 | | | μS |
| t _{g(RSTL)in} | Filtered glitch duration | | | | 200 | | ns |

^{1.} Data based on characterization results, not tested in production

^{2.} The I_{IO} current sunk must always respect the absolute maximum rating specified in Section Table 66. on page 144 and the sum of I_{IO} (I/O ports and control pins) must not exceed I_{VSS} .

^{3.} The R_{ON} pull-up equivalent resistor is based on a resistive transistor. Specified for voltages on \overline{RESET} pin between V_{ILmax} and V_{DD}

To guarantee the reset of the device, a minimum pulse has to be applied to the RESET pin. All short pulses applied on RESET pin with a duration below t_{h(RSTL)in} can be ignored.

Required Optional (note 3)

EXTERNAL RESET

O.01µF 11MΩ PULSE GENERATOR WATCHDOG ILLEGALOPCODE 5)

LVD RESET

Figure 96. RESET pin protection when LVD is enabled³⁾⁴⁾

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The reset network protects the device against parasitic resets. The output of the external reset circuit must have an open-drain output to drive the ST7 reset pad. Otherwise the device can be damaged when the ST7 generates an internal reset (LVD or watchdog). Whatever the reset source is (internal or external), the user must ensure that the level on the $\overline{\text{RESET}}$ pin can go below the V_{IL} max. level specified in $Section\ 13.10.1\ on\ page\ 170$. Otherwise the reset will not be taken into account internally. Because the reset circuit is designed to allow the internal Reset to be output in the $\overline{\text{RESET}}$ pin, the user must ensure that the current sunk on the $\overline{\text{RESET}}$ pin is less than the absolute maximum value specified for $I_{\text{INJ(RESET)}}$ in $Section\ Table\ 66.$ on page\ 144.

When the LVD is enabled, it is recommended not to connect a pull-up resistor or capacitor. A 10nF pull-down capacitor is required to filter noise on the reset line.

In case a capacitive power supply is used, it is recommended to connect a $1M\Omega$ pull-down resistor to the \overline{RESET} pin to discharge any residual voltage induced by the capacitive effect of the power supply (this will add $5\mu A$ to the power consumption of the MCU).

Tips when using the LVD

- Check that all recommendations related to ICCCLK and reset circuit have been applied (see caution in Table 2 on page 16 and notes above).
- Check that the power supply is properly decoupled (100nF + 10μF close to the MCU).
 Refer to AN1709 and AN2017. If this cannot be done, it is recommended to put a 100nF + 1MΩ pull-down on the RESET pin.
- The capacitors connected on the RESET pin and also the power supply are key to avoid any start-up marginality. In most cases, steps 1 and 2 above are sufficient for a robust solution. Otherwise: replace 10nF pull-down on the RESET pin with a 5μF to 20μF capacitor."

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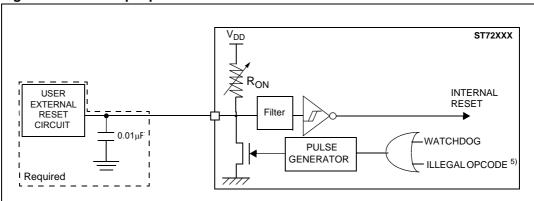


Figure 97. RESET pin protection when LVD is disabled

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- 1. The reset network protects the device against parasitic resets. The output of the external reset circuit must have an open-drain output to drive the ST7 reset pad. Otherwise the device can be damaged when the ST7 generates an internal reset (LVD or watchdog). Whatever the reset source is (internal or external), the user must ensure that the level on the RESET pin can go below the V_{IL} max. level specified in Section 13.10.1 on page 170. Otherwise the reset will not be taken into account internally.
 - Because the reset circuit is designed to allow the internal Reset to be output in the RESET pin, the user must ensure that the current sunk on the RESET pin is less than the absolute maximum value specified for I_{INJ(RESET)} in Section Table 66. on page 144.
- 2. Please refer to Section 12.2.1 on page 139 for more details on illegal opcode reset conditions.

13.11 10-bit ADC characteristics

Subject to general operating condition for V_{DD} , f_{OSC} , and T_A unless otherwise specified.

Table 92. ADC characteristics

| Symbol | Parameter | ameter Conditions | | Typ ⁽¹⁾ | Max | Unit | |
|-------------------|--|--|----------------|--------------------|--------------------|--------------------|--|
| f _{ADC} | ADC clock frequency ⁽²⁾ | | | | 4 | MHz | |
| V _{AIN} | Conversion voltage range | | V_{SSA} | | V_{DDA} | V | |
| | | $V_{DD} = 5V$, $f_{ADC} = 4MHz$ | | | 8k ⁽³⁾ | | |
| D | External input resistor | $V_{DD} = 3.3V$, $f_{ADC} = 4MHz$ | | | 7k ⁽³⁾ | Ω | |
| R _{AIN} | | $2.7V \le V_{DD} \le 5.5V$, f_{ADC} =2MHz | | | 10k ⁽³⁾ | 52 | |
| | | $2.4V \le V_{DD} \le 2.7V$, f_{ADC} =1MHz | | | 20k ⁽³⁾ | | |
| C _{ADC} | Internal sample and hold capacitor | | | 3 | | pF | |
| t _{STAB} | Stabilization time after ADC enable | | | 0 ⁽⁴⁾ | | 6 | |
| | Conversion time (Sample+Hold) | f _{CPU} =8MHz, f _{ADC} =4MHz | 3.5 4 10 | | | μS | |
| t _{ADC} | - Sample capacitor loading time - Hold conversion time | Gro - , Add | | | | 1/f _{ADC} | |

- Unless otherwise specified, typical data are based on T_A=25°C and V_{DD}-V_{SS}=5V. They are given only as design guidelines and are not tested.
- 2. The maximum ADC clock frequency allowed within V_{DD} = 2.4V to 2.7V operating range is 1MHz.
- Any added external serial resistor will downgrade the ADC accuracy (especially for resistance greater than the maximum value). Data guaranteed by Design, not tested in production.
- The stabilization time of the A/D converter is masked by the first t_{LOAD}. The first conversion after the enable is then always valid.

R_{AIN}
AINX
AINX
V_T
0.6V

V_{AIN}
V_T
0.6V

L
±1µA

ST7xxxx

Figure 98. Typical application with ADC

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Table 93. ADC accuracy with $V_{DD} = 3.3$ to 5.5 V

| Symbol (1) | Parameter | Conditions | Тур | Max | Unit |
|----------------|------------------------------|--|-----|-----|------|
| E _T | Total unadjusted error | | 2.0 | 5.0 | |
| E _O | Offset error | | 0.9 | 2.5 | |
| E _G | Gain Error | f _{CPU} =8 MHz, f _{ADC} =4 MHz ⁽¹⁾ | 1.0 | 1.5 | LSB |
| E _D | Differential linearity error | ADC | 1.2 | 3.5 | |
| E _L | Integral linearity error | | 1.1 | 4.5 | |

^{1.} Data based on characterization results over the whole temperature range.

Table 94. ADC accuracy with $V_{DD} = 2.7$ to 3.3 V

| Symbol (1) | Parameter | Conditions | Тур | Max | Unit |
|----------------|------------------------------|--|-----|-----|------|
| E _T | Total unadjusted error | | 1.9 | 3.0 | |
| E _O | Offset error | | 0.9 | 1.5 | |
| E _G | Gain Error | f _{CPU} =4 MHz, f _{ADC} =2 MHz ⁽¹⁾ | 0.8 | 1.4 | LSB |
| E _D | Differential linearity error | ADC = ·····= | 1.4 | 2.5 | |
| E _L | Integral linearity error | | 1.1 | 2.5 | |

^{1.} Data based on characterization results over the whole temperature range.

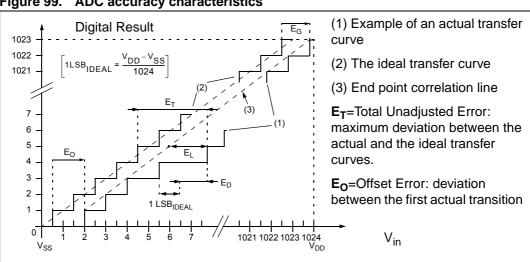
Table 95. ADC accuracy with $V_{DD} = 2.4$ to 2.7 V

| Symbol (1) | Parameter | Conditions | Тур | Max | Unit |
|----------------|------------------------------|--|-----|-----|------|
| E _T | Total unadjusted error | | 2.5 | 3.5 | |
| E _O | Offset error | | 1.1 | 1.5 | |
| E _G | Gain Error | f _{CPU} =2 MHz, f _{ADC} =1 MHz ⁽¹⁾ | 0.5 | 1.5 | LSB |
| E _D | Differential linearity error | ADC | 1.1 | 2.5 | |
| E _L | Integral linearity error | | 1.2 | 2.5 | |

^{1.} Data based on characterization results at ambient temperature and above.

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Figure 99. ADC accuracy characteristics



14 Device configuration and ordering information

This device is available for production in user programmable version (Flash).

ST7LITE49M XFlash devices are shipped to customers with a default program memory content (FFh).

14.1 Option bytes

The two option bytes allow the hardware configuration of the microcontroller to be selected. The option bytes can be accessed only in programming mode (for example using a standard ST7 programming tool).

14.1.1 Option byte 1

• Bit 7:6 = **CKSEL[1:0]** Start-up clock selection. These bits are used to select the startup frequency. By default, the internal RC is selected.

Table 96. Startup clock selection

| Configuration | CKSEL1 | CKSEL0 |
|------------------------------------|--------|--------|
| Internal RC as Startup Clock | 0 | 0 |
| AWU RC as a Startup Clock | 0 | 1 |
| External crystal/ceramic resonator | 1 | 0 |
| External Clock | 1 | 1 |

- Bits 5:4 = Reserved, must always be 1.
- Bits 3:2 = **LVD[1:0]** Low Voltage Detection selection. These option bits enable the low voltage detection block (LVD) with a selected threshold as shown in *Table 97*.

Table 97. LVD threshold configuration

| Configuration | VD1 | VD0 |
|---------------------------|-----|-----|
| LVD Off (default value) | 1 | 1 |
| Highest Voltage Threshold | 1 | 0 |
| Medium Voltage Threshold | 0 | 1 |
| Lowest Voltage Threshold | 0 | 0 |

• Bit 1 = **WDG SW** Hardware or software watchdog

This option bit selects the watchdog type.

- 0: Hardware (watchdog always enabled)
- 1: Software (watchdog to be enabled by software)
- Bit 0 = WDG HALT Watchdog Reset on Halt

This option bit determines if a Reset is generated when entering Halt mode while the Watchdog is active.

- 0: No Reset generation when entering Halt mode
- 1: Reset generation when entering Halt mode

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14.1.2 Option byte 0

OPT7 = AWUCK Auto Wake Up Clock Selection

0: 32-kHz Oscillator (VLP) selected as AWU clock

1: AWU RC Oscillator selected as AWU clock.

Note:

If this bit is reset, OSCRANGE[2:0] must be set to 100.

OPT6:4 = OSCRANGE[2:0] Oscillator Range

When the internal RC oscillator is not selected (CKSEL1=1), these option bits (and CKSEL0) select the range of the resonator oscillator current source or the external clock source.

Table 98. Selection of the resonator oscillator range

| | | | OSCRANGE ⁽¹⁾ | | | |
|-------------------------------------|------------------------------|-----------|-------------------------|---|---|--|
| | | | 2 | 1 | 0 | |
| | LP | 1~2MHz | 0 | 0 | 0 | |
| | MP | 2~4MHz | 0 | 0 | 1 | |
| Typ. frequency range with Resonator | MS | 4~8MHz | 0 | 1 | 0 | |
| | HS | 8~16MHz | 0 | 1 | 1 | |
| | VLP | 32.768kHz | 1 | 0 | 0 | |
| External Clo | External Clock on OSC1/CLKIN | | | | 1 | |
| R | 1 | 1 | 0 | | | |
| Externa | l Clock on F | PB1 | 1 | 1 | 1 | |

^{1.} When the internal RC oscillator is selected, the CLKSEL option bits must be kept at their default value in order to select the 256 clock cycle delay (see Section 7.3).

OPT 3:2 = SEC[1:0] Sector 0 size definition
 These option bits indicate the size of sector 0 according to Table 99.

Table 99. Configuration of sector size

| Sector 0 Size | SEC1 | SEC0 |
|---------------|------|------|
| 0.5k | 0 | 0 |
| 1k | 0 | 1 |
| 2 | 1 | 0 |
| 4k | 1 | 1 |

Bit 1 = FMP_R Read-Out Protection

Read-Out Protection, when selected provides a protection against program memory content extraction and against write access to Flash memory. Erasing the option bytes when the FMP_R option is selected will cause the whole memory to be erased first, and the device can be reprogrammed. Refer to Section 4.5 on page 24 and the ST7 Flash Programming Reference Manual for more details.

0: Read-Out Protection off

1: Read-Out Protection on

• Bit 0 = **FMP_W** Flash write protection

This option indicates if the Flash program memory is write protected.

Warning: When this option is selected, the program memory (and the option bit itself) can never be erased or programmed again.

0: Write protection off

1: Write protection on

| | | Option byte 0 | | | | | | | | Option byte 1 | | | | | | |
|------------------|-----------|---------------|-------|--------|----------|----------|----------|----------|------------|---------------|-----|-----|------|------|---|-------------|
| | 7 | | | | | | 0 | 7 | | | | | | | 0 | |
| .com | AWU CK | OSCI | RANGI | Ξ[2:0] | SEC 1 | SEC 0 | FMP R | FMP W | CKS EL1 | CKS EL0 | Res | Res | LVD1 | LVD0 | _ | WDG HALT |
| Default Value | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |

14.2 Device ordering information

Table 100. Supported part numbers

| Part number | Program memory (bytes) | RAM (bytes) | Data EEPROM (bytes) | Package |
|---------------|------------------------------|----------------|------------------------|---------|
| ST7FLI49MK1B6 | 4 K of Flash | 384 | 128 | SDIP32 |
| ST7FLI49MK1T6 | memory | 304 | 120 | LQFP32 |

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14.3 Development tools

Development tools for the ST7 microcontrollers include a complete range of hardware systems and software tools from STMicroelectronics and third-party tool suppliers. The range of tools includes solutions to help you evaluate microcontroller peripherals, develop and debug your application, and program your microcontrollers.

14.3.1 Starter kits

ST offers complete, affordable **starter kits**. Starter kits are complete hardware/software tool packages that include features and samples to help you quickly start developing your application.

14.3.2 Development and debugging tools

Application development for ST7 is supported by fully optimizing **C Compilers** and the **ST7 Assembler-Linker** toolchain, which are all seamlessly integrated in the ST7 integrated development environments in order to facilitate the debugging and fine-tuning of your application. The Cosmic C Compiler is available in a free version that outputs up to 16Kbytes of code.

The range of hardware tools includes a full-featured **LITE4** Emulator and the low-cost **RLink** in-circuit debugger/programmer. These tools are supported by the **ST7 Toolset** from STMicroelectronics, which includes the STVD7 integrated development environment (IDE) with high-level language debugger, editor, project manager and integrated programming interface.

14.3.3 Programming tools

During the development cycle, the **LITE4** emulator and the **RLink** provide in-circuit programming capability for programming the Flash microcontroller on your application board.

ST also provides a low-cost dedicated in-circuit programmer, the **ST7-STICK**, as well as **ST7 Socket Boards** which provide all the sockets required for programming any of the devices in a specific ST7 sub-family on a platform that can be used with any tool with incircuit programming capability for ST7.

For production programming of ST7 devices, ST's third-party tool partners also provide a complete range of gang and automated programming solutions, which are ready to integrate into your production environment.

14.3.4 Order codes for development and programming tools

Table 101 below lists the ordering codes for the ST7LITE49M development and programming tools. For additional ordering codes for spare parts and accessories, refer to the online product selector at www.st.com/mcu.

14.3.5 Order codes for ST7LITE49M development tools

Table 101. Development tool order codes for the ST7LITE49M family

| II L | MCU | In-circuit Debu Series | | Emulator | Programming tool | | |
|------|--------------------------------|--------------------------------------|------------------------------------|-------------------------------|--|---------------------------------|--|
| | ST7FLI49MK1T6 | Starter kit without demo board | Starter kit with demo board | (2) | In-circuit programmer | ST socket boards and EPBs | |
| | ST7FLI49MK1T6 ST7FLI49MK1B6 | STX-RLINK ⁽³⁾ | STFLITE- SK/RAIS ⁽³⁾ | LITE4 emulator ⁽²⁾ | STX-RLINK ST7- STICK ⁽⁴⁾⁽⁵⁾ | LITE4 Socket boardSK/RAIS | |

- 1. Available from ST or from Raisonance, www.raisonance.com.
- 2. Contact local ST sales office for sales types
- 3. USB connection to PC.
- 4. Add suffix /EU, /UK or /US for the power supply for your region
- 5. Parallel port connection to PC

14.4 ST7 application notes

Table 102. ST7 application notes

| Identification | Description | | | | |
|----------------|--|--|--|--|--|
| | Application examples | | | | |
| AN1658 | Serial numbering implementation | | | | |
| AN1720 | N1720 managing the Read-Out Protection in Flash microcontrollers | | | | |
| AN1755 | A high resolution/precision thermometer using ST7 and NE555 | | | | |
| AN1756 | Choosing a DALI implementation strategy with ST7DALI | | | | |
| AN1812 | A high precision, low cost, single supply ADC for positive and negative input voltages | | | | |
| | Example drivers | | | | |
| AN 969 | SCI communication between ST7 and PC | | | | |
| AN 970 | SPI communication between ST7 and EEPROM | | | | |
| AN 971 | I ² C communication between ST7 and M24Cxx EEPROM | | | | |
| AN 972 | ST7 software SPI master communication | | | | |
| AN 973 | SCI software communication with a PC using ST72251 16-bit timer | | | | |
| AN 974 | Real time clock with ST7 timer Output Compare | | | | |

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Table 102. ST7 application notes (continued)

| | | , |
|-----------------|----------------|--|
| | Identification | Description |
| | AN 976 | Driving a buzzer through ST7 timer PWM function |
| | AN 979 | Driving an analog keyboard with the ST7 ADC |
| | AN 980 | ST7 keypad decoding techniques, implementing wake-up on keystroke |
| | AN1017 | Using the ST7 Universal Serial Bus microcontroller |
| | AN1041 | Using ST7 PWM signal to generate analog output (sinusoïd) |
| | AN1042 | ST7 routine for I ² C Slave mode Management |
| www.DataSheet4L | AN1044 | Multiple interrupt sources management for ST7 MCUs |
| | AN1045 | ST7 S/W implementation of I ² C bus master |
| | AN1046 | UART emulation software |
| | AN1047 | Managing reception errors with the ST7 SCI peripherals |
| | AN1048 | ST7 software LCD Driver |
| | AN1078 | PWM duty cycle switch implementing true 0% & 100% duty cycle |
| | AN1082 | Description of the ST72141 motor control peripherals registers |
| | AN1083 | ST72141 BLDC motor control software and flowchart example |
| | AN1105 | ST7 pCAN peripheral driver |
| | AN1129 | PWM management for BLDC motor drives using the ST72141 |
| | AN1130 | An introduction to sensorless brushless DC motor drive applications with the ST72141 |
| | AN1148 | Using the ST7263 for designing a USB mouse |
| | AN1149 | Handling Suspend mode on a USB mouse |
| | AN1180 | Using the ST7263 kit to implement a USB game pad |
| | AN1276 | BLDC motor start routine for the ST72141 microcontroller |
| | AN1321 | Using the ST72141 motor control MCU in Sensor mode |
| | AN1325 | Using the ST7 USB low-speed firmware V4.x |
| | AN1445 | Emulated 16-bit slave SPI |
| | AN1475 | Developing an ST7265X mass storage application |
| | AN1504 | Starting a PWM signal directly at high level using the ST7 16-bit timer |
| | AN1602 | 16-bit timing operations using ST7262 or ST7263B ST7 USB MCUs |
| | AN1633 | Device firmware upgrade (DFU) implementation in ST7 non-USB applications |
| | AN1712 | Generating a high resolution sinewave using ST7 PWMART |
| | AN1713 | SMBus slave driver for ST7 I ² C peripherals |
| | AN1753 | Software UART using 12-bit ART |
| | AN1947 | ST7MC PMAC sine wave motor control software library |
| | | General purpose |
| | AN1476 | Low cost power supply for home appliances |

Table 102. ST7 application notes (continued)

| Identification | Description | | | | |
|----------------|--|--|--|--|--|
| AN1526 | ST7FLITE0 quick reference note | | | | |
| AN1709 | EMC design for ST microcontrollers | | | | |
| AN1752 | ST72324 quick reference note | | | | |
| | Product evaluation | | | | |
| AN 910 | Performance benchmarking | | | | |
| AN 990 | ST7 benefits vs industry standard | | | | |
| AN1077 | Overview of enhanced CAN controllers for ST7 and ST9 MCUs | | | | |
| AN1086 | U435 can-do solutions for car multiplexing | | | | |
| AN1103 | Improved B-EMF detection for low speed, low voltage with ST72141 | | | | |
| AN1150 | Benchmark ST72 vs PC16 | | | | |
| AN1151 | Performance comparison between ST72254 & PC16F876 | | | | |
| AN1278 | LIN (Local Interconnect Network) solutions | | | | |
| | Product migration | | | | |
| AN1131 | Migrating applications from ST72511/311/214/124 to ST72521/321/324 | | | | |
| AN1322 | Migrating an application from ST7263 Rev.B to ST7263B | | | | |
| AN1365 | Guidelines for migrating ST72C254 applications to ST72F264 | | | | |
| AN1604 | How to use ST7MDT1-TRAIN with ST72F264 | | | | |
| AN2200 | Guidelines for migrating ST7LITE1x applications to ST7FLITE1xB | | | | |
| | Product optimization | | | | |
| AN 982 | Using ST7 with ceramic resonator | | | | |
| AN1014 | How to minimize the ST7 power consumption | | | | |
| AN1015 | Software techniques for improving microcontroller EMC performance | | | | |
| AN1040 | Monitoring the Vbus signal for USB self-powered devices | | | | |
| AN1070 | ST7 checksum self-checking capability | | | | |
| AN1181 | Electrostatic discharge sensitive measurement | | | | |
| AN1324 | Calibrating the RC oscillator of the ST7FLITE0 MCU using the mains | | | | |
| AN1502 | Emulated data EEPROM with ST7 HD Flash memory | | | | |
| AN1529 | Extending the current & voltage capability on the ST7265 V _{DDF} supply | | | | |
| AN1530 | Accurate timebase for low-cost ST7 applications with internal RC oscillator | | | | |
| AN1605 | Using an active RC to wake up the ST7LITE0 from power saving mode | | | | |
| AN1636 | Understanding and minimizing ADC conversion errors | | | | |
| AN1828 | PIR (passive infrared) detector using the ST7FLITE05/09/SUPERLITE | | | | |
| AN1946 | Sensorless BLDC motor control and BEMF sampling methods with ST7MC | | | | |
| AN1953 | PFC for ST7MC starter kit | | | | |

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Table 102. ST7 application notes (continued)

| Identification | Description | | | |
|-----------------------|---|--|--|--|
| AN1971 | ST7LITE0 microcontrolled ballast | | | |
| Programming and tools | | | | |
| AN 978 | ST7 Visual DeVELOP software key debugging features | | | |
| AN 983 | N 983 Key features of the Cosmic ST7 C-compiler package | | | |
| AN 985 | Executing code In ST7 RAM | | | |
| AN 986 | Using the indirect addressing mode with ST7 | | | |
| AN 987 | ST7 serial test controller programming | | | |
| AN 988 | Starting with ST7 assembly tool chain | | | |
| AN1039 | ST7 math utility routines | | | |
| AN1071 | Half duplex USB-to-serial bridge using the ST72611 USB microcontroller | | | |
| AN1106 | Translating assembly code from HC05 to ST7 | | | |
| AN1179 | Programming ST7 Flash microcontrollers in remote ISP mode (In-situ programming) | | | |
| AN1446 | Using the ST72521 emulator to debug an ST72324 target application | | | |
| AN1477 | Emulated data EEPROM with XFlash memory | | | |
| AN1527 | Developing a USB smartcard reader with ST7SCR | | | |
| AN1575 | On-board programming methods for XFlash and HD Flash ST7 MCUs | | | |
| AN1576 | In-application programming (IAP) drivers for ST7 HD Flash or XFlash MCUs | | | |
| AN1577 | Device firmware upgrade (DFU) Implementation for ST7 USB applications | | | |
| AN1601 | Software implementation for ST7DALI-EVAL | | | |
| AN1603 | Using the ST7 USB device firmware upgrade development kit (DFU-DK) | | | |
| AN1635 | ST7 customer ROM code release information | | | |
| AN1754 | Data logging program for testing ST7 applications via ICC | | | |
| AN1796 | Field updates for Flash memory based ST7 applications using a PC comm port | | | |
| AN1900 | Hardware implementation for ST7DALI-EVAL | | | |
| AN1904 | ST7MC three-phase AC induction motor control software library | | | |
| AN1905 | ST7MC three-phase BLDC motor control software library | | | |
| System optimization | | | | |
| AN1711 | Software techniques for compensating ST7 ADC errors | | | |
| AN1827 | Implementation of SIGMA-DELTA ADC with ST7FLITE05/09 | | | |
| AN2009 | PWM management for 3-phase BLDC motor drives using the ST7FMC | | | |
| AN2030 | Back EMF detection during PWM on time by ST7MC | | | |

15 Package characteristics

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

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15.1 Package mechanical data

Figure 100. 32-pin plastic dual in-line package, shrink 400mil width, package outline

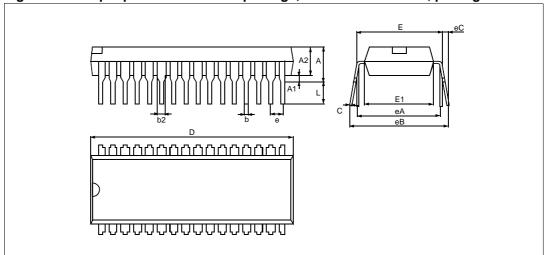


Table 103. 32-pin plastic dual in-line package, shrink 400mil width, mechanical data

| Dim. | mm | | | inches | | |
|------|-------|----------------|-------|--------|-------|-------|
| | Min | Тур | Max | Min | Тур | Max |
| Α | 3.56 | 3.76 | 5.08 | 0.140 | 0.148 | 0.200 |
| A1 | 0.51 | | | 0.020 | | |
| A2 | 3.05 | 3.56 | 4.57 | 0.120 | 0.140 | 0.180 |
| b | 0.36 | 0.46 | 0.58 | 0.014 | 0.018 | 0.023 |
| b1 | 0.76 | 1.02 | 1.40 | 0.030 | 0.040 | 0.055 |
| С | 0.20 | 0.25 | 0.36 | 0.008 | 0.010 | 0.014 |
| D | 27.43 | | 28.45 | 1.080 | 1.100 | 1.120 |
| E | 9.91 | 10.41 | 11.05 | 0.390 | 0.410 | 0.435 |
| E1 | 7.62 | 8.89 | 9.40 | 0.300 | 0.350 | 0.370 |
| е | | 1.78 | | | 0.070 | |
| eA | | 10.16 | | | 0.400 | |
| eB | | | 12.70 | | | 0.500 |
| eC | | | 1.40 | | | 0.055 |
| L | 2.54 | 3.05 | 3.81 | 0.100 | 0.120 | 0.150 |
| | | Number of pins | | | | |
| N | | | , | 32 | | |

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Figure 101. 32-pin low profile quad flat package (7x7), package outline

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Table 104. 32-pin low profile quad flat package (7x7), package mechanical data

| Dim. | mm | | | inches ⁽¹⁾ | | |
|------|------|------|-------|-----------------------|-------|-------|
| | Min | Тур | Max | Min | Тур | Max |
| Α | | | 1.60 | | | 0.063 |
| A1 | 0.05 | | 0.15 | 0.002 | | 0.006 |
| A2 | 1.35 | 1.40 | 1.45 | 0.053 | 0.055 | 0.057 |
| b | 0.30 | 0.37 | 0.45 | 0.012 | 0.015 | 0.018 |
| С | 0.09 | | 0.20 | 0.004 | | 0.008 |
| D | | 9.00 | | | 0.354 | |
| D1 | | 7.00 | | | 0.276 | |
| E | | 9.00 | | | 0.354 | |
| E1 | | 7.00 | | | 0.276 | |
| е | | 0.80 | | | 0.031 | |
| θ | 0° | 3.5° | 7° | 0° | 3.5° | 7° |
| L | 0.45 | 0.60 | 0.75 | 0.018 | 0.024 | 0.030 |
| L1 | | 1.00 | | | 0.039 | |
| | | | Numbe | er of pins | • | • |
| N | | | ; | 32 | | |

^{1.} Values in inches are converted from mm and rounded to 3 decimal digits.

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15.2 Thermal characteristics

Table 105. Thermal characteristics⁽¹⁾

| Symbol | Ratings | | Value | Unit |
|-------------------|--|--------|-------|------|
| R _{thJA} | Package thermal resistance (junction to ambient) | LQFP32 | TBD | °C/W |
| T _{Jmax} | Maximum junction temperature ⁽²⁾ | | TBD | °C |
| P _{Dmax} | Power dissipation ⁽³⁾ | LQFP32 | TBD | mW |

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^{1.} TBD stands for 'to be determined'.

^{2.} The maximum chip-junction temperature is based on technology characteristics.

^{3.} The maximum power dissipation is obtained from the formula $P_D = (T_J - T_A) / R_{thJA}$. The power dissipation of an application can be defined by the user with the formula: $P_D = P_{INT} + P_{PORT}$ where P_{INT} is the chip internal power $(I_{DD}xV_{DD})$ and P_{PORT} is the port power dissipation depending on the ports used in the application.

ST7LITE49M Revision history

16 Revision history

Table 106. Document revision history

| Date | Revision | Changes | | |
|--------------|----------|---|--|--|
| 01-Jun-2007 | 1 | Initial release. | | |
| 13-July-2007 | 2 | Document reformatted and status updated to Full Datasheet. Table 5. EEPROM register mapping and reset values removed. Section 7.2.3: Internal RC oscillator updated. Section 7.5.3: AVD Threshold Selection register (AVDTHCR): global description of AVD[1:0] added. Table 69: Operating characteristics with LVD: IDD(LVD) typical and maximum values updated, and note removed; VtPOR minimum value updated. Table 71: Voltage drop: minimum and maximum values added. Table 72: Internal RC oscillator characteristics (5.0 V calibration), Table 73: Internal RC oscillator characteristics (3.3 V calibration), and Table 74: Supply current characteristics updated. Figure 67, Figure 68, Figure 69, Figure 71, and Figure 76 updated. Table 75: On-chip peripheral characteristics values and Note 2 updated. tprog and NRW updated in Table 83: Flash program memory characteristics. NRW updated in Table 84: Data EEPROM memory characteristics. Class updated forVFESD in Table 85: EMS characteristics. Table 86: EMI characteristics updated. RPU and RON updated in Table 89: General characteristics and Table 91: Asynchronous RESET pin characteristics, respectively. | | |

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